Click here to ask about the production status of specific part numbers.

MAX98396

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

General Description

The MAX98396 is a high-efficiency, mono Class-DG speaker amplifier with industry-leading quiescent power featuring I/V sense, brownout-prevention engine (BPE), and dynamic-headroom tracking (DHT). The IC enables ultrasound applications by providing support for sample rates up to 192kHz, a higher passband (for $f_s > 50$ kHz), and a bypass path for the ultrasound signals through the amplifier so it is not attenuated by the audio processing. Precision output current and voltage monitoring (I/V sense) enables the host device to run speaker protection algorithms. Spread-spectrum modulation (SSM) and edge rate control minimize EMI and eliminate the need for the output filtering found in traditional Class-D devices.

To achieve industry-leading quiescent power, the Class-DG amplifier employs two supply rails VBAT (3V to 5.5V) and PVDD (3V to 20V) to supply the speaker amplifier. The Class-DG amplifier switches between the two supply rails depending on the input signal level and/or the supply headroom. The brownout-prevention engine in the device allows it to reduce its contribution to the overall system power consumption by either attenuating or limiting the amplifier output when the device supply drops below a set of programmable thresholds. Additionally, as the power supply voltage varies due to sudden transients and declining battery life, DHT automatically optimizes the headroom available to the Class-DG amplifier to maintain consistent distortion and listening levels.

The device provides a PCM interface for audio data and a standard I²C interface for control data communication. The PCM interface supports audio playback using I²S, left-justified, and TDM audio data formats. A unique clocking structure eliminates the need for an external master clock for PCM communication, which reduces pin count and simplifies board layout. Enabling thermal foldback automatically reduces the output power when the temperature exceeds a user specified threshold. This allows for uninterrupted music playback even at high ambient temperatures. Traditional thermal protection is also available in addition to robust overcurrent protection.

The device is available in a 0.4mm pitch, 35-bump waferlevel package (WLP). The device operates over the extended -40° C to $+85^{\circ}$ C temperature range.

Applications

- Mobile Speakers Smart Speakers Smart IoT Tablets
- Notebook Computers
 Soundbars

SMBus is a trademark of Intel Corp.

Benefits and Features

- Wide Input Supply Range (3.0V to 20V)
- Class-DG Operation Enables Industry-Leading Quiescent Power
 - + 12.7mW at V_{PVDD} = 12V , V_{VBAT} = 3.8V
 - 18mW at V_{PVDD} = 19V, V_{VBAT} = 5.0V
- Ultra-Low Noise Floor
 - 15.5µV_{RMS} Output Noise
 - 118dB Dynamic Range
- Low Distortion
 - -82dB THD+N at 1W into 8Ω, f = 1kHz
 - -76dB THD+N at 1W into 8Ω, f = 6kHz
- Output Power at 1% THD+N:
 - 20W into 8Ω, V_{PVDD} = 19V
 - 19W into 4Ω, V_{PVDD} = 14V
- 60W Peak Output Power into 4Ω, V_{PVDD} = 19V
- Speaker Amplifier Efficiency:
 - 87% at 1W into 8Ω , V_{PVDD} = 12V, V_{VBAT} = 3.8V
 - 83% at 1W into 4Ω, V_{PVDD} = 12V, V_{VBAT} = 3.8V
 - 83% at 1W into 8Ω , V_{PVDD} = 19V, V_{VBAT} = 5.0V
 - 91% at 20W into 8Ω , V_{PVDD} = 19V, V_{VBAT} = 5.0V
- Class-D EMI Reduction Enables Filterless Operation
- Spread-Spectrum Modulation
- Switching-Edge Rate Control
- Integrated Speaker Current and Voltage Sense do not Require External Components
- Flexible Brownout-Prevention Engine
- I²S/16-Channel TDM and I²C Digital Interfaces
- Playback Support for 16-, 24-, and 32-Bit Data Words
- Playback and I/V Sense Support Sample Rates up to 192kHz
- Audio Processing Bypass Path
- Dynamic-Headroom Tracking Maintains a Consistent Listening Experience
- Extensive Click-and-Pop Suppression
- 35-Bump, WLP (0.4mm Pitch)

Ordering Information appears at end of data sheet.



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Simplified Block Diagram



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

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20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Absolute Maximum Ratings

VBAT to PGND	0.3V to +6.0V
PVDD to PGND	0.3V to +22V
PVDD to VBAT	0.3V to 22 - V _{VBAT} V
AGND, DGND to PGND	0.1V to +0.1V
AVDD to AGND	0.3V to +2.2V
DVDD, DVDDIO to DGND	0.3V to +2.2V
OUTP, OUTN to PGND	0.3V to V _{PVDD} + 0.3V
OUTPSNS or OUTNSNS to PGND	0.3V to +22 V
OUTPSNS and OUTNSNS to PGND	0.3V to +13 V
VREFC to GND	
I2C1, I2C2, ADDR to GND	0.3V to +4.0V

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

35 WLP

Package Code	W352F3Z+1			
Outline Number	<u>21-100489</u>			
Land Pattern Number	Refer to Application Note 1891			
Thermal Resistance, Single Layer Board:				
Junction-to-Ambient (θ _{JA})	46.33			
Junction-to-Case Thermal Resistance (θ_{JC})	N/A			
Thermal Resistance, Four Layer Board:				
Junction-to-Ambient (θ _{JA})				
Junction-to-Case Thermal Resistance (θ_{JC})	N/A			

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/</u> <u>thermal-tutorial</u>.

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES			1			
VBAT Power Supply Operating Voltage Range	V _{VBAT}		3.0		5.5	V
VBAT Voltage	V _{VBAT}	Device is functional but parametric performance is not guaranteed	2.3			V
PVDD Power Supply Operating Voltage Range	V _{PVDD}		3.0		20	V
PVDD Voltage	V _{PVDD}	Device is functional but parametric performance is not guaranteed	2.3			V
AVDD Power Supply Voltage Range	V _{AVDD}		1.71	1.8	1.89	~
DVDD Power Supply Voltage Range	V _{DVDD}		1.14	1.2	1.89	V
DVDDIO Power Supply Voltage Range	V _{DVDDIO}		1.14	1.2	1.26	- V
VBAT Undervoltage Lockout	VVBAT_UVLO	V _{VBAT} falling	1.8	1.0	2.2	V
PVDD Undervoltage Lockout	V _{PVDD_UVLO}	V _{PVDD} falling	1.93		2.26	V
AVDD Undervoltage Lockout	VAVDD_UVLO	V _{AVDD} falling	1.24		1.46	V
DVDD Undervoltage Lockout	V _{DVDD_} UVLO	V _{DVDD} falling	0.85		1.01	V
VBAT UVLO Hysteresis		T _A = +25°C	35			mV
PVDD UVLO Hysteresis		T _A = +25°C	30			mV
Supply Ramp Rate VBAT			0.1		100	V/ms
Supply Ramp Rate PVDD			0.1		100	V/ms

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
POWER CONSUMPTION	POWER CONSUMPTION / QUIESCENT POWER CONSUMPTION								
Total Power				All supplies, IV	V _{PVDD} = 12V, V _{VBAT} = 3.8V, DG mode		16.5	25	
			sense enabled V _{PVDD} = 19V, V _{VBAT} = 5.0V, DG mode (Note 3)	V_{PVDD} = 19V, V_{VBAT} = 5.0V, DG mode (Note 3)		22.3	30	m\\/	
Consumption	ΓQ	All supplies IV	V _{PVDD} = 12V, V _{VBAT} = 3.8V, DG mode		12.7		- mW -		
		sense disabled	V _{PVDD} = 19V, V _{VBAT} = 5.0V, DG mode		18				
Total Power Consumption	PQ	All supplies, IV	V_{PVDD} = 12V, V_{VBAT} = 3.8V, DG mode, noise gate enabled		1.7		- mW		
		sense disabled	V_{PVDD} = 19V, V_{VBAT} = 5.0V, DG mode, noise gate enabled		1.9				
POWER CONSUMPTION	I / SOFTWARE S	HUTDOWN	1						
		VBAT = $3.8V$, No BC transactions, T _A = +2	CLK/LRCLK/DIN 25°C		0.3	5			
VBAT Software	ISHDN_SW_VB AT	VBAT = $3.8V$, No BC transactions, T _A = + 3	CLK/LRCLK/DIN 85°C (Note 3)			15			
Current		VBAT = 5.0V, No BCLK/LRCLK/DIN transactions, $T_A = +25^{\circ}C$			0.4	5	μΑ		
		VBAT = 5.0V, No BC transactions, $T_A = +3$	CLK/LRCLK/DIN 85°C (Note 3)			15			
		PVDD = 5.0V, No B0 transactions, T _A = +2	CLK/LRCLK/DIN 25°C		0.25	5			
		PVDD = 5.0V, No BCLK/LRCLK/DIN transactions, T_A = +85°C (Note 3)				15			
PVDD Software Shutdown Supply Current	ISHDN SW PV	PVDD = 12V, No BC transactions, $T_A = +2$	CLK/LRCLK/DIN 25°C		1	5			
	DD	PVDD = 12V, No BCLK/LRCLK/DIN transactions, $T_A = +85^{\circ}C$ (Note 3)				15	μΑ		
		PVDD = 19V, No BCLK/LRCLK/DIN transactions, $T_A = +25^{\circ}C$			1.7	5			
		PVDD = 19V, No BC transactions, T _A = +	CLK/LRCLK/DIN 85°C (Note 3)			15			

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
AVDD Software Shutdown Supply Current	ISHDN_SW_AV DD	No BCLK/LRCLK/DIN transactions, T _A = +25°C		1.1	5	μA
		No BCLK/LRCLK/DIN transactions, T _A = +85°C (Note 3)			30	
DVDDIO+DVDD Software Shutdown Supply Current		No BCLK/LRCLK/DIN transactions, T _A = +25°C		6.6	15	μA
	DD_DVDDIO	No BCLK/LRCLK/DIN transactions, T _A = +85°C (Note 3)			18	
POWER CONSUMPTION	I / HARDWARE S	SHUTDOWN				
		VBAT = 3.8V, T _A = +25°C		0.3	5	
VBAT Hardware	ISHDN HW VB	VBAT = 3.8V, T _A = +85°C (Note 3)			15	
Current	AT AT	VBAT = 5.0V, T _A = +25°C		0.4	5	μΑ
		VBAT = 5.0V, T _A = +85°C (Note 3)			15	
		PVDD = 5.0V, T _A = +25°C		0.25	5	
		PVDD = 5.0V, T _A = +85°C (Note 3)			15	
PVDD Hardware	ISHON HW PV	PVDD = 12V, T _A = +25°C		1	5	
Current	DD	PVDD = 12V, T _A = +85°C (Note 3)			15	μΑ
		PVDD = 19V, T _A = +25°C		1.7	5	
		PVDD = 19V, T _A = +85°C (Note 3)			15	
AVDD Hardware		T _A = +25°C		0.1	1	
Shutdown Supply Current	DD	T _A = +85°C (Note 3)			10	μA
DVDDIO+DVDD		T _A = +25°C		0.2	6.0	
Hardware Shutdown Supply Current		T _A = +85°C (Note 3)			10	μA
TURN-ON/OFF TIME						
		From EN bit set to 1 to full operation, volume ramp disabled (Note 4)		1.4	3	ms
Turn-On Time	t _{ON}	From EN bit set to 1 to full operation, volume ramp enabled (Note 4)		3	6	ms
		From SPK_EN bit set to 1 to full operation, EN = 1, volume ramp disabled		0.85		ms
Turn-Off Time		T_A = +25°C, From full operation, EN bit set to 0 to software shutdown, volume ramp disabled		20	100	μs
	toff	From full operation, EN bit set to 0 to software shutdown, volume ramp enabled		2.3	6	ms
		From SPK_EN bit set to 0 to amplifier disabled, volume ramp disabled, EN = 1		20		μs

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	DITIONS	MIN	TYP	MAX	UNITS
DIGITAL AUDIO PATH							
DIGITAL AUDIO PATH /	GAIN CONTROL	S / DIGITAL VOLUM	E CONTROL				
Digital Volume Control (max)	A _{SPK_VOL}	SPK_VOL[6:0] = 0x0	00		0		dB
Digital Volume Control Step Size					0.5		dB
Digital Volume Control (min)	A _{SPK_VOL}	SPK_VOL[6:0] = 0x7	7E		-63		dB
DIGITAL AUDIO PATH /	FILTERING / DIO	GITAL HIGHPASS FIL	TER CHARACTERIS	FICS (Note &	5)		
DC Attenuation				80			dB
DC Blocking Cut Off		f _S = 8kHz, 16kHz, 3	2kHz	0.856			
Frequency					1.872		
DIGITAL AUDIO PATH /	FILTERING / DIO	GITAL FILTER CHAR	ACTERISTICS (LRCL	K < 50kHz) (Note 5)		
Valid Sample Rates				16		48	kHz
Deschard Outoff	f _{PLP}	Ripple < δ _P	Ripple < δ_P 0				Hz
		Droop < -3dB		0.459 x f _S			Hz
Passband Ripple	δ _P	f < f _{PLP} , referenced 1kHz	to signal level at	-0.25		+0.25	dB
Stopband Cutoff	f _{SLP}	Attenuation > δ_S				0.49 x f _S	Hz
Stopband Attenuation	δ _S	f > f _{SLP}		75			dB
Group Delay		f = 1kHz			6.1		Samples
DIGITAL AUDIO PATH /	FILTERING / DIO	GITAL FILTER CHAR	ACTERISTICS (LRCL	K > 50kHz) (Note 5)		
Valid Sample Rates				88.2		192	kHz
	f _{PLP}		Ripple < δ _P , 88.2kHz ≤ f _S ≤ 96kHz	0.227 x f _S			Hz
Deschard Cutoff		SPK_WBAND_FIL	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.314 x f _S			Hz
Passband Cutoff	fPLP	T_EN = 0	Ripple < δ_P , 176.4kHz ≤ f_S ≤ 192kHz	0.1135 x f _S			Hz
			Droop < -3dB cutoff, 176.4kHz \leq f _S \leq 192kHz	0.232 x f _S			Hz
Passband Ripple	δ _P	SPK_WBAND_FIL T_EN = 0	f < f _{PLP} , referenced to signal level at 1kHz	-0.25		+0.25	dB

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Stopband Cutoff	f _{SLP}	SPK_WBAND_FIL T_EN = 0	Attenuation < δ_S			0.49 x f _S	Hz
	2	SPK_WBAND_FIL	f > f _{SLP,} 88.2kHz ≤ f _S ≤ 96kHz	80			-ID
Stoppand Attenuation	os	T_EN = 0	f > f _{SLP,} 176.4kHz ≤ f _S ≤ 192kHz	65			aв
Group Delay		SPK_WBAND_FIL T_EN = 0	f = 1kHz		6.9		Samples
DIGITAL AUDIO PATH /	FILTERING / DIO	GITAL FILTER CHAR	ACTERISTICS (LRCL	K > 50kHz) ((Note 5)		
Valid Sample Rates				88.2		192	kHz
	f _{PLP}		Ripple < δ _Ρ , 88.2kHz ≤ f _S ≤ 96kHz	0.325 x f _S			Hz
Deschand Cutoff		SPK_WBAND_FIL	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.463 x f _S			Hz
	fPLP	T_EN = 1	Ripple < δ _P , 176.4kHz ≤ f _S ≤ 192kHz	0.18 x f _S			Hz
			Droop < -3dB cutoff, 176.4kHz \leq f _S \leq 192kHz	0.3 x f _S			Hz
Passband Ripple	δ _P	SPK_WBAND_FIL T_EN = 1	f < f _{PLP} , referenced to signal level at 1kHz	-0.35		+0.35	dB
Stopband Cutoff	f _{SLP}	SPK_WBAND_FIL T_EN = 1	Attenuation < δ_S			0.52 x f _S	Hz
Stopband Attenuation	δ _S	SPK_WBAND_FIL T_EN = 1	f > f _{SLP}	77			dB
Group Delay		SPK_WBAND_FIL T_EN = 1	f = 1kHz		8.1		Samples
Max Device to Device Group Delay Variability		f _{IN} = 1kHz			1		μs
CLASS-DG AMPLIFIER		·					
Output Offset Voltage	V _{OS}	T _A = +25°C, Z _{SPK} = DRE_EN = 0	8Ω + 33μΗ,	-3	±0.65	+3	mV
		Peak voltage,			-68		
Click-and-Pop Level	K_{CP} audio playback silent, A-weighted, 32 samples per second, $T_A =$ +25°C (Note 6)		V _{PVDD} = 12V		-68		dBV

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONE	DITIONS	MIN	ТҮР	MAX	UNITS
	ЛЅРК	V _{PVDD} = 12V, V _{VBA} 1W, Z _L = 8Ω + 33μH	_{AT} = 3.8V, P _{OUT} = I, f _{IN} = 1kHz		87		
Efficiency	ЛЅРК	V _{PVDD} = 12V, V _{VBA} 1W, Z _L = 4Ω + 33μH	_{AT} = 3.8V, P _{OUT} = I, f _{IN} = 1kHz		83		0/
Enciency	ЛЅРК	V _{PVDD} = 19V, V _{VBA} 1W, Z _L = 8Ω + 33μH	_T = 5.0V, P _{OUT} = I, f _{IN} = 1kHz		83		70
	ЛЅРК	V _{PVDD} = 19V, V _{VBA} 20W, Z _L = 8Ω + 33μ	_{.T} = 5.0V, P _{OUT} = iH, f _{IN} = 1kHz		91		
		V _{PVDD} = 12V, Z _L = ≤ 1%, f _{IN} = 1kHz	4Ω + 33µH, THD+N		14		
Output Power		V _{PVDD} = 19V, Z _L = 1%, f _{IN} = 1kHz	8Ω + 33µH, THD+N ≤	20			
	Роит	V _{PVDD} = 14V, Z _L = 1%, f _{IN} = 1kHz	4Ω + 33µH, THD+N ≤		19		w
		V _{PVDD} = 12V, Z _L = 10%, f _{IN} = 1kHz	4Ω + 33μH, THD+N ≤		17.8		
		V _{PVDD} = 19V, Z _L = 10%, f _{IN} = 1kHz	25			1	
Peak Output Power	Роит	$Z_L = 4\Omega + 33\mu$ H; 50 signal)/1kHz (460 pe signal) alternating si 12dB; test duration 100°C and THD+N		60		w	
		f _{IN} = 1kHz, P _{OUT} =		-80		1	
		f _{IN} = 1kHz, P _{OUT} =	-80]	
		f _{IN} = 6kHz, P _{OUT} =	1W, Z _L = 8Ω + 33μH	-75			1
		f _{IN} = 6kHz, P _{OUT} =	2W, Z _L = 4Ω + 33μH		-73		
			$f_{IN} = 1 kHz, P_{OUT} =$ 1W, Z _L = 8 Ω + 33 μ H	-75	-82		
Total Harmonic Distortion + Noise	THD+N	V _{PVDD} = 12V	$f_{IN} = 1 kHz, P_{OUT} = 2W, Z_L = 4\Omega + 33 \mu H$		-80		dB
			f _{IN} = 6kHz, P _{OUT} = 1W, Z _L = 8Ω + 33μH		-76		
		V _{PVDD} = 14V	$V_{PVDD} = 14V$ $f_{IN} = 6kHz, P_{OUT} = 2W, Z_L = 4\Omega + 33\mu H$		-74		
Intermodulation Distortion		ITU-R standard, f _{IN} = -3dBFS	ITU-R standard, f _{IN} = 19kHz/20kHz, V _{IN} = -3dBFS				dB
Output Noise	e _N	A-weighted			15.5		μV _{RMS}

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Dynamic Range	DR	Measured using EIA output signal at 1kH output power at 1%	J method, -60dBFS z referenced to ГHD+N, A-weighted		118		dB
CLASS-DG AMPLIFIER	POWER SUPP	LY RIPPLE REJECTION	N				
VBAT Supply Rejection DC	PSRR	V _{VBAT} = 3.0V to 5.5	V	65	85		dB
			f _{RIPPLE} = 217Hz		78		
VBAT Supply Rejection	PSRR	VRIPPLE =	f _{RIPPLE} = 1kHz		78		dB
		100mvp-p	f _{RIPPLE} = 20kHz		64		
PVDD Supply DC Rejection	PSRR	SPK_MODE = 0x1(PVDD Mode)	V _{PVDD} = 3.0V to 20V	60	90		dB
		SPK_MODE =	f _{RIPPLE} = 217Hz		80		
PVDD Supply Rejection	PSRR	0x1(PVDD Mode),	f _{RIPPLE} = 1kHz		75		dB
		100mV _{P-P}	f _{RIPPLE} = 20kHz		60		
AVDD Supply DC Rejection	PSRR	V _{AVDD} = 1.71V to 1.	.89V	60	90		dB
			f _{RIPPLE} = 217Hz		90		
AVDD Supply Rejection	PSRR	V _{RIPPLE} =	f _{RIPPLE} = 1kHz		90		dB
			f _{RIPPLE} = 20kHz		70		
DVDD Supply DC Rejection	PSRR	V _{DVDD} = 1.14V to 1	.89V		100		dB
		PSRR V _{RIPPLE} = 100mV _{P-P}	f _{RIPPLE} = 217Hz		95		dB
DVDD Supply Rejection	PSRR		f _{RIPPLE} = 1kHz		95		
			f _{RIPPLE} = 20kHz		95		
DVDDIO Supply DC Rejection	PSRR	V _{DVDDIO} = 1.14V to	1.89V		100		dB
			f _{RIPPLE} = 217Hz		95		
Rejection AC	PSRR	VRIPPLE =	f _{RIPPLE} = 1kHz		95		dB
			f _{RIPPLE} = 20kHz		95		
CLASS-DG AMPLIFIER	POWER SUPP		ON				
Power Supply Intermodulation		f _{IN} = 1kHz, P _{OUT} = 400mW	V _{VBAT} , f _{RIPPLE} = 217Hz, V _{RIPPLE} = 100mV _{P-P}	-78	-85		
			V_{DVDD} , $f_{RIPPLE} =$ 217Hz, $V_{RIPPLE} =$ 100m V_{P-P}		-100		dB
			V _{DVDDIO} , f _{RIPPLE} = 217Hz, V _{RIPPLE} = 100mV _{P-P}		-100		

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Switching		Constant across all sample rates in the 48kHz family		472		
Frequency		Constant across all sample rates in the 44.1kHz family		451		KHZ
Frequency Response Deviation		Across the bandwidth 20Hz to 20kHz referenced to f _{IN} = 1kHz (Note 3)	-0.25		+0.25	dB
Gain Error	AVERROR		-0.5		+0.5	dB
Channel-to-Channel Phase Error		Output phase shift between multiple devices from 20Hz to 20kHz, across all sample rates and DAI operating modes		1		o
Minimum Load Resistance				3.2		Ω
Minimum Load Inductance		In series with a 3.2Ω load		0		μH
Maximum Load Inductance		In series with a 3.2Ω load		100		μH
Current Limit	ILIM	PVDD mode	6.2	7		А
SPEAKER VOLTAGE AD	C					
Resolution				16		Bits
Sample Rate	fSVSNS ADC		8		192	kHz
Voltage Range	V _{SPK}			±22		V
Dynamic Range	DNR	f _{IN} = 1kHz, AC measurement bandwidth = 20Hz to 20kHz, unweighted		81		dB
Total Harmonic Distortion + Noise	THD+N	f _{IN} = 1kHz, V _{SPK} = 8Vrms		-65		dB
		DC blocking filter enabled	-0.2		+0.2	
DC Offset Voltage		DC blocking filter disabled, $T_A = +25^{\circ}C$ (Note 3)	-10		+10	mV
Highpass Cutoff Frequency		-3dB limit across all sample rates			2	Hz
SPEAKER VOLTAGE AD	DC / DIGITAL FIL	TER CHARACTERISTICS (f _S < 50kHz) (No	ote 5)			
Passband Ripple		f _{IN} < f _{PLP,} referenced to signal level at 1kHz	-0.225		+0.225	dB
Lowpass Filter Cutoff Frequency	f _{PLP}	Droop < -3dB	0.44 x f _S			Hz
Lowpass Filter Stopband Frequency	f _{SLP}	-40dB limit			0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation			40			dB
Group Delay		f _{IN} = 1kHz		8		Samples

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP MAX	UNITS
SPEAKER VOLTAGE AD	C / DIGITAL FIL	TER CHARACTERIS	TICS (f _S > 50kHz) (No	ote 5)		
Passband Ripple		IVADC_WBAND_F ILT_EN = 0	f _{IN} ≤ f _{PLP} , referenced to signal level at 1kHz	-0.225	+0.225	dB
	f _{PLP}		Ripple < δ _P , 88.2kHz ≤ f _S ≤ 96kHz	0.26 x f _S		
Lowpass Filter Cutoff		IVADC_WBAND_F	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.31 x f _S		- Hz
Frequency	f _{PLP}	ILT_EN = 0	Ripple < δ _P , 176.4kHz ≤ f _S ≤ 192kHz	0.13 x f _S		
			Droop < -3dB, 176.4kHz ≤ f _S ≤ 192kHz	0.189 x f _S		
Lowpass Filter Stopband Frequency	f _{SLP}	IVADC_WBAND_F ILT_EN = 0	-40dB limit		0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation		IVADC_WBAND_FIL	.T_EN = 0	40		dB
Group Delay		IVADC_WBAND_F ILT_EN = 0	f _{IN} = 1kHz		10	Samples
SPEAKER VOLTAGE AD	C / DIGITAL FIL	TER CHARACTERIS	TICS (f _S > 50kHz) (No	ote 5)		
Passband Ripple		IVADC_WBAND_F ILT_EN = 1	f _{IN} ≤ f _{PLP} , referenced to signal level at 1kHz	-0.5	+0.5	dB
	f _{PLP}		Ripple < δ _P , 88.2kHz ≤ f _S ≤ 96kHz	0.27 x f _S		
Lowpass Filter Cutoff		IVADC WBAND F	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.475 x f _S		-
Frequency	f _{PLP}	ILT_EN = 1	Ripple < δ _P , 176.4kHz ≤ f _S ≤ 192kHz	0.13 x f _S		
			Droop < -3dB, 176.4kHz ≤ f _S ≤ 192kHz	0.31 x f _S		-
Lowpass Filter Stopband Frequency	f _{SLP}	IVADC_WBAND_F ILT_EN = 1	-40dB limit		0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation		IVADC_WBAND_FIL	T_EN = 1	40		dB

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS
Group Delay		IVADC_WBAND_F ILT_EN = 1	f _{IN} = 1kHz		10		Samples
SPEAKER CURRENT AD	C		·				
Resolution					16		Bits
Sample Rate	^f SISNS ADC			8		192	kHz
Current Range	I _{SPK}				±6.5		А
Dynamic Range	DNR	f _{IN} = 1kHz, AC measurement bandwidth = 20Hz to 20kHz, unweighted, referred to 4A _{PEAK}			73.5		dB
Total Harmonic Distortion + Noise	THD+N	f _{IN} = 1kHz, I _{SPK} = 1/		-55		dB	
Highpass Cutoff Frequency		-3dB limit across all	sample rates			2	Hz
		DC blocking filter ena	abled, T _A = +25°C	-0.12		+0.12	
DC Offset Current	DC blocking filter disabled, $T_A = +25^{\circ}C$ (Note 3)		-3		+3	mA	
SPEAKER CURRENT AD	C / DIGITAL FIL	TER CHARACTERIS	TICS (f _S < 50 kHz) (N	ote 5)			
Passband Ripple		f _{IN} < f _{PLP,} referenced 1kHz	d to signal level at	-0.225		+0.225	dB
Lowpass Filter Cutoff Frequency	f _{PLP}	Droop < -3dB		0.44 x f _S			Hz
Lowpass Filter Stopband Frequency	f _{SLP}	-40dB limit				0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation				40			dB
Group Delay		f _{IN} = 1kHz			8		Samples
SPEAKER CURRENT AD	C / DIGITAL FIL	TER CHARACTERIS	TICS (f _S > 50kHz) (No	ote 5)			
Passband Ripple	δ _Ρ	IVADC_WBAND_F ILT_EN = 0	f _{IN} ≤ f _{PLP} , referenced to signal level at 1kHz	-0.225		+0.225	dB

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
	fPLP		Ripple < δ _Ρ , 88.2kHz ≤ f _S ≤ 96kHz	0.26 x f _S			
Lowpass Filter Cutoff		IVADC WBAND F	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.31 x f _S			11-
Frequency	fPLP	ILT_EN = 0	Ripple < δ _P , 176.4kHz ≤ f _S ≤ 192kHz	0.14 x f _S			
			Droop < -3dB, 176.4kHz ≤ f _S ≤ 192kHz	0.189 x f _S			
Lowpass Filter Stopband Frequency	f _{SLP}	IVADC_WBAND_F ILT_EN = 0	-40dB limit			0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation		IVADC_WBAND_FIL	_T_EN = 0	40			dB
Group Delay		IVADC_WBAND_F ILT_EN = 0	f _{IN} = 1kHz		10		Samples
SPEAKER CURRENT ADC / DIGITAL FILTER CHARACTERISTICS (f _S > 50kHz) (Note 5)							
Passband Ripple	δ _P	IVADC_WBAND_F ILT_EN = 1	f _{IN} ≤ f _{PLP} , referenced to signal level at 1kHz	-0.5		+0.5	dB
	fPLP	 	Ripple < δ _Ρ , 88.2kHz ≤ f _S ≤ 96kHz	0.315 x f _S			
Lowpass Filter Cutoff		IVADC_WBAND_F	Droop < -3dB, 88.2kHz ≤ f _S ≤ 96kHz	0.475 x f _S			.
Frequency	fPLP	ILT_EN = 1	Ripple < ō _P , 176.4kHz ≤ f _S ≤ 192kHz	0.145 x f _S			ΠZ
			Droop < -3dB, 176.4kHz ≤ f _S ≤ 192kHz	0.31 x f _S			
Lowpass Filter Stopband Frequency	f _{SLP}	IVADC_WBAND_F ILT_EN = 1	-40dB limit			0.58 x f _S	Hz
Lowpass Filter Stopband Attenuation		IVADC_WBAND_FIL	_T_EN = 1	-40			dB
Group Delay		IVADC_WBAND_F ILT_EN = 1	f _{IN} = 1kHz		10		Samples
MEASUREMENT ADC							
PVDD Channel Input Voltage Range				2.5		22	V

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
PVDD Channel Voltage Resolution				38.1		mV
PVDD Channel Measurement Accuracy		T _A = +25°C	-150		+150	mV
VBAT Channel Input Voltage Range			2.5		5.5	V
VBAT Channel Voltage Resolution				19.04		mV
VBAT Channel Measurement Accuracy		T _A = +25°C, Note 3	-100		+100	mV
BROWNOUT-PREVENTI	ON ENGINE (BF	PE)				
BPE Attack Delay Time to Gain Change				15.5		μs
BPE Attack Delay Time to Interrupt				7.1		μs
THERMAL PROTECTION	N					
Thermal Shutdown Trigger Point		THERMSHDN_THRESH = 0x64	140	150	160	°C
DIGITAL I/O / INPUT-DI	N, BCLK, LRCL	K, RESET, ICC				
Input Voltage High	V _{IH}		0.7 x V _{DVDDI} O			V
Input Voltage Low	V _{IL}				0.3 x V _{DVDDI} O	V
Input Leakage Current			-1		+1	μA
Input Hysteresis	V _{HYS}		75			mV
Maximum Input Capacitance	C _{IN}			10		pF
Internal Pulldown Resistance	R _{PD}	BCLK, LRCLK, and ICC		3		MΩ
DIGITAL I/O / INPUT—I2	C1, I2C2, ADDR					
Input Voltage High	VIH		0.7 x V _{DVDDI} O			V
Input Voltage Low	VIL				0.3 x V _{DVDDI} O	V
Input Leakage Current		$T_A = +25^{\circ}C$, input high	-1		+1	μA
Input Hysteresis	V _{HYS}		75			mV

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Maximum Input Capacitance	C _{IN}			10		pF
DIGITAL I/O / OPEN DRA	IN OUTPUT—I2	C1, I2C2, IRQ, LV_EN				
Output Voltage Low	V _{OL}	I _{SINK} = 3mA			0.4	V
Output High Leakage Current	I _{ОН}	T _A = +25°C	-1		+1	μA
DIGITAL I/O / PUSH-PUL	L OUTPUT-DO	UT, ICC, IRQ				
Output Voltage High	V _{OH}	I _{OH} = 3mA	V _{DVDDI} ₀ - 0.3			V
Output Voltage Low	V _{OL}	I _{OL} = 3mA			0.3	V
		Maximum-drive mode		8		
Outrast Ourread	Levi	High-drive mode		6		4
	ЮН	Normal-drive mode		4		mA
		Reduced-drive mode		2		
PCM AUDIO INTERFACE	TIMING	1				
LRCLK Frequency Range	flrclk	All DAI operating modes	16		192	kHz
		I ² S/left-justified modes	1.024		12.288	• • • •
BCLK Frequency Range	[†] BCLK	TDM mode	1.024		24.576	
BCLK Duty Cycle	DC		45		55	%
		I ² S/left-justified only	80			
BCLK Period	^I BCLK	TDM mode	40			ns
Maximum BCLK Input Low-Frequency Jitter		Maximum allowable jitter before a -20dBFS, 20kHz input has a 1dB reduction in THD+N, RMS jitter ≤ 40kHz		0.2		ns
Maximum BCLK Input High-Frequency Jitter		Maximum allowable jitter before a -60dBFS, 20kHz input has a 1dB reduction in THD+N, RMS jitter > 40kHz		1		ns
PCM AUDIO INTERFACE	E TIMING / INTER	RFACE TIMING				
LRCLK to BCLK Active Edge Setup Time	^t SYNCSET		4			ns
LRCLK to BCLK Active Edge Hold Time	t _{SYNCHOLD}		4			ns
DIN to BCLK Active Edge Setup Time	^t SETUP		4			ns
DIN to BCLK Active Edge Hold Time	^t HOLD		4			ns
DIN Frame Delay After LRCLK Edge		Measured in number of BCLK cycles, set by selected TDM mode	0		2	cycles

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
PCM AUDIO INTERFACE	TIMING / INTER	RFACE TIMING / PCM DATA OUTPUT (DO	UT)			
BCLK Inactive Edge to DOUT Delay	^t CLKTX				14	ns
BCLK Active Edge to DOUT Hi-Z Delay	t _{HIZ}		4		18	ns
BCLK Inactive Edge to DOUT Active Delay	^t ACTV		0		14	ns
PCM AUDIO INTERFACE	TIMING / INTER	RFACE TIMING / INTERCHIP COMMUNICA	TION (ICC)			
ICC to BCLK Active Edge Setup Time	^t SETUP		4			ns
ICC to BCLK Active Edge Hold Time	thold		4			ns
BCLK Inactive Edge to ICC Delay	^t CLKTX				14	ns
BCLK Active Edge to ICC Hi-Z Delay	t _{HIZ}		4		18	ns
BCLK Inactive Edge to ICC Active Delay	^t ACTV		0		14	ns
I ² C INTERFACE TIMING						
Serial Clock Frequency	f _{SCL}				1000	kHz
Bus Free Time Between STOP and START Conditions	^t BUF		0.5			μs
Hold Time (Repeated) START Condition	^t HD,STA		0.26			μs
SCL Pulse-Width Low	t _{LOW}		0.5			μs
SCL Pulse-Width High	tнigн		0.26			μs
Setup Time for a Repeated START Condition	^t SU,STA		0.26			μs
Data Hold Time	^t HD,DAT		0		450	ns
Data Setup Time	^t SU,DAT		50			ns
SDA and SCL Receiving Rise Time	t _R		20		120	ns
SDA and SCL Receiving Fall Time	t _F		20 x V _{DVDDI} _O /5.5V		120	ns
SDA Transmitting Fall Time	tF		20 x V _{DVDDI} _O /5.5V		120	ns

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Electrical Characteristics (continued)

 $(V_{VBAT} = 5.0V, V_{PVDD} = 19V, V_{AVDD} = 1.8V, V_{DVDD} = 1.2V, V_{DVDDIO} = \overline{RESET} = 1.2V, C_{VBAT} = 1x10\mu$ F, $1x0.1\mu$ F, $C_{PVDD} = 1x220\mu$ F, $2x10\mu$ F, $2x0.1\mu$ F, $C_{AVDD} = 1\mu$ F, $C_{DVDD} = 1\mu$ F, $C_{DVDDIO} = 0.1\mu$ F, $C_{VREFC} = 1\mu$ F, $Z_{SPK} = 0$ pen, $f_s = 48$ kHz, AC Measurement Bandwidth = 20Hz to 22kHz, SPK_GAIN_MAX = 0xF (19dB), Data Width = 24-bit, DG Mode, $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted, Typical values are at $T_A = +25^{\circ}$ C) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Setup Time for STOP Condition	^t su,sто		0.26			μs
Bus Capacitance	CB				550	pF
Pulse Width of Suppressed Spike	t _{SP}		0		50	ns
RESET TIMING						
RESET Low	tRESET_LOW	Minimum low time for RESET to ensure device enters hardware shutdown		1		μs
Release from RESET	ti ² C_READY	Time from RESET = 1 to I ² C communication available (software shutdown)			1.5	ms

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

Note 2: 100% production tested at T_A = +25°C. Specifications over temperature limits are guaranteed by design. Typical values are based on one sigma characterization data unless otherwise noted.

Note 3: Minimum and/or maximum limit is guaranteed by design and by statistical analysis of device characterization data. The specification is not guaranteed by production testing.

Note 4: Assumes device is fully programmed (SPK_EN = 1) and EN = 1 is the last I²C write in the sequence.

Note 5: Digital filter performance is invariant over temperature and is production tested at $T_A = +25^{\circ}C$.

Note 6: Applies to all transitions in/out of full operation with noise gate enabled/disabled. Does not include state transitions due to fault conditions.

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)

 $(V_{VBAT} = 5.0V, V_{DVDD} = 1.2V, D_{VDDIO} = 1.2V, V_{AVDD} = 1.8V, V_{GND} = 0V, V_{PGND} = 0V, V_{PVDD} = 19V, C_{VBAT} = 10\mu F + 0.1\mu F, C_{PVDD} = 0.1\mu F + 10\mu F + 220\mu F, C_{DVDDIO} = 0.1\mu F, C_{VAVDD} = 1\mu F, C_{VAVDD} = 1\mu F, C_{VREFC} = 1\mu F, A_V = 19dB, Z_{SPK} = \infty$ between OUTP and OUTN, AC Measurement Bandwidth = 20Hz to 20kHz, fs = 48kHz, 24-bit data, f_{BCLK} = 3.072MHz. Typical values are at T_A = +25°C)



100

10

1

1

10

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)

 $(V_{VBAT} = 5.0V, V_{DVDD} = 1.2V, D_{VDDIO} = 1.2V, V_{AVDD} = 1.8V, V_{GND} = 0V, V_{PGND} = 0V, V_{PVDD} = 19V, C_{VBAT} = 10\mu F + 0.1\mu F, C_{PVDD} = 0.1\mu F + 10\mu F + 220\mu F, C_{DVDDIO} = 0.1\mu F, C_{VAVDD} = 1\mu F, C_{VAVDD} = 1\mu F, C_{VREFC} = 1\mu F, A_V = 19dB, Z_{SPK} = \infty$ between OUTP and OUTN, AC Measurement Bandwidth = 20Hz to 20kHz, f_S = 48kHz, 24-bit data, f_{BCLK} = 3.072MHz. Typical values are at T_A = +25°C)



OUTP

10V/div

OUTN

10V/div

FILTERED

OUTPUT 1V/div

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Operating Characteristics (continued)



20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Pin Configuration

35 WLP



Pin Description

PIN	NAME	FUNCTION	REF SUPPLY	TYPE
B4	DVDD	Digital Core Power Supply. Bypass to GND with a 1µF capacitor.		Supply
B5	DVDDIO	Digital Core and Interface Power Supply. Bypass to DGND with a $0.1\mu F$ capacitor.		Supply
C5, C6	DGND	Digital Ground		Supply
A1, A2, E1, E2	PVDD	Speaker Amplifier Power Supply. Bypass each bump to PGND with a 0.1μ F and 10μ F capacitor placed as close as possible. Bypass the supply bus to PGND with a single 220 μ F bulk capacitor per device.		Supply
C1, C2, C3	PGND	Speaker Amplifier Ground		Supply
D4, E4	VBAT	Battery Power Supply. Bypass to PGND with a $0.1\mu F$ and $10\mu F$ capacitor placed as close as possible.		Supply
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Pin Description (continued)

PIN	NAME	FUNCTION	REF SUPPLY	ТҮРЕ
A4	AVDD	Analog Power Supply. Bypass to GND with a 1µF capacitor placed as close as possible.		Supply
C4, D5, E5	AGND	Analog Ground. Connect to the common ground plane of the application.		Supply
E3	VREFC	Internal Bias. Bypass to GND with a 1µF capacitor.	PVDD	
A3	RESET	Hardware Enable (Active Low). Resets all digital portions of the device and all registers to default PoR settings.	DVDDIO	Digital Input
D1, D2	OUTP	Positive Speaker Amplifier Output	PVDD	Analog Output
D3	OUTPSNS	Voltage Sense and Speaker Amplifier Feedback Positive Input. Connect as close as possible to the positive terminal of the loudspeaker. This pin must form a complete loop with OUTP and is not intended to be driven externally.	PVDD	Analog Output
B1, B2	OUTN	Negative Speaker Amplifier Output	PVDD	Analog Output
В3	OUTNSNS	Voltage Sense and Speaker Amplifier Feedback Negative Input. Connect as close as possible to the negative terminal of the loudspeaker. This pin must form a complete loop with OUTN and is not intended to be driven externally.	PVDD	Analog Output
B7	I2C1	I ² C-Compatible Serial-Data/Clock 1. This pin can be configured as either a SDA or SCL. Connect a $1.5k\Omega$ pullup resistor to DVDDIO for full logic level swing.	DVDDIO	Digital I/O (Open drain)
A6	I2C2	I ² C-Compatible Serial-Data/Clock 2. This pin can be configured as either a SDA or SCL. Connect a $1.5k\Omega$ pullup resistor to DVDDIO for full logic level swing.	DVDDIO	Digital I/O (Open Drain)
B6	ADDR	I ² C Address Select. Selects one of eight I ² C slave addresses in conjunction with I2C1 and I2C2 pins.	DVDDIO	Digital Input
A5	IRQ	Hardware Interrupt Output. Interrupt polarity and pin drive mode are configurable. Connect a $1.5k\Omega$ pullup resistor to DVDDIO for full logic level swing in open drain mode.	DVDDIO	Digital Output
E7	BCLK	PCM Interface BCLK Input. Internally pulled down to DGND through R _{PD} .	DVDDIO	Digital Input
E6	LRCLK	PCM Interface Frame Clock Input/Output. LRCLK frequency matches the PCM interface sample rate. Internally pulled down to DGND through R_{PD} .	DVDDIO	Digital Input
D7	DIN	PCM Interface Data Input. Internally pulled down to DGND through R _{PD} .	DVDDIO	Digital Input
C7	DOUT	PCM Interface Data Output	DVDDIO	Digital Output
D6	LV_EN	Low Voltage Enable Output. This pin signals an external boost the active power supply used by the amplifier output stage. The pin is asserted when the amplifier uses VBAT as the supply for the output stage.	DVDDIO	Digital Ouput (Open Drain)
A7	ICC	Interchip Communication Data Bus. Optionally allows multiple devices to be grouped up to communicate with each other. Internally pulled down to DGND through R _{PD} .	DVDDIO	Digital I/O

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Functional Diagrams

Detailed Block Diagram



Detailed Description

Device State Control

The device has three distinct power states: the hardware shutdown state, software shutdown state, and active state. When transitioning between states, the device always moves from the hardware shutdown state to the software shutdown state (or the reverse) based on the state transition requirements. Normal transitions between the software shutdown state and active state are reversible without waiting for an in-progress transition to be completed. State transitions due to fault conditions, supply removal, and reset conditions are not reversible and are always completed (once initiated) to protect the device.

Hardware Shutdown State

When the device is first powered up or after a hardware reset event, the device always initializes into the hardware shutdown state. In hardware shutdown, the device is configured to its lowest power state. Upon entering hardware shutdown, the device is globally placed into a reset condition. As a result, the I^2C control interface is disabled and all device registers are returned to their PoR states. When exiting hardware shutdown, the device initializes and then transitions into the software shutdown state. During this transition (as part of initialization), the OTP register trim settings are loaded. If the OTP load routine fails to complete successfully, an <u>OTP_FAIL_*</u> interrupt is generated once the device reaches the software shutdown state.

When the hardware reset input (RESET) is asserted low, the device enters (or remains in) hardware shutdown. The device is also placed into hardware shutdown anytime the AVDD, DVDD, or DVDDIO supplies drop below their respective UVLO thresholds. The device only exits hardware shutdown when the AVDD, DVDD, and DVDDIO supplies are all above their respective UVLO thresholds and the hardware reset input (RESET) is asserted high. Once all of these conditions are met, the device automatically exits hardware shutdown and transitions into software shutdown.

Software Shutdown State

The device enters the software shutdown state after it transitions out of the hardware shutdown state and when exiting the active state. In the software shutdown state, all blocks are automatically disabled except for the I²C control interface. In the software shutdown state, all device registers can be programmed without restriction and all programmed register states are retained.

The global enable bit (\underline{EN}) is used to transition the device into and out of software shutdown. When global enable (\underline{EN}) is set high, the device transitions to the active state and a power-up done ($\underline{PWRUP_DONE_*}$) interrupt is generated. When the device is in the active state and global enable (\underline{EN}) is set low, the device transitions to the software shutdown state and a power-down done ($\underline{PWRDN_DONE_*}$) interrupt is generated. Additionally, the device is reset and enters software shutdown anytime the global enable bit (\underline{RST}) is written with a 1.

By default, the device supply configuration is PVDD and VBAT pins being supplied with voltages and in this scenario, regardless of the state of the global enable bit, the device cannot transition from the software shutdown state to the active state until PVDD and VBAT are all above their UVLO thresholds. If PVDD or VBAT supplies drop below their UVLO levels while the device is in the active state, the device is forced back into the software shutdown state.

In systems where the VBAT supply is not available, the device is configured to operate with PVDD only by connecting the VBAT pin to the VREFC pin on the PCB and setting the NOVBAT bit to 1. In this scenario, regardless of the state of the global enable bit, the device cannot transition from the software shutdown state to the active state until PVDD is above its UVLO thresholds. If PVDD supply drops below its UVLO levels while the device is in the active state, the device is forced back into the software shutdown state.

While in the software shutdown state, the PVDD and VBAT (if applicable) supplies can be powered down safely.

Recovery from Software Shutdown due to Supply Faults

The device provides two forms of fault recovery in the event that either VBAT or PVDD drop below their UVLO thresholds while the device is in its active state. Based on the setting of the <u>VBAT_AUTORESTART_EN</u> and <u>PVDD_AUTORESTART_EN</u> bits, the individual supply fault recovery is either in manual mode or auto restart mode.

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If the bit is set low, then the supply UVLO fault recovery is in manual mode. In manual mode, when the supply drops below its UVLO threshold, the device transitions into the software shutdown state (sets EN = 0) and generates the appropriate UVLO fault shutdown interrupt (<u>VBAT_UVLO_SHDN_*</u> or <u>PVDD_UVLO_SHDN_*</u> respectively). Even once the supply recovers (when voltage levels exceed the UVLO thresholds), the device remains in the software shutdown state until the global enable bit (<u>EN</u>) is set high by the host software.

If the bit is instead set high, then the supply UVLO fault recovery is in auto restart mode. In auto restart mode, when the supply drops below its UVLO threshold, the device is internally forced into software shutdown (*EN* state is preserved and remains high) and generates the appropriate UVLO fault shutdown interrupt (*VBAT_UVLO_SHDN_** or *PVDD_UVLO_SHDN_** respectively). Once the supply recovers (voltage levels exceed the UVLO thresholds), the device is no longer held in software shutdown and automatically restarts back into the active state (if all other conditions are met). These recovery modes do not apply when the AVDD, DVDD, or DVDDIO supplies cause a UVLO fault while the device is in the active state. If AVDD, DVDD, or DVDDIO drop below their UVLO thresholds, the device is reset and is placed into hardware shutdown.

Active State

The device always enters the active state through a transition from the software shutdown state. In the active state, all enabled device blocks are active and speaker amplifier playback is possible. In the active state, only dynamic register settings (or those restricted to disabled blocks) can be programmed safely.

The only non-fault state transitions to or from the active state are those initiated through the global enable bit (<u>EN</u>). All other transitions to or from the active state are the result of fault events, and can result in audible glitches if they occur during active playback.

Device Sequencing

Table 1 and Table 2 show the recommended typical device power-up and power-down sequences.

Table 1. Typical Power-Up Sequence

STEP	ACTION	DETAILED DESCRIPTION
1	Power-Up Core Supplies	Power the PVDD, VBAT, DVDD, DVDDIO, and AVDD supplies above their UVLO thresholds. If the VBAT pin is unavailable in the system, connect the VBAT pin to the VREFC pin.
2	Exit Hardware Shutdown State	Assert the hardware reset input (RESET) to a logic high level. If RESET is tied to the DVDD/DVDDIO supply, this step is combined with step 1.
3	Enter Software Shutdown State	The device finishes the transition and enters the software shutdown state after the release from reset time ($t_1 2_{C_{READY}}$) elapses.
4	Program the Device Registers/Enable the External Clocks	The I ² C interface is active, and all registers can be freely configured. If the VBAT pin is unavailable in the system, set the NOVBAT bit to logic high. Start both external clocks before exiting the software shutdown state.
5	Exit Software Shutdown State	If volume ramping is disabled, the input audio data should be silent. Set the global enable to a logic high ($\underline{EN} = 1$).
6	Enter the Active State	Device enters the active state after the turn-on time (t _{ON}) elapses.
7	Active State/Audio Playback	Dynamic bits (and those restricted to disabled blocks) can be programmed. The device is capable of audio playback in the active state.

Table 2. Typical Power-Down Sequence

STEP	ACTION	DETAILED DESCRIPTION
1	Exit the Active State	If volume ramping is disabled, the input audio data should be silent. Set the global enable bit to a logic low ($\underline{EN} = 0$)
2	Enter Software Shutdown State	Device enters software shutdown state after the turn-off time (t_{OFF}) elapses.

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Table 2. Typical Power-Down Sequence (continued)

STEP	ACTION	DETAILED DESCRIPTION
3	Reprogram Device Registers/Disable the External Clocks	The device is fully programmable, and can idle in the software shutdown state. To return to the active state, resume the power-up sequence from step 5.
4	Enter Hardware Shutdown State	For full hardware shutdown, disable the external clocks first. Assert the reset input (RESET) to ground or power down DVDD/DVDDIO. The AVDD/PVDD/VBAT supplies (if applicable) can be disabled.

PCM Interface

The flexible PCM slave interface supports common audio playback sample rates from 16kHz to 192kHz and I/V sense ADC sample rates from 8kHz to 192kHz. The PCM interface also supports standard I²S, left-justified, and TDM data formats. The PCM interface is disabled and powered down when both the PCM data input (DIN) and PCM data output (DOUT) are disabled.

PCM Clock Configuration

The PCM slave interface requires the host to supply both BCLK and LRCLK. To configure the PCM interface clock inputs, the host must program both the device interface sample rate ($\underline{PCM_SR}$) and BCLK to LRCLK ($\underline{PCM_BSEL}$) ratio. The PCM interface sample rate must be configured to match the frequency of the frame clock (LRCLK) using the $\underline{PCM_SR}$ registers. The speaker path sample rate is also set by the $\underline{PCM_SR}$ setting. However, the I/V sense ADC path sample rate ($\underline{IVADC_SR}$) can be set to the same rate or lower rate than the speaker path sample rate ($\underline{PCM_SR}$) according to the restrictions in <u>Table 3</u>. When the I/V sense ADC path is set to a lower rate than the speaker amplifier path, the output data contains repeated samples.

N/A = Not Available	I/V SENSE ADC SAMPLE RATE (kHz)												
N/S = Not Supported	ł	192	96	88.2	48	44.1	32	24	22.05	16	12	11.025	8
	192	1	2	N/S	4	N/S	6	8	N/S	12	16	N/S	24
	96	N/A	1	N/S	2	N/S	3	4	N/S	6	8	N/S	12
	88.2	N/A	N/A	1	N/S	2	N/S	N/S	4	N/S	N/S	8	N/S
PCM Interface	48	N/A	N/A	N/A	1	N/S	N/S	2	N/S	3	4	N/S	6
and Speaker	44.1	N/A	N/A	N/A	N/A	1	N/S	N/S	2	N/S	N/S	4	N/S
Rate (kHz)	32	N/A	N/A	N/A	N/A	N/A	1	N/S	N/S	2	N/S	N/S	4
	24	N/A	N/A	N/A	N/A	N/A	N/A	1	N/S	N/S	2	N/S	3
	22.05	N/A	N/A	N/A	N/A	N/A	N/A	N/A	1	N/S	N/S	2	N/S
	16	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	1	N/S	N/S	2

Table 3. Sample Rate Selection for I/V Sense

The device supports a range of BCLK to LRCLK clock ratios (<u>PCM_BSEL</u>) ranging from 32 to 512. However, based on the selected PCM interface sample rate (LRCLK frequency), the configured clock ratio cannot result in a BLCK frequency that exceeds 24.576MHz.

PCM Data Format Configuration

The device supports the standard I²S, left-justified, and TDM data formats. The operating mode is configured using the <u>PCM_FORMAT</u> bit field.

I²S/Left-Justified Mode

I²S and left-justified formats support two channels that can be 16-, 24-, or 32-bits in length. The BCLK to LRCLK ratio (<u>PCM_BSEL</u>) must be configured to be twice the desired channel length. The audio data word size is configurable to 16-, 24-, or 32-bits in length (<u>PCM_CHANSZ</u>), but must be programmed to be less than or equal to the channel length. If

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the resulting channel length exceeds the configured data word size then the data input LSBs are truncated and the data output LSBs are padded with either zero or Hi-Z data based on the <u>PCM_TX_EXTRA_HIZ</u> register bit setting.

Table 4. Supported I²S/Left-Justified Mode Configurations

CHANNELS	CHANNEL LENGTH	BCLK TO LRCLK RATIO (<u>PCM_BSEL</u>)	SUPPORTED DATA WORD SIZES (<u>PCM_CHANSZ</u>)
	16	32	16
2	24	48	16, 24
	32	64	16, 24, 32

With the default PCM settings, falling LRCLK indicates the left channel data (Channel 0) and the start of a new frame while rising LRCLK indicates the right channel data (Channel 1). In I²S mode, the MSB of the audio word is latched on the second active BCLK edge after an LRCLK transition. In left-justified mode, the MSB of the audio word is latched on the first active BCLK edge after an LRCLK transition.

The <u>PCM_BCLKEDGE</u> register bit selects either the rising or falling edge of BCLK as the active edge that is used for data capture (DIN) and data output (DOUT). The <u>PCM_CHANSEL</u> bit configures which LRCLK edge indicates the start of a new frame (Channel 0), and LRCLK transitions always align with the inactive BCLK edge. The data output is valid on the same active BCLK edge as the data input. The data output also transitions on the same edge as the data input.

LRCLK	CHANNEL 0 (LEFT)	CHANNEL 1 (RIGHT)	
DOUT	15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0/ PAD BITS	15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0/	PAD BITS (15)(14)
BCLK			
DIN	15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0	15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0	15 (14)

Figure 1. Standard I²S Mode

	CHANNEL 0 (LEFT)	CHANNEL 1 (RIGHT)	7
)15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0/ PAD BITS	χ 15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0/ PAD BITS	15 14 13
всік ∏			
	<u>}</u> 15)14)13)12)11)10)9)8)7)6)5)4)3)2)1)0	<u>)</u> 15)14)13)12)11)10)9)8)7)6)5)4)3)2)1)0	15 14 13

Figure 2. Left-Justified Mode

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	CHANNEL 0 (LEFT)	CHANNEL 1 (RIGHT)
	(15)(14)(13)(12)(11)(10)(9)(8)(7)(6)(5)(4)(3)(2)(1)(0) PAD BITS)15/14/13/12/11/10/9/8/7/6/5/4/3/2/1/0/ PAD BITS /15/14/13)
BCLK		
din Z	(6)(4)(3)(2)(1)(0)(9)(8)(7)(6)(5)(4)(3)(2)(1)(0)	15 (4)(13)(12)(11)(10)(9)(8)(7)(6)(5)(4)(3)(2)(1)(0)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)

Figure 3. Left-Justified Mode (LRCLK Inverted)

LRCLK		CHANNEL 0 (LEFT)		CHANNEL 1 (RIG	HT)	
DOUT	15/14/13/12/11/10/	9)8)7)6)5)4)3)2)1)0)	PAD BITS	X 15X 14X 13X 12X 11X 10X 9X 8X 7X 6X 5X 4X 3X 2X 1	0 PAD BITS	15 14 13
BCLK						
DIN	15/14/13/12/11/10/	9)8)7)6)5)4)3)2)1)0) 15) 14) 13) 12) 11) 10) 9) 8) 7) 6) 5) 4) 3) 2) 1) o /////// ////////////////////////////	15 14 13

Figure 4. Left-Justified Mode (BCLK Inverted)

TDM Modes

The provided TDM modes support timing for up to 16 digital audio input channels (DIN), each containing 16-, 24-, or 32-bits of data. The digital audio output (DOUT) is structured into 8-bit slots, and the timing can support up to a maximum of 128 data output slots. The number of TDM input channels and output slots is determined by both the selected BCLK to LRCLK ratio (*PCM_BSEL*) and the selected data word and channel length (*PCM_CHANSZ*).

For a given valid configuration, the number of available data input channels per frame is calculated as follows:

Number of Available Data Input Channels = BCLK to LRCLK Ratio/Channel Length

For a given valid configuration, the number of available 8-bit data output slots per frame is calculated as follows:

Number of Available Data Output Slots = BCLK to LRCLK Ratio/8

<u>Table 5</u> shows the supported TDM mode configurations for each combination of input data channels and output data slots. In some configurations, the maximum PCM interface and speaker amplifier playback sample rate is limited to less than 96kHz to avoid violating the BCLK frequency limit of 24.576MHz.

Table 5. Supported TDM Mode Configurations

INPUT DATA CHANNELS	OUTPUT DATA SLOTS	DATA WORD SIZES (PCM_DATA_WIDTH)	BCLK TO LRCLK RATIO (PCM_BSEL)	MAXIMUM SPEAKER PLAYBACK SAMPLE RATE (FLRCLK)
	4	16	32	
2	6	24	48	10264-
	8	32	64	192KHZ
3	15	32	125	

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INPUT DATA CHANNELS	OUTPUT DATA SLOTS	DATA WORD SIZES (PCM_DATA_WIDTH)	BCLK TO LRCLK RATIO (PCM_BSEL)	MAXIMUM SPEAKER PLAYBACK SAMPLE RATE (FLRCLK)
	8	16	64	
4	12	24	96	
	16	32	128	
5	15	24	125	
7	15	16	125	
	4	16	32	
2	6	24	48	
	8	32	64	
3	15	32	125	
	8	16	64	
4	12	24	96	
	16	32	128	
5	15	24	125	96kHz
7	15	16	125	
1	31	32	250	
	16	16	128	
8	24	24	192	
	32	32	256	
10	31	24	250	
15	31	16	250	
16	32	16	256	
7	31	32	250	
10	31	24	250	
10	40	32	320	48kHz
15	31	16	250	
16	48	24	384	
16	64	32	512	

Table 5. Supported TDM Mode Configurations (continued)

With the default PCM interface settings in TDM mode, a rising frame clock (LRCLK) edge acts as the frame sync pulse and indicates the start of a new frame. The frame sync pulse width must be equal to at least one bit clock period. However, the falling edge can occur at any time as long as it does not violate the setup time of the next frame sync pulse rising edge. The <u>PCM_CHANSEL</u> bit can be used to invert the LRCLK edges (sync pulse) used to start a TDM frame.

In TDM mode, the MSB of the first audio word can be latched on the first (TDM Mode 0), second (TDM Mode 1), or third (TDM Mode 2) active BCLK edge after the sync pulse and is programmed by the <u>PCM_FORMAT</u> bits. Additionally, the <u>PCM_BCLKEDGE</u> register bit allows the BLCK edge (that is used for data capture and data output) to be programmed. The data output is valid on the same active BCLK edge as the data input. The data output also transitions on the same edge as the data input.

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Figure 5. TDM Modes

PCM Data Path Configuration

The PCM interface data input (DIN) receives the source data for the speaker amplifier path and the speaker audio processing bypass path while the data output (DOUT) transmits the data from the I/V sense ADC path. In addition, the PCM data output can also transmit internal diagnostic data such as the speaker DSP monitor path, supply measurement ADC results, device status reporting, and the DHT attenuation level.

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PCM Data Input



Figure 6. PCM Data Input

The PCM playback path is enabled with the <u>PCM_RX_EN</u> bit and can accept data from any valid input data channel. The device provides an input digital mono mixer that can route a single channel or mix two PCM input channels to create a mono input to the speaker playback path. The <u>PCM_DMMIX_CFG</u> bit is used to configure the mixer, while the <u>PCM_DMMIX_CH0_SOURCE</u> and <u>PCM_DMMIX_CH1_SOURCE</u> bits select which of the 16 PCM input channels are used as the input to the mono mixer. In I²S and left-justified modes, only two input data channels are available while in TDM mode up to 16 channels of input data can be available. If the PCM_playback path is disabled (<u>PCM_RX_EN</u> = 0), a zero code value is driven into the speaker amplifier path.

The device also supports an audio processing bypass path from the PCM input to speaker amplifier output that bypasses the audio processing blocks like the volume control, DHT, BPE, and thermal foldback circuits. The audio processing bypass path is enabled by setting the <u>PCM_BYP_EN</u> bit field to 1. The PCM data input for the audio processing bypass path is selected with the <u>PCM_BYPASS_SOURCE</u> bit field. If the PCM audio processing bypass path is disabled (<u>PCM_BYP_EN</u> = 0), a zero code value is driven into the audio processing bypass path.

PCM Data Output

The PCM interface data output (DOUT) is enabled by the <u>PCM_TX_EN</u> bit field, and can transmit any output data type onto any valid output channel or slot. In I²S and left-justified mode, only two data output channels are available in each output transmit frame (Channel 0 and 1). In TDM mode, each output transmit frame can contain up to 64 sequential 8-bit data output slots, each of which are numbered from 0 up to a maximum of 63.

The PCM data output can transmit several different output data types. In I²S and left-justified modes, only the speaker amplifier output voltage sense, output current sense, and DSP monitor output data types are available for data output transmission. If the word size of the data output type is longer than output channel data word (<u>PCM_CHANSZ</u>), the lowest trailing bits are truncated.

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In TDM mode, all output data types are available and are individually assigned to data output slots. The output data types vary in word size from 3 bits to 32 bits, and as a result require from 1 to 4 data output slots to transmit in TDM mode. Table 6 shows the supported output data types and the parameters of each data type.

OUTPUT DATA TYPE	SYMBOL	DATA WORD SIZE (BITS)	NUMBER OF TDM SLOTS	ENABLE/SLOT ASSIGNMENT
Speaker Amplifier Output Voltage Sense	VMON	16	2	PCM_VMON_ENI PCM_VMON_SLOT
Speaker Amplifier Output Current Sense	IMON	16	2	PCM_IMON_ENI PCM_IMON_SLOT
Speaker Amplifier DSP Monitor	DSPMON	32	4	PCM_DSPMONITOR_ENI PCM_DSP_MONITOR_SLOT
Applied DHT Attenuation	DHT_ATN	16	2	PCM_DHT_ATN_ENI PCM_DHT_ATN_SLOT
Battery Voltage (V _{VBAT})	VBAT	16	2	PCM_VBAT_ENI PCM_VBAT_SLOT
PVDD Voltage (V _{PVDD})	PVDD	16	2	PCM_PVDD_ENI PCM_PVDD_SLOT
BPE Level	BPELVL	3	1	PCM_BPE_ENI PCM_BPE_SLOT
Device Status Flags	FLAG	14	2	PCM_STATUS_ENI PCM_STATUS_SLOT

Table 6. Supported PCM Data Output Types

An individual enable and slot assignment bit field is provided for each output data type. In I²S and left-justified modes, use output slot 0 to assign data to Channel 0 and output slot 1 to assign data to Channel 1. In TDM mode, the slot assignment selects the slot where the output data type transmit begins for data output types requiring more than one slot to transmit (e.g., a two slot data type assigned to slot 6 would occupy slots 6 and 7).

In TDM mode, each data type can be assigned to any valid data output slot (or series of slots) with some restrictions. First, it is invalid for data types to be assigned such that the data word extends beyond the end of the data output frame. For example, data types that require two slots to transmit cannot be assigned to the last slot of the frame. Next, it is also invalid to assign a data output type to any slot that overlaps with the slot assignment of another data type (this also applies to channels in I²S and left-justified modes). Finally, it is invalid to assign a data type to any slots that do not exist in the frame structure of the current PCM interface configuration.

Any data output (DOUT) slots that exist in the current frame structure but have no output data type assigned to them are either Hi-Z or driven with a 0 code (as set by the <u>PCM_TX_SLOT_HIZ</u> bit field). Likewise, if a data output type is disabled, then the assigned data output slot(s) are also either Hi-Z or driven with a 0 code (as set by the <u>PCM_TX_SLOT_HIZ</u> bit field).

Data Output Channel-Interleaved I/V Sense Data

In I²S and left-justified use cases, the PCM interface limits the number of available data output channels to two making it impossible to fit amplifier output current and voltage sense data from stereo devices on a single shared data output (DOUT) line. For these cases, the data output can be configured to allow the current and voltage sense data types from a single device to share a single data output channel. To enable channel-interleaved mode, set the <u>PCM_TX_INTERLEAVE</u> bit high. Then assign the current and voltage sense data types to the same valid data channel (using <u>PCM_VMON_SLOT</u> and <u>PCM_IMON_SLOT</u>).

In this configuration, the current and voltage sense data types are frame interleaved on the assigned data output channel. The current and voltage sense data words are both 16-bits in length, and as a result if the channel length is longer than 16-bits the trailing padding bits are set to either Hi-Z or zero code depending on the state of the <u>PCM_TX_EXTRA_HIZ</u> bit field.

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To identify the data type in channel-interleaved mode, the LSB of the 16-bit data word is dropped (truncated). The data word is then right shifted by a single bit, and the now vacant MSB is replaced with either a 0 to indicate voltage sense data or a 1 to indicate current sense data. For phase alignment, the voltage sense data for a single sampling instant is always transmitted in the assigned channel on the first frame, followed by the current sense data on the second frame. The MSB value and the transmission order allow the host to identify and phase-align the output data across frames.

Since the I/V sense data is frame interleaved, the sample rate for the PCM interface must be greater than that of the I/V sense ADCs by an integer ratio of 2. The example below shows a basic case where the sample rate of the PCM interface is twice that of the I/V sense ADCs.



Figure 7. I/V Sense Path Data Interleaved on a Single Data Output Channel

Data Output Status Bits

The following interrupt information is reported in the status slots:

- Bit 15: BPE level 0 begin
- Bit 14: BPE level change
- Bit 13: BPE active begin
- Bit 12: BPE active end
- Bit 11: Thermal warning 1 begin
- Bit 10: Thermal warning 1 end
- Bit 9: Thermal warning 2 begin
- Bit 8: Thermal warning 2 end
- Bit 7: Thermal foldback begin
- Bit 6: Thermal foldback end
- Bit 5: DHT active end
- Bit 4: DHT active begin
- Bit 3: Speaker overcurrent
- Bit 2: Power-up done
- Bit 1: 0
- Bit 0: 0

Each of the interrupt information above corresponds to a raw interrupt and is 1 bit wide. When a raw interrupt has a rising edge, the corresponding status bit goes high during the next LRCLK frame. The status bit goes low during the next LRCLK frame even if the raw interrupt has remained high.

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PCM Interface Timing

Figure 8 and Figure 9 shows timing for BCLK, LRCLK, DIN, and DOUT. See the Electrical Characteristics table for more details.



Figure 8. PCM Interface Timing/Slave Mode—LRCLK, BCLK, DIN Timing Diagram



Figure 9. PCM Interface Timing/DOUT Timing Diagram

Interrupts

The device supports individually enabled status interrupts for sending feedback to the host about events that have occurred on-chip. When enabled, interrupts are transmitted on the IRQ output.

Interrupt Bit Field Composition

Each interrupt source has five individual bit field components. The function of each component is detailed as follows, and the corresponding bit fields for each source can be identified by the appended suffix (shown in parentheses).

- Raw Status (RAW): Each interrupt source has a read-only bit to indicate the real-time raw status of the interrupt source.
- State (STATE): Each interrupt source has a read-only state bit that is set whenever a rising edge occurs on the associated raw status bit. The state bit is set regardless of the setting of the source enable bit.
- Flag (FLAG): Each interrupt source has a read-only flag bit. If the source enable bit is set, then the flag bit is set and an interrupt can be generated whenever the source state bit is set.
- Enable (EN): Each interrupt source has a dynamic read/write enable bit. When the enable bit is set, the associated flag bit is set and an interrupt can be generated whenever the source state bit is set.
- Clear (CLR): Each interrupt source has a dynamic write-only clear bit. Writing a 1 to a clear bit resets the associated state and flag bits to 0. Writing a 0 to a clear bit has no effect. In I²C control mode, the IRQ output is deasserted if all flag bits are 0.

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Interrupt Output Configuration

The device allows the user to configure the drive mode, drive strength, and polarity of the IRQ output. The <u>IRQ_MODE</u> bit controls the drive mode. If <u>IRQ_MODE</u> is 0, the pin is configured as an open-drained output and requires an external pullup resistor. If <u>IRQ_MODE</u> is 1, then IRQ is configured as a push-pull CMOS output.

Additionally, when IRQ is configured as a push-pull CMOS output, the drive strength control (<u>IRQ_DRV</u>) bits set the drive strength of the IRQ output. Four different CMOS drive strengths are available.

The <u>IRQ_POL</u> bit controls the polarity of the IRQ bus. Interrupt events (a flag bit is set high) assert the IRQ bus low if <u>IRQ_POL</u> = 0 and high if <u>IRQ_POL</u> = 1. The IRQ bus deasserts if all flag bits are cleared (set low).

Interrupt Sources

Table 7. Interrupt Sources

INTERRUPT SOURCES	BIT FIELD	DESCRIPTION
Thermal Shutdown Begin Event	THERMSHDN_BGN_*	Indicates when the thermal-shutdown threshold temperature has been exceeded.
Thermal Shutdown End Event	THERMSHDN_END_*	Indicates that the die temperature was previously above the thermal-shutdown threshold and has now dropped below the threshold.
Thermal Warning 1 Begin Event	THERMWARN1_BGN_*	Indicates when the thermal-warning1 threshold temperature has been exceeded.
Thermal Warning 1 End Event	THERMWARN1_END_*	Indicates that the die temperature was previously above the thermal-warning1 threshold and has now dropped below the threshold.
Thermal Warning 2 Begin Event	THERMWARN2_BGN_*	Indicates when the thermal-warning2 threshold temperature has been exceeded.
Thermal Warning 2 End Event	THERMWARN2_END_*	Indicates that the die temperature was previously above the thermal-warning2 threshold and has now dropped below the threshold.
Thermal Foldback Begin Event	THERMFB_BGN_*	Indicates that the die temperature is above the thermal-warning1 threshold and the device is attenuating the output.
Thermal Foldback End Event	THERMFB_END_*	Indicates die temperature is below thermal-warning1 threshold and device has stopped attenuating the output.
BPE Level Change Event	BPE_LEVEL_*	Indicates that the BPE has transitioned between thresholds.
BPE Active Begin Event	BPE_ACTIVE_BGN_*	Indicates that the BPE is active.
BPE Active End Event	BPE_ACTIVE_END_*	Indicates that the BPE is no longer active.
BPE Level 0 Begin Event	<u>BPE_L0_*</u>	Indicates that the BPE has transitioned into L0.
OTP Load Fail Event	OTP_FAIL_*	Indicates when the OTP load routine that runs when exiting hardware shutdown has failed to complete successfully. If the OTP load routine fails, the device is held in software shutdown.

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Speaker Over	SPK OVC *	Indicates that the speaker amplifier current limit has been exceeded
Current Event	<u>SFK_0VC_</u>	
Internal CLK Error	INT_CLK_ERR_*	Indicates a clock stop error in the internal clocks of the device.
External CLK (BCLK/LRCLK) Error	CLK_ERR_*	Indicates a frequency or framing error in the input BCLK or LRCLK.
External CLK (BCLK/LRCLK) Recover	CLK_RECOVER_*	Indicates that the input BCLK or LRCLK has recovered after an error event.
Speaker Amplifier Monitor Error	INT_SPKMON_ERR_*	Indicates an amplifier output stuck high or low error.
External Data (DIN) Error	DMON_ERR_*	Indicates a data stuck or data magnitude error at the PCM data input (DIN).
Power-Up Done Event	PWRUP_DONE_*	Indicates when the device has entered the active state and the device is ready to play audio.
Power-Down Done Event	PWRDN_DONE_*	Indicates when the device has entered the software shutdown state.
PVDD UVLO Shutdown Event	PVDD_UVLO_SHDN_*	Indicates that PVDD is below the minimum allowed voltage when the device is in active state.
VBAT UVLO Shutdown Event	VBAT_UVLO_SHDN_*	Indicates that VBAT is below the minimum allowed voltage when the device is in active state.
DHT Active Begin Event	DHT_ACTIVE_BGN_*	Indicates that the DHT circuit is active and is applying attenuation to the signal.
DHT Active End Event	DHT_ACTIVE_END_*	Indicates that the DHT circuit has stopped applying attenuation to the signal.
NOTE: The bit fields are shown without the component suffixes. For example, OTP_FAIL_* refers to OTP_FAIL_RAW, OTP_FAIL_STATE, OTP_FAIL_FLAG, OTP_FAIL_EN, and OTP_FAIL_CLR. All interrupt sources have these five component bit fields.		

Table 7. Interrupt Sources (continued)

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Speaker Path

Speaker Path Block Diagram



Figure 10. Speaker Signal Path Diagram

Speaker Playback Path

The source input data to the speaker amplifier path is routed from either the PCM interface or the tone generator. The data is then routed through digital filters, signal processing, and volume/gain control blocks before reaching the Class-DG speaker amplifier.

Speaker Path Noise Gate

The speaker path noise gate function is enabled when the device is in the active state and the noise gate enable (<u>NOISEGATE_EN</u>) is set to 1. The noise gate enable can be programmed dynamically. However, if the noise gate function is disabled (<u>NOISEGATE_EN</u> is set to 0) while the noise gate is active (speaker path actively muted), the noise gate function remains active until after it deactivates normally (unmutes the speaker path).

When the noise gate is enabled, the noise gate activates whenever the amplitude of the input audio data to the speaker path (from the PCM interface) is below the configured mute threshold (<u>MUTE_THRESH</u>) for more than 1024 consecutive data samples. When the noise gate is active, the amplifier path is muted, the current and voltage sense ADC paths output zero code data, and the device idles in a reduced power state.

The noise gate deactivates immediately if the amplitude of a single sample from the input audio data exceeds the configured unmute threshold (<u>UNMUTE_THRESH</u>). When the noise gate deactivates, the speaker path is unmuted and returns to normal operation before the input audio data (that triggered deactivation) reaches the speaker output. Once noise gate deactivation is complete, the current and voltage sense ADC paths resume operation and output data normally.

The noise gate mute and unmute threshold settings are selected in terms of the number of bits (starting from the LSB) that must be toggling (or active) in order for the input signal amplitude to exceed the thresholds. It is invalid to set the noise gate unmute threshold (<u>UNMUTE THRESH</u>) such that it is less than the configured mute threshold (<u>MUTE_THRESH</u>). The location of the audio data LSB within the PCM input data channel is determined by the configured PCM data word size (<u>PCM_CHANSZ</u>). The supported combinations are shown in <u>Table 8</u>.

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Table 8. Noise Gate/Idle Mode Threshold LSB Location by Input Data Configuration

INPUT DATA WORD SIZE (<u>PCM_CHANSZ</u>)	NOISE GATE FUNCTION LSB LOCATION
16	16
24	24
32	24

It is not valid to enable the speaker path noise gate function when the tone generator is enabled or when the speaker idle mode is enabled.

Speaker Path Dither

The input data to the speaker path can optionally have dither (±1LSB peak-to-peak) applied if <u>SPK_DITH_EN</u> is set to 1. No dither is applied when <u>SPK_DITH_EN</u> is set to 0.

Speaker Path Data Inversion

The input data to the speaker path can optionally be inverted by setting the <u>SPK_INVERT</u> bit to 1. The input data to the speaker path can only be inverted when the speaker DC blocking filter is also enabled by setting <u>SPK_DCBLK_EN</u> to 1.

Speaker Path DC Blocking Filter

A DC blocking filter can be enabled on the speaker path by setting the <u>SPK_DCBLK_EN</u> bit to 1.

Speaker Path Digital Volume Control

The device has a dynamically programmable speaker path digital volume control. The digital volume control provides an attenuation range of 0dB to -63dB in 0.5dB steps that is configured with the <u>SPK_VOL</u> bit field. A digital mute is also provided, and is enabled when <u>SPK_VOL</u> is set to 0x7F.

Digital volume ramping during speaker path start up, speaker path shutdown, and digital mute (<u>SPK_VOL</u> = 0x7F) is disabled by default. However, both the volume ramp up and ramp down can be individually enabled with the <u>SPK_VOL_RMPUP_BYPASS</u> and <u>SPK_VOL_RMPDN_BYPASS</u> bit fields respectively. When volume ramp up or ramp down is enabled, the device turn-on and turn-off times are longer.

Speaker Path Digital Gain Control

The device provides a programmable speaker path digital gain control. The digital gain control provides a range of 0dB to +6dB in 0.5dB steps that is configured with the <u>SPK_GAIN</u> bit field. Unlike the digital volume control, the digital gain setting cannot be dynamically changed.

Speaker Path DSP Data Feedback Path

The speaker path DSP data can be routed from just before the DAC input back to the PCM interface, and can be assigned to any valid data output channel. The speaker path DSP data feedback path is enabled with the <u>SPK_FB_EN</u> bit.

Speaker Safe Mode

The device provides a safe mode bit (<u>SPK_SAFE_EN</u>) which applies a -18dB attenuation to the input signal when set to 1. By default, speaker safe mode is enabled to protect any speaker connected to the device on power-up. While speaker safe mode is enabled, the digital volume control (<u>SPK_VOL</u>) and speaker digital gain control (<u>SPK_GAIN</u>) settings are ignored.

Speaker Audio Processing Bypass Path

In applications where the audio processing in the main speaker path is not desired, the device provides a bypass path. The bypass path is selected with the <u>PCM_BYPASS_EN</u> bit field. The PCM data input channel for the speaker audio processing bypass path is selected with the <u>PCM_BYPASS_SOURCE</u> bit field.

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Bypass Path Data Inversion

The input data to the audio processing bypass path can optionally be inverted by setting the <u>BYP_INVERT</u> bit to 1. The input data to the audio processing bypass path can only be inverted when the DC blocking filter is also enabled by setting <u>SPK_DCBLK_EN</u> to 1.

Bypass Path Dither

The input data to the audio processing bypass path can optionally have dither (±1LSB peak-to-peak) applied if <u>SPK_DITH_EN</u> is set to 1. No dither is applied when <u>SPK_DITH_EN</u> is set to 0. The <u>SPK_DITH_EN</u> bit also controls the dither applied to the audio playback path.

Bypass Path DC Blocking Filter

A DC blocking filter can be enabled on the audio processing bypass path by setting the <u>SPK_DCBLK_EN</u> bit to 1. The <u>SPK_DCBLK_EN</u> also controls the DC blocking filter in the audio playback path.

Speaker Maximum Peak Output Voltage Scaling

The device operates over a large PVDD supply voltage range, and as a result the full-scale speaker amplifier output amplitude level is configurable to allow it to be scaled. As a baseline, the full-scale output of the speaker path DAC is 3.68dBV (typ). The speaker path no-load maximum peak output voltage level (V_{MPO}) is then programmable relative to this baseline level. The peak output scaling range is from +4dB to +21dB, and is set with the <u>SPK_GAIN_MAX</u> bit field.

The speaker output signal level (in dBV) for a given digital input signal level (in dBFS) is calculated as follows:

The peak output voltage scaling is applied to the signal path using a combination of digital gain and analog gain adjustments.

Dynamic-Headroom Tracking (DHT)

The device features dynamic-headroom tracking that can preserve consistent signal distortion and listening levels in the presence of a varying supply level. The DHT block provides both a dynamic range compressor (DRC) and limiter. The limiter can operate either as a signal distortion limiter (SDL) or a standard signal level limiter (SLL). Each of these three functions can be used independently (modes 1 through 3), and the SLL and DRC can be used simultaneously (mode 4). The DHT block is enabled with the <u>DHT_EN</u> bit. Prior to enabling the DHT, the measurement ADC, PVDD, and VBAT channels should be configured and enabled as required based on the amplifier mode of operation. The DHT block uses the measured supply levels and the current signal level to calculate the attenuation (if any) that is applied to the signal path. Also, the DHT block should not be disabled by setting <u>DHT_EN</u> bit to 0 when the DHT is active (i.e., attenuation is being applied).



Figure 11. Simplified Dynamic-Headroom Tracking System Block Diagram

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DHT Supply Tracking and Headroom

The DHT block uses three parameters to track the target peak output level (V_{TPO}) relative to the maximum peak output voltage (V_{MPO}) as the active speaker amplifier supply level varies.

The first is the speaker amplifier full-scale gain setting (<u>SPK_GAIN_MAX</u> bit field). This control selects the maximum (noload) peak output voltage level (V_{MPO}) that is output by the Class-DG amplifier with a full-scale input signal (0dBFS). Most DHT thresholds and parameters are calculated relative to the full-scale V_{MPO}.

The second parameter is the measured speaker amplifier supply voltage level (V_{SUP}). The measurement ADC provides the DHT block with the current supply voltage levels (V_{PVDD} and V_{VBAT}). The DHT block decides which supply voltage to use for calculations based on the currently active speaker amplifier supply.

The third parameter is the speaker amplifier supply headroom (SUP_{HR}). The supply headroom is a positive or negative percentage offset relative to the measured V_{SUP} conversion result. It is configured using the <u>DHT_HR</u> bit field, and can be set from +20% to -20% of V_{SUP} in 2.5% step sizes.

The DHT target peak output voltage level (V_{TPO}) is equal to the measured supply voltage (V_{SUP}) scaled to include the selected supply headroom percentage and is actively calculated with the following equation:

 $V_{TPO} = V_{SUP} x (100\% - SUP_{HR})$ The target peak output attenuation (or ratio) from V_{TPO} to V_{MPO} is calculated as follows:

 $A_{TPO} = 20 \times \log (V_{TPO}/V_{MPO})$

If A_{TPO} exceeds 0dB (V_{SUP} with headroom > V_{MPO}), then the DHT block assumes that there is sufficient supply voltage to reproduce the audio signals as configured without attenuation. In this case, A_{TPO} = 0dB is used for all further calculations. This is important as the DHT functions only ever apply attenuation and do not apply positive gain. Once the calculated V_{TPO} drops below V_{MPO} , the calculated target peak output attenuation (A_{TPO}) is less than 0dB, and the DHT functions are applied appropriately as the input signal level changes.

For example, if V_{MPO} = 13.63V, V_{SUP} = 8.04V, and SUP_{HR} = -20%, then solving for V_{TPO} yields a target peak output level of approximately 9.65V. Next, solving for the target peak output attenuation (A_{TPO}) yields approximately -3dB.

<u>Figure 12</u> shows the default transfer function (with no DHT attenuation applied), where the current target peak output level (V_{TPO}) is based on the current V_{SUP} and the supply headroom settings. The tracked V_{TPO} and the resulting peak output attenuation (A_{TPO}) are then used in the attenuation calculations for the DHT functions. Note that this and all subsequent figures are not drawn to precise scale, and that the x-axis is input signal level (dBFS) on a linear scale, while the y-axis is peak output voltage level on a log scale.

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Figure 12. VTPO and ATPO Calculation Example

DHT Mode 1 – Signal Distortion Limiter

The DHT signal distortion limiter (SDL) maintains a consistent level of signal distortion at the amplifier output as the supply voltage (V_{SUP}) changes. To use DHT mode 1 (just the signal distortion limiter active), set the <u>DHT_LIM_MODE</u> bit low (default) to place the limiter function in supply tracking mode (SDL), and set the dynamic range compressor rotation point (<u>DHT_VROT_PNT</u>) to 0dBFS (effectively disabling the DRC). The signal distortion limiter function is a compressor with a ratio of infinity to one that actively sets its threshold (V_{SDL} in voltage) equal to the calculated target peak output voltage level (V_{TPO}). The output referred SDL threshold (SDL_{THR}) and the input referred SDL knee or rotation point (SDL_{RP}) are equal in mode 1, and can be calculated relative to full-scale (in dBFS) as a ratio of V_{TPO} to V_{MPO} :

 $SDL_{RP} = SDL_{THR} = 20 \times log(A_{TPO}) = 20 \times log(V_{TPO} / V_{MPO})$

The transfer function for input signal levels below the SDL rotation point (SDL_{RP}) is unchanged. When the input signal level exceeds SDL_{RP} , the signal distortion limiter function is applied to the signal path. As the input signal level increases, the distortion limiter attenuation continues to increase as well and can be calculated for a given input signal level (A_{INPUT} in dBFS) as follows:

SDL ATTENUATION = SDL_{RP} – A_{INPUT}

By actively recalculating SDL_{RP} (or SDL_{THR}) as the target peak output level (V_{TPO}) changes, the DHT SDL maintains a consistent limit and level of amplifier output distortion relative to available supply voltage (V_{SUP}).

When the target peak output voltage (V_{TPO}) exceeds the amplifier maximum peak output voltage (V_{MPO}) there is sufficient headroom and no SDL attenuation is applied. However, as soon as V_{TPO} falls below V_{MPO}, it is possible for the input signal amplitude to exceed the calculated SDL_{RP}. The following examples show the transfer function when V_{SUP} \geq V_{MPO} with the minimum (-20%), without (0%), and maximum (+20%) supply headroom (SUP_{HR}) settings. Note that in the case with positive headroom (+20%), the SDL_{RP} falls below the input signal full-scale level even though V_{SUP} = V_{MPO}.

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Figure 13. Signal Distortion Limiter with $V_{MPO} \le V_{SUP}$ and +20% Headroom (SUP_{HR})



Figure 14. Signal Distortion Limiter with $V_{MPO} \le V_{SUP}$ and 0% Headroom (SUP_{HR})

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Figure 15. Signal Distortion Limiter with V_{MPO} ≤ V_{SUP} and -20% Headroom (SUP_{HR})

As the supply voltage (V_{SUP}) drops further below the maximum peak output voltage (V_{MPO}), the DHT target peak out voltage (V_{TPO}) proportionally scales down. In cases with zero or positive amplifier supply headroom settings (+20% \geq SUP_{HR} \geq 0%), the input signal level can exceed the SDL rotation point (SDL_{RP}) before the peak output exceeds V_{SUP}. In this case, amplifier output clipping can be prevented.

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Figure 16. Signal Distortion Limiter with $V_{MPO} > V_{SUP}$ and +20% Headroom (SUP_{HR})



Figure 17. Signal Distortion Limiter with V_{MPO} > V_{SUP} and 0% Headroom (SUP_{HR})

In cases with a negative supply headroom setting (0% > SUP_{HR} \ge -20%), the input signal does not exceed the SDL_{RP} until after the peak output reaches V_{SUP}. As a result, clipping occurs at the amplifier output. However, once the input signal level exceeds the SDL_{RP}, the audio signal level is digitally limited by the SDL preventing the amplifier output clipping from worsening further.

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Figure 18. Signal Distortion Limiter with V_{MPO} > V_{SUP} and -20% Headroom (SUPHR)

DHT Mode 2 – Signal Level Limiter

In DHT mode 2, the limiter is configured as a fixed threshold signal level limiter (SLL). Set the <u>DHT_LIM_MODE</u> bit high to place the limiter function in SLL mode, and set the dynamic range compressor rotation point to 0dBFS (effectively disabling the DRC).

Like the signal distortion limiter, the signal level limiter function is a compressor with a ratio of infinity to 1. However, unlike the SDL, the SLL output referred threshold (SLL_{THR}) is configured to a set level. The SLL_{THR} is selected with the <u>DHT_LIM_THRESH</u> bit field from a range of 0dBFS to -15dBFS. The SLL threshold can also expressed as an input referred knee or rotation point (SLL_{RP}) which is equal to SLL_{THR} in mode 2. The SLL amplifier peak output voltage limit (V_{SLL}) is calculated from the selected SLL threshold (SLL_{THR}) and maximum peak output voltage (V_{MPO}) with the following equation:

SLL PEAK OUTPUT VOLTAGE LIMIT = V_{SLL} = V_{MPO} x 10^{(SLL}THR / 20)</sup>

The transfer function for signal levels below the SLL threshold (SLL_{THR}) is unchanged. When the signal level exceeds the SLL_{THR}, the signal level limiter function is applied to the signal path. As the input signal level increases, the limiter attenuation continues to increase as well and can be calculated for a given input signal level (A_{INPUT} in dBFS) relative to SLL_{RP} (= SLL_{THR}) as follows:

SLL ATTENUATION = SLL_{RP} – AINPUT

When V_{TPO} is greater than V_{SLL} , the amplifier peak output level is limited to V_{SLL} whenever the signal amplitude exceeds the SLL threshold (SLL_{THR}). As a result of the fixed SLL threshold and rotation point, the transfer function is identical for any V_{SUP} level and corresponding V_{TPO} that is greater than V_{SLL} .

This is illustrated in <u>Figure 19</u> for decreasing V_{SUP} and V_{TPO} levels. As V_{SUP} decreases, V_{TPO} is recalculated and decreases as well. Three different progressively lower V_{TPO} levels are shown (V_{TPO1}, V_{TPO2}, and V_{TPO3}). Due to the fixed SLL threshold, V_{SLL} is the same in all three cases. Since all three V_{TPO} values are greater than V_{SLL}, the transfer function for each case is identical and is limited at V_{SLL}.

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Figure 19. Signal Level Limiter with V_{TPO} > V_{SLL} as V_{SUP} Decreases

When V_{TPO} is less than V_{SLL} , the amplifier output can clip before the input signal amplitude exceeds the SLL rotation point (SLL_{RP} = SLL_{THR}). As the input signal level continues to increase and exceed SLL_{RP}, the signal level is digitally limited which prevents the amplifier output clipping from worsening further. Because both the SLL threshold and rotation point are fixed relative to full-scale, the clipping at the amplifier output grows progressively worse prior to the input signal exceeding SLL_{RP} (= SLL_{THR}) as V_{SUP} continues to decrease.

The following [[Signal Level Limiter with V_{TPO}< V_{SLL} Showing Amplifier Output Clipping]] has the same SLL settings as <u>Figure 19</u> (same SLL_{THR}). For simplicity, V_{TPO} = V_{SUP} (SUP_{HR} = 0%), and V_{TPO} has decreased further and is now less than V_{SLL}. As a result, the amplifier output clips before the SLL digitally limits the signal level.

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Figure 20. Signal Level Limiter with V_{TPO} < V_{SLL} Showing Amplifier Output Clipping

DHT Mode 3: Dynamic Range Compressor

The DHT dynamic range compressor (DRC) is configured by setting the input referred rotation point (DRC_{RP} in dBFS). The DRC_{RP} can be selected from a range from 0dBFS to -15dBFS with the <u>DHT_VROT_PNT</u> bit field. To calculate the DRC output referred voltage threshold (V_{DRC}), use the following equation:

$$V_{DRC} = V_{MPO} \times 10^{(DRC_{RP}/20)}$$

For mode 3 operation, set the DRC rotation point (DRC_{RP}) to any level lower than 0dBFS. Next, to disable limiter functions, place DHT into signal level limiter mode ($\underline{DHT_LIM_MODE}$ = 1) and set the fixed SLL threshold (SLL_{THR}) to 0dBFS (using the $\underline{DHT_LIM_THRESH}$ bit field).

Once configured, the dynamic range compressor rotation point (DRC_{RP}) is fixed at the selected level (or ratio) relative to the input full-scale. As V_{SUP} and V_{TPO} change, the DRC compression ratio for input signals that exceed DRC_{RP} changes as well. However, the transfer function remains unchanged for input signals below DRC_{RP}. If the amplifier is operating in class-G mode, it is recommended that the DRC rotation point (DRC_{RP}) be set such that V_{DRC} exceeds the maximum possible VBAT voltage level. This ensures that DRC compression is only applied when PVDD is the active amplifier supply, and that the DHT cannot rapidly switch between two different ratios if the active amplifier supply toggles quickly.

The DHT tracks the target peak output voltage (V_{TPO}) and attenuation (A_{TPO}). As they change, the adaptive DRC compression ratio smoothly scales the listening level of the amplifier for any input signals that exceed DRC_{RP}. The DRC compression ratio is actively calculated with the following formula:

DRC COMPRESSION RATIO = $DRC_{RP}/(A_{TPO} - DRC_{RP})$

The DRC attenuation for a given input signal level (AINPUT in dBFS) is calculated as follows:

DRC ATTENUATION = ATPO – AINPUT x (ATPO / DRCRP)

The following example shows the DRC transfer function with SUP_{HR} $\ge 0\%$ as V_{SUP} (and thus V_{TPO}) decreases. As the V_{TPO} level decreases (from V_{TPO1} to V_{TPO2} to V_{TPO3}), the DRC compression ratio increases.

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Figure 21. Dynamic Range Compression with Decreasing V_{SUP} and SUP_{HR} \ge 0%

<u>Figure 22</u> shows the DRC transfer function with SUP_{HR} < 0%. Due to the negative supply headroom, V_{TPO} is greater than V_{SUP} and the amplifier output clips before the input signal reaches full-scale.

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Figure 22. Dynamic Range Compressor with SUP_{HR} < 0% and Output Clipping

DHT Mode 4: Dynamic Range Compressor with Signal Level Limiter

In DHT mode 4, the dynamic range compressor (DRC) and signal level limiter (SLL) are both enabled. The DRC rotation point (DRC_{RP}) must be less than 0dBFS to enable mode 4. In addition, the DHT limiter function must be configured for SLL mode ($\underline{DHT_LIM_MODE}$ = 1) with an SLL threshold (SLL_{THR}) less than 0dBFS. Finally, to create a DHT response curve with both DRC and SLL inflection points, the SLL threshold (V_{SLL}) must be greater than the DRC voltage threshold (V_{DRC}). This insures that the resulting SLL_{RP} is always greater than the DRC_{RP}; otherwise, the SLL limits the signal level before the DRC rotation point is ever reached.

<u>Figure 23</u> shows three mode 4 transfer functions for three progressively lower V_{SUP} levels. The supply headroom is configured for SUP_{HR} > 0% (positive supply headroom), and the calculated V_{TPO} value is falling such that V_{TPO1} > V_{TPO2} > V_{TPO3} . The DRC rotation point and SLL threshold are constant in all three cases, and SLL_{THR} is selected such that as V_{TPO} falls the SLL knee (SLL_{RP}) is greater than the DRC_{RP}.

In the first two cases (for V_{TPO1} and V_{TPO2}), the calculated SLL output voltage limit (V_{SLL}) is less than V_{TPO}. As the signal level increases, it is first compressed by the DRC function then limited once the output level reaches V_{SLL}. In the third case, the SLL function is never applied since V_{SLL} is greater than V_{TPO3} and the signal level, while still compressed by the DRC, reaches full-scale before exceeding V_{SLL}.

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Figure 23. DHT DRC and SLL with Decreasing V_{SUP} (V_{TPO}), and SUP_{HR} \ge 0%

<u>Figure 24</u> shows a mode 4 transfer function where the supply headroom is negative (SUP_{HR} < 0%). As before, the SLL threshold (SLL_{THR}) is programmed so that the resulting SLL_{RP} is greater than the DRC_{RP}. This also insures that the resulting V_{SLL} is greater than V_{DRC} and less than V_{TPO}. As the audio signal level increases, it is first compressed by the DRC function, then limited once the digital output signal level reaches V_{SLL}. However, due to the negative headroom, the amplifier output clips before the SLL function digitally limits the signal level.

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Figure 24. DHT DRC and SLL with Decreasing V_{SUP} (V_{TPO}), and $SUP_{HR} < 0\%$

DHT Attenuation

An interrupt is generated (<u>DHT_ACTIVE_BGN_*</u>) when the DHT block first applies attenuation. When the DHT block fully releases all applied attenuation (i.e., DHT is inactive), an interrupt is generated (<u>DHT_ACTIVE_END_*</u>). Interrupts are not generated when DHT is actively adjusting the level of attenuation.

The maximum attenuation (A_{MAX}) applied to the audio signal by the DHT functions is selected with the <u>DHT_MAX_ATN</u> bit field. The maximum attenuation can be set from -1dB to -15dB with a 1dB step size. The configured DHT functions stop further attenuation of the audio signal once the calculated attenuation (relative to the un-attenuated input signal level) reaches the selected maximum attenuation (A_{MAX}). If the calculated attenuation (based on input signal level and measured V_{SUP}) exceeds the selected maximum attenuation (A_{MAX}), the applied attenuation is set equal to (limited at) A_{MAX} . This can occur anytime when the target peak output (V_{TPO}) to maximum peak output (V_{MPO}) ratio or peak output attenuation (denoted A_{TPO}) is less than (or has a larger absolute value than) A_{MAX} .

All previous examples show cases where the peak output attenuation (A_{TPO}) did not exceed the selected maximum attenuation (A_{MAX}). The following figures show signal distortion limiter use cases where V_{SUP} has decreased until A_{TPO} < A_{MAX} (the DHT DRC function DRC_{RP} is set to 0dbFS as in use case 1).

In Figure 25, the SUP_{HR} is set to -20%. Since $A_{TPO} < A_{MAX}$, the attenuation applied by the distortion limiter reaches the programmed maximum attenuation level before the input signal reaches full-scale. For input signals past the point where calculated attenuation is equal to A_{MAX} , the attenuation stops increasing and is now fixed at A_{MAX} . As a result, the audio signal (in the digital domain) begins to increase past this point. This results in the distortion increasing at the amplifier output (which was already clipping at the limited level of distortion).

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Figure 25. Distortion Limiter Case with -20% Headroom and A_{MAX} Exceeded

In <u>Figure 26</u>, the supply headroom is set to +20%. As before, the attenuation applied by the SDL reaches the selected maximum attenuation (A_{MAX}) before the input signal reaches full-scale. The audio signal (in the digital domain) begins increasing past this point, and the signal level (and any distortion) at the amplifier output increases as well. In this case, the amplifier output was not clipping until after A_{MAX} was exceeded.

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Figure 26. Distortion Limiter Case with +20% Headroom and AMAX Exceeded

DHT Attenuation Reporting

In TDM mode, the current level of DHT attenuation is reported on the PCM data output (DOUT) when the DHT attenuation transmit enable bit is set high (<u>PCM_DHT_ATN_EN</u> = 1). The DHT attenuation level output is transmitted as a 14-bit unsigned binary attenuation level:

DOUT CURRENT DHT ATTENUATION (dB) = 20 x log(14-bit DOUT Value/16383)

If enabled, the DHT attenuation target (in dB) is also shared between devices on the interchip communication (ICC) bus. In this case, the DHT attenuation level output requires two ICC output slots (8 bits each) and is transmitted as a 10-bit unsigned binary attenuation level (DHT_ATN) followed by 6 bits of zero padding.

The current DHT attenuation (in dB) is calculated from the 10-bit value (DHT_ATN) with the following equation:

The current DHT attenuation level cannot exceed the selected DHT maximum attenuation (A_{MAX}). Additionally, when the DHT is inactive, the reported attenuation is 0x0.

DHT Ballistics

When the signal level exceeds the rotation point or threshold for a configured DHT function (SDL, SLL, and/or DRC) or continues to increase beyond this point, the appropriate level of attenuation is applied to the signal level at the programmed attack rate. The DHT attack rate is selected with the <u>DHT_ATK_RATE</u> bit field.

The change in input signal level is detected by a peak detect circuit which has a fixed 3.5ms release time. When the signal level decreases or drops below the rotation point or threshold for a configured DHT function (SDL, SLL, and/or DRC), the appropriate level of applied attenuation is released. The DHT release rate is selected with the <u>DHT_RLS_RATE</u> bit field. However, due to the 3.5ms/dB peak detector, the 2ms/dB release rate is effectively 3.5ms/dB. All other release rates have a fixed delta of 3.5ms compared to the programmed release rate.

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The attack and release behavior is slightly different when triggered by a change in active amplifier supply level. When the supply level decreases and triggers a DHT function attack, the attenuation is applied quickly at the configured attack rate. Likewise, as the supply level increases, the attenuation is released at the configured release rate. However, if DHT supply hysteresis is enabled ($DHT_SUPPLY HYST_EN = 1$), then as the supply increases the applied DHT function does not release attenuation until the increase in the supply level exceeds the programmed DHT supply hysteresis level ($DHT_SUPPLY HYST_EN = 1$). Once the supply increase exceeds the hysteresis, the appropriate level of applied attenuation is released at the configured release rate.

Speaker Amplifier

The device features a Class-DG speaker amplifier output stage. The speaker amplifier playback path is enabled and disabled using the <u>SPK_EN</u> bit. The Class-DG multilevel amplifier generates a rail-to-rail output, pulse-width modulated (PWM) signal. By varying the PWM duty cycle, the amplifier modulates the output with the audio input signal. Because the switching frequency of the amplifier is 472kHz (typ) when the output signal is filtered by the speaker, only the audio component remains. Rail-to-rail operation ensures that power dissipation at the output is dominated by the on resistance (R_{ON}) of the power output MOSFETs brief saturation current draw as the output switches as well as the current draw necessary to charge the output stage gates.

Speaker Amplifier Operating Modes

The speaker amplifier can operate both in Class-DG and standard Class-D modes. In Class-DG mode, the amplifier output supply rail is switched between V_{PVDD} and V_{VBAT} based on the signal level. If Class-DG operation is disabled, the amplifier operates as a fixed supply Class-D amplifier and can be configured to use either V_{PVDD} or V_{VBAT} as the output supply rail. The speaker amplifier operating mode is selected with the <u>SPK MODE</u> bit field.

Class-DG Mode Enabled

Class-DG is the default speaker amplifier mode of operation (<u>SPK_MODE</u> = 0x0). In this mode, the amplifier switches the supply rail between PVDD and VBAT as needed to efficiently supply the required output power.

Additionally, if V_{VBAT} drops below the programmed threshold level <u>VBATLOW_OK_LVL</u> bit field, the amplifier operates from PVDD supply rail regardless of signal level.

The Class-DG signal level threshold (VDG_THR) at which the amplifier switches between the supply rails is programmable. The method used to program the signal level threshold is selected with the <u>SPK_DG_SEL</u> bit field. When <u>SPK_DG_SEL</u> is set to 0x0, the threshold (VDG_THR) is set to a fixed peak voltage level with the <u>SPK_DG_THRES</u> bit field. When <u>SPK_DG_SEL</u> is set to 0x1 (default), the threshold (VDG_THR) is variable relative to the current VBAT voltage (measurement ADC result). The peak voltage headroom relative to V_{VBAT} is configured with the <u>SPK_DG_THRES</u> or <u>SPK_DG_THRES</u> is set to 0x2, the threshold (VDG_THR) is set based on whichever setting (<u>SPK_DG_THRES</u> or <u>SPK_DG_HEADROOM</u>) results in the lowest threshold for the current V_{VBAT} voltage level. As a result, as V_{VBAT} decreases, VDG_THR might transition from a fixed threshold to a lower V_{VBAT} headroom based variable threshold.

The Class-DG mode hold time is configured with the <u>SPK_DG_HOLD_TIME</u> bit field. VBAT is selected as the active amplifier supply to save power when the signal level drops below the threshold for longer than hold time. The amplifier switches to the VBAT supply only at signal zero cross, so the measured hold time is the register configured hold time plus the time taken for a zero cross event to occur. When VBAT is the active amplifier output supply, the LV_EN output asserts high. When the signal level rises above the threshold, the amplifier supply quickly switches to PVDD to provide higher output voltage swing and to avoid clipping. When PVDD is the active amplifier output supply, the LV_EN output asserts low.

Delay for DG Mode

When the amplifier is operating in the automatic Class-DG mode, to avoid the potential for clipping the output signal as the PVDD supply rises, there is a programmable delay in the signal path controlled by <u>SPK_DG_DELAY</u>. This allows the PVDD supply time to increase the output voltage before it is required to output larger signals.

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Class-DG Mode Disabled

When Class-DG mode is disabled, the speaker amplifier operates in standard Class-D mode. In this case, the active amplifier output supply is configured to either PVDD (<u>SPK_MODE</u> = 0x1) or VBAT (<u>SPK_MODE</u> = 0x2).

If the active amplifier output supply is configured to VBAT (<u>SPK_MODE</u> = 0x2), the amplifier operates from VBAT regardless of signal level. In this mode, the LV_EN pin is asserted high.

When the active amplifier supply is set to PVDD, the amplifier always operates from PVDD regardless of the signal and supply levels. Furthermore, PVDD can be actively regulated between any levels within its standard operating range (3V to 20V) to save power. In this mode, LV_EN pin is always asserted low.

NOVBAT Mode

By default, the PVDD and VBAT pins must be supplied with external supplies for the amplifier to operate. In systems where the VBAT pin cannot be supplied by an external supply, the device can still operate from PVDD supply only by programming the <u>NOVBAT</u> bit field to 1. Additionally, the VBAT pin must be shorted to the VREFC pin on the PCB. When <u>NOVBAT</u> bit field is set to 1, the amplifier automatically operates in PVDD mode and the <u>SPK_MODE</u> bits have no effect.

IDLE Mode

In customer systems where an external LC filter is used for EMI reduction, the quiescent power consumption and power consumption in Class-DG mode for low signal levels can be reduced by setting the IDLE_MODE_EN bit field to 1. The idle mode setting is not intended for operation in PVDD mode (with VBAT pin supplied externally) or NOVBAT mode (when the VBAT pin is not supplied externally) and therefore should not be enabled.

When the idle mode is enabled, the idle mode activates whenever the amplitude of the input audio data to the speaker path (from the PCM interface) is below the configured mute threshold (<u>MUTE_THRESH</u>) for more than 1024 consecutive data samples. When the idle mode is active, the current and voltage sense ADC paths output zero code data. The idle mode deactivates immediately if the amplitude of a single sample from the input audio data exceeds the configured unmute threshold (<u>UNMUTE_THRESH</u>). When the idle mode deactivates, the current and voltage sense ADC paths resume operation and output data normally.

The idle mode mute and unmute threshold settings are selected in terms of the number of bits (starting from the LSB) that must be toggling (or active) in order for the input signal amplitude to exceed the thresholds. It is invalid to set the noise gate unmute threshold (<u>MUTE_THRESH</u>) such that it is less than the configured mute threshold (<u>MUTE_THRESH</u>). The location of the audio data LSB within the PCM input data channel is determined by the configured PCM data word size (<u>PCM_CHANSZ</u>). The supported combinations are shown in [[Noise Gate/Idle Mode Threshold LSB Location By Input Data Configuration]]. It is not valid to enable the idle mode and noise gate function simultaneously.

Speaker Amplifier Ultra-Low EMI Filterless Operation

Traditional Class-D amplifiers require the use of external LC filters or shielding to meet electromagnetic-interference (EMI) regulation standards. However, the device features emissions limiting circuitry that limits the output switching harmonics that can directly contribute to EMI and radiated emissions.

The programmable speaker amplifier edge rate control bits are used to adjust the switching edge rate to help tune EMI performance. As the edge rate increases, the efficiency improves slightly, while as the edge rate is decreased, the efficiency drops slightly. The speaker amplifier edge rate is configured with the <u>SPK_SL_RATE_GMODE</u>, <u>SPK_SL_RATE_LS</u>, and <u>SPK_SL_RATE_HS</u> bit fields.

The speaker amplifier output also supports spread-spectrum modulation (SSM). SSM is enabled by default to optimize the suppression and control of the output switching harmonics that can contribute to EMI and radiated emissions. The modulation index in spread-spectrum mode is controlled by the <u>SPK_SSM_MOD_INDEX</u> bit field, and the maximum modulation index (MMI) varies accordingly. Higher percentage settings of the modulation index result in the switching frequency of the amplifier being modulated by a wider range, spreading out-of-band energy across a wider bandwidth. Above 10MHz, the wideband spectrum looks like noise for EMI purposes.

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Speaker Amplifier Overcurrent Protection

The device features amplifier current limit protection that protects the amplifier output from both high current and short circuit events. If the <u>OVC_AUTORESTART_EN</u> bit is set to 1 and the speaker amplifier output current exceeds the current limit threshold (6.2A min), the device generates an interrupt and disables the amplifier output. After approximately 20ms, the amplifier output is re-enabled. If the overcurrent condition still exists, the device continues to disable and re-enable the amplifier output automatically until the fault condition is removed.

If the <u>OVC_AUTORESTART_EN</u> bit is set to 0, the device still generates an interrupt and disables the amplifier output when a speaker amplifier overcurrent event occurs. However, in this case the device is placed into software shutdown and the software enable (<u>EN</u>) bit is set to 0. As a result, the host must manually re-enable the device after an overcurrent event.

Speaker Current and Voltage Sense ADC Path

The device provides two separate 16-bit ADCs to monitor the speaker amplifier output current and voltage (the I/V sense ADC path). The current and voltage ADC paths are independently enabled with the <u>IVADC I_EN</u> and <u>IVADC_V_EN</u> bits, respectively.

The voltage and current digital data output are routed to the host through the PCM interface data output (DOUT), which is enabled by the PCM_TX_EN bit field. Both I and V data can be formatted in 16-/24-/32-bit 2's complement format and has a voltage sense range of $\pm 22V$, and a current sense range of $\pm 6.5A$.

When configured in 16-bit mode for Vsense, if MSB is 0 then the voltage would be 11/(2^15) x DIG CODE.

For example, a Vsense reading of 0111 1111 1111 1111 translates to a voltage of +22V and a reading of 1000 0000 0000 would be -22V.

For 16-bit Isense, if MSB is 0, then the current would be 3/(2^15) x DIG CODE.

For example, an Isense reading of 0111 1111 1111 1111 translates to a voltage of +6.5A and a reading of 1000 0000 0000 would be -6.5A.

See the <u>PCM Interface</u> section for details on configuring I/V sense-data output on DOUT. Both the current and voltage sense ADC output data can optionally have dither applied (±1 LSB peak-to-peak) by setting the <u>IVADC_DITH_EN</u> bit field to 1. No dither is applied when <u>IVADC_DITH_EN</u> is set to 0.

The I/V sense ADC path provides separate optional DC blocking filters (first-order highpass) in the current and voltage sense paths. The current and voltage path filters are enabled by setting the <u>IVADC I DCBLK_EN</u> and <u>IVADC_V DCBLK_EN</u> bit fields to 1, respectively.

To ensure phase alignment, the current and voltage sense ADCs should be enabled either with a single write to the <u>IVADC_I_EN</u> and <u>IVADC_V_EN</u> bits (<u>EN</u> = 1) or by setting both bits high before exiting software shutdown. Additionally, all feedback channels (VMON, IMON, and <u>DSP feedback data</u>) are nominally in phase except for LRCLK sample rates of 88.2kHz/176.4kHz. For 88.2kHz/176.4kHz sample rates, VMON/IMON data is 180 degrees out of phase with the <u>DSP feedback data</u>.

When laying out the PCB, the OUTPSNS and OUTNSNS pins should be Kelvin connected as close as possible to the load connected between OUTP and OUTN for accurate voltage measurements. If a filter comprised of a ferrite bead and capacitor is installed between the speaker amplifier output pins and the load, then the sense lines should be connected between the filter and the load and as close to the load as possible. If an LC filter is installed between the amplifier output pins and the load, the OUTPSNS and OUTNSNS lines should be connected to the OUTP and OUTN lines before the filter. The OUTPSNS and OUTNSNS pins are not intended to be driven by an external source. The speaker amplifier current is measured internally and requires no external connections.

Brownout-Prevention Engine

The brownout-prevention engine (BPE) allows the device to reduce its contribution to the overall system power consumption by attenuating the amplifier output when the supply drops below a set of programmable thresholds. The BPE is enabled and disabled using the <u>BPE_EN</u> bit. The BPE can be enabled at any time by setting the <u>BPE_EN</u> bit

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high. However, the BPE must not be disabled when it is active (in critical supply levels 0 through 3). The BPE can be disabled safely at any time that it is inactive. The input to the BPE controller is selected using the <u>BPE_SRC_SEL</u> bit. By default, the input to the BPE controller is the measurement ADC PVDD channel. If the selected measurement ADC channel is not already active, enabling the BPE will automatically enables it. The sample rate and filter settings for the measurement ADC determine the speed at which the BPE updates.



Figure 27. BPE Block Diagram

BPE State Controller and Level Thresholds

There are a total of four BPE critical supply levels, each with individually programmable thresholds. The thresholds for each level are configured with the <u>BPE_L0_VTHRESH</u> to <u>BPE_L3_VTHRESH</u> bit fields respectively. The BPE state controller monitors the measurement ADC channel results and automatically makes state changes.

Table 9. Brownout-Prevention Engine Levels

THRESHOLD NAME	CONDITION
BPE Inactive	VSUPPLY > Critical Supply Level 3
Critical Supply Level 3	Critical Supply 3 ≥ VSUPPLY > Critical Supply Level 2 + Hysteresis
Critical Supply Level 2	Critical Supply Level 2 ≥ VSUPPLY > Critical Supply Level 1 + Hysteresis
Critical Supply Level 1	Critical Supply Level 1 ≥ VSUPPLY > Critical Supply Level 0 + Hysteresis
Critical Supply Level 0	VSUPPLY ≤ Critical Supply Level 0

The brownout engine supports hysteresis on the levels. This behaves as follows:

- When in level N, transition to level N + 1 when V_{SUPPLY} stays above (level N threshold) + (hysteresis)
- When in level N, transition to level N 1 when V_{SUPPLY} falls below level N threshold

The amount of hysteresis is defined by the <u>BPE_VTHRESH_HYST</u> register. The hysteresis is only applied to the thresholds when supply voltage is increasing. The amount of hysteresis can be defined as larger than the distance between two levels.

Thresholds must be configured so that the level N threshold is greater than the sum of the level N - 1 threshold and the hysteresis. For example, if the level 2 threshold is set to 3.15V and hysteresis is set to 25mV, then the level 3 threshold must be set to 3.1875V or higher.

The current level that the BPE is in can be read-back using the <u>BPE_STATE</u> register. The <u>BPE_LOWEST</u> register contains the lowest BPE level that the controller has visited since the last time the <u>BPE_LOWEST</u> register was read.
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BPE Level Configuration Options

For a given BPE level, the following options are configurable to reduce the overall device current draw:

Gain Attenuation Function

Limiter Function

Each of these configuration options are individually configurable for each BPE level.

BPE Gain Attenuation Function

The speaker gain attenuation block reduces the overall current draw by the device at low supply voltages by applying smooth digital gain changes to the signal path. The maximum attenuation that can be applied can be independently configured for each BPE level. The maximum attenuation that can be applied for each level is programmable from 0 to -31dB in 1dB steps and is configured using the <u>BPE Lx MAXATTN</u> bits.

When the V_{SUPPLY} voltage level falls below the programmed level, the brownout controller waits for a time equal to the programmed dwell time for the level before applying attenuation at the programmed attack rate. The brownout controller then enters the hold time phase when the V_{SUPPLY} voltage increases and causes the brownout controller to enter the next level. After the programmed hold time for a BPE level expires, the controller enters the release phase where the controller releases the attenuation at the programmed release rate. Additionally, each BPE level has independent programmable settings for dwell time (*BPE_Lx_DWELL*), hold time (*BPE_Lx_HOLD*), attack and release step size (*BPE_Lx_STEP*), attack rate (*BPE_Lx_GAIN_ATK*), and release rate (*BPE_Lx_GAIN_RLS*). While the attack and release rates are independently configurable for the gain attenuation and limiter block, the attack and release step size settings are common.

The <u>BPE_LOWEST_GAIN</u> register contains the lowest gain (highest attenuation) applied the brownout controller. The register is updated upon reading to show the current attenuation applied by the BPE.

BPE Limiter Function

The BPE limiter function allows the device to reduce the overall current draw at low supply levels by quickly attenuating (15 μ s) input signals that exceed a programmed threshold. When the BPE limiter is enabled (<u>BPE_LIM_EN</u> = 1), the device ignores the Signal Distortion Limiter and Signal Level Limiter settings in the DHT. In this state, the limiter knee threshold is determined solely by the BPE limiter setting of the current BPE level. Each BPE level has an individually configured limiter threshold (set by <u>BPE_Ln_LIM</u>) that is programmable from 0dBFS and -15dBFS in 1dB steps.

Input signals that exceed the limiter knee threshold are attenuated, while input signals below the threshold are not. Each BPE level has an individually configured attack and release step size (<u>BPE_Lx_STEP</u>), attack rates (<u>BPE_Lx_LIM_ATK</u>), and release rates (<u>BPE_Lx_LIM_RLS</u>). While the attack and release rates are independently configurable for the gain attenuation and limiter block, the attack and release step size settings are common.

The <u>BPE_LOWEST_LIMIT</u> register contains the lowest limiter setting applied the brownout controller. The register is updated upon reading to show the current limiter setting applied by the BPE.

Brownout Interrupts

The BPE can generate interrupts triggered by the following conditions:

- BPE controller enters level 0 (<u>BPE L0 *</u>)
- BPE controller changes from one level to another (<u>BPE_LEVEL_*</u>)
- BPE controller is active (<u>BPE_ACTIVE_BGN_*</u>)
- BPE controller is no longer active (<u>BPE_ACTIVE_END_*</u>)

See the *Interrupts* section for more information.

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Measurement ADC

The device features a configurable 9-bit measurement ADC. The measurement ADC has three channels, one for die temperature measurement (measurement ADC thermal channel), one for PVDD supply voltage measurement (measurement ADC PVDD channel), and one for VBAT supply voltage measurement (measurement ADC VBAT channel). Enabled channels are measured sequentially and continuously. The programmable measurement ADC sample rate can be set independently for each channels. Each channel separately provides an optional programmable lowpass IIR filter.

Measurement ADC Thermal Channel

When the device is clocked in the active state (EN = 1), the measurement ADC thermal channel automatically activates. When active, it continuously measures and reports the device die temperature over the range from -29° C to $+150^{\circ}$ C.

The output of the thermal ADC channel can be readback through the <u>MEAS_ADC_THERM_DATA</u> bit field and is the input to both the thermal protection and thermal foldback blocks. By default (<u>MEAS_ADC_THERM_RD_MODE</u> = 0), the thermal readback value is automatically updated after each conversion is completed. Setting <u>MEAS_ADC_THERM_RD_MODE</u> to 1 places thermal readback into manual mode. In manual mode, the thermal readback result is updated manually when 1 is written to the <u>MEAS_ADC_THERM_UPD</u> bit field. The ADC thermal channel data readback in manual mode and the data streamed through the PCM interface are 9 bits. In automatic mode, since the 9-bit data readback is from two registers, the LSB register is not guaranteed to be synchronous with the MSB register and can result in higher noise.

The thermal ADC channel also provides an optional lowpass IIR filter with a programmable bandwidth that scales relative to the measurement ADC sample rate. The filter is enabled with the <u>MEAS_ADC_TEMP_FILT_EN</u> bit field, and the bandwidth is set with the <u>MEAS_ADC_TEMP_FILT_COEFF</u> bit field.

Measurement ADC PVDD Channel

When the device is clocked and in the active state (EN = 1), the measurement ADC PVDD channel can be enabled. The PVDD channel is manually enabled by setting the MEAS_ADC_PVDD_EN bit to 1 and must be manually enabled for the DHT to operate. When the channel is enabled, it continuously measures and reports the PVDD supply voltage level over the range of 2.5V to 20V.

The output of the measurement ADC PVDD channel can be read back through the <u>MEAS_ADC_PVDD_DATA</u> bit field and is routed to the DHT. By default (<u>MEAS_ADC_PVDD_RD_MODE</u> = 0), the PVDD readback value is automatically updated after each conversion is completed. Setting <u>MEAS_ADC_PVDD_RD_MODE</u> to 1 places PVDD readback into manual mode. In manual mode, the readback result is updated when 1 is written to the <u>MEAS_ADC_PVDD_RD_UPD</u> bit field. The ADC PVDD channel data readback in manual mode and the data streamed through the PCM interface are 9 bits. In automatic mode, since the 9-bit data readback is from two registers, the LSB register is not guaranteed to be synchronous with the MSB register and can result in higher noise.

The lowest PVDD measurement is readback through the <u>LOWEST_PVDD_DATA_MSB</u> and <u>LOWEST_PVDD_DATA_LSB</u> bit fields. These bit fields both automatically clear and are reset to the value of the current measurement result immediately after LSB readback is completed.

The PVDD channel also provides an optional lowpass IIR filter with a programmable bandwidth that scales relative to the measurement ADC sample rate. The filter is enabled with the <u>MEAS_ADC_PVDD_FILT_EN</u> bit and the bandwidth is set with the <u>MEAS_ADC_PVDD_FILT_COEFF</u> bit field.

Measurement ADC VBAT Channel

When the device is clocked in the active state (EN = 1), the measurement ADC VBAT channel can be enabled. The VBAT channel is manually enabled by setting the <u>MEAS_ADC_VBAT_EN</u> bit to 1 and must be manually enabled for the DHT to operate. When the channel is enabled, it continuously measures and reports the VBAT supply voltage level over the range of 2.5V to 5.5V.

The output of the measurement ADC VBAT channel can be read back through the <u>MEAS_ADC_VBAT_DATA</u> bit field. By default (<u>MEAS_ADC_VBAT_RD_MODE</u> = 0), the VBAT readback value is automatically updated after each conversion

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is completed. Setting <u>MEAS_ADC_VBAT_RD_MODE</u> to 1 places VBAT readback into manual mode. In manual mode, the readback result is updated when 1 is written to the <u>MEAS_ADC_VBAT_RD_UPD</u> bit field. The ADC VBAT channel data readback in manual mode and the data streamed through the PCM interface are 9 bits. In automatic mode, since the 9-bit data readback is from two registers, the LSB register is not guaranteed to be synchronous with the MSB register and can result in higher noise.

The lowest measured VBAT measurement result is readback through the <u>LOWEST_VBAT_DATA_MSB</u> and <u>LOWEST_VBAT_DATA_LSB</u> bit fields. These bit fields both automatically clear and are reset to the value of the current measurement result immediately after LSB readback is completed.

The VBAT channel also provides an optional lowpass IIR filter with a programmable bandwidth that scales relative to the measurement ADC sample rate. The filter is enabled with the <u>MEAS_ADC_VBAT_FILT_EN</u> bit and the bandwidth is set with the <u>MEAS_ADC_VBAT_FILT_COEFF</u> bit field.

Clock and Data Monitors

The device has input data and external clock monitors that detect host and system level faults. The data monitor detects persistent stuck and high amplitude input signals while the clock monitor detects external clock failures and invalid clock configurations. Upon fault detection, these monitors automatically place the device into software shutdown to stop glitches and unwanted signals at the amplifier output and speaker load.

Input Data Monitor

The device has an optional input data monitor that is enabled by setting <u>DMON_MAG_EN</u> to 1 for the data magnitude monitor or <u>DMON_STUCK_EN</u> to 1 (for the data stuck monitor). Once the data monitor is enabled, it actively monitors the selected input data (from DIN) to the speaker amplifier path anytime the device exits software shutdown (<u>EN</u> = 1) and the amplifier is enabled (<u>SPK_EN</u> = 1). When the tone generator is enabled, the data monitor is automatically disabled.

When active, the block monitors the selected input data for the enabled data error types (data magnitude, data stuck, or both). The <u>DMON_DURATION</u> bit field selects the duration that a data stuck or magnitude error must persist before a data error is detected. Once a data error is detected, the data monitor automatically places the device into software shutdown (sets EN to 0) and generates a data monitor error interrupt (<u>DMON_ERR_*</u>).

A data stuck error is detected if the input signal repeats a fixed value with a magnitude (positive or negative) that is beyond the data stuck threshold (<u>DMON_STUCK_THRES</u>) for longer than the data error duration (set by <u>DMON_DURATION</u>). If the input signal repeats a fixed value for any duration with a magnitude that is within the data stuck threshold limits (such as a zero or near zero code), no data stuck error is detected.



Figure 28. Data Monitor Error Generation due to Input Data Stuck Error Detection

A data magnitude error is detected if the input signal magnitude (positive or negative) is beyond the data magnitude threshold (set by <u>DMON MAG THRES</u>) for longer than the data error duration (set by <u>DMON DURATION</u>).

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Figure 29. Monitor Error Generation due to Input Data Magnitude Error Detection

Clock Monitor

The device provides an optional clock monitor that is enabled by setting <u>CMON_EN</u> to 1. Once enabled, it actively monitors the input BCLK and LRCLK anytime the device exits software shutdown (<u>EN</u> = 1). When the tone generator is enabled, the clock monitor is automatically disabled. When active, the clock monitor detects clock activity, clock frequency, and frame timing (clock ratio). If faults are detected, the clock monitor automatically places the device into software shutdown and generates a clock error interrupt (<u>CLK_ERR_*</u>).

The clock monitor operates in automatic mode when <u>CMON_AUTORESTART_EN</u> = 1 and manual mode when <u>CMON_AUTORESTART_EN</u> = 0. In automatic mode, when a clock error places the device into software shutdown, the global enable bit (EN) is not changed (remains 1) and the device automatically recovers from all clock errors. In automatic mode, both clock error (<u>CLK_ERR_*</u>) and clock recovery (<u>CLK_RECOVER_*</u>) interrupts are generated in pairs (a clock recovery interrupt is not possible until after a clock error has occurred).

In manual mode, when a clock error places the device into software shutdown, the global enable bit (*EN*) is set to 0. Clock recovery (*CLK_RECOVER_**) interrupts are never generated in manual mode, and the device remains in software shutdown until the host sets *EN* back to 1. Once the device is re-enabled (*EN* set to 1), the clock monitor is active and detects any new (or persisting) clock errors. If a clock error is detected, the device returns to software shutdown (*EN* = 0), and a new clock error interrupt (*CLK_ERR_**) is generated.

Clock errors are fault conditions, and audible glitches may occur on clock monitor based transitions into and out of software shutdown. When the clock monitor is enabled, no false clock error or clock recovery interrupts are generated when the host software transitions the device normally into and out of software shutdown.

Clock Activity and Frequency Detection

When the clock monitor is enabled, the bit clock (BCLK) and frame clock (LRCLK) frequencies are monitored. The expected LRCLK frequency is equal to the PCM sample rate (<u>PCM_SR</u>). The expected BCLK frequency is based on the BCLK to LRCLK ratio (<u>PCM_BSEL</u>) relative to the PCM sample rate (<u>PCM_SR</u>).

The current frequency of each clock is measured relative to (and once per interval of) the programmed frame period (as set by <u>PCM_SR</u>). A clock frequency error is detected when the measured clock frequencies differ from programmed clock frequencies (faster or slower) by more than the frequency error threshold (45% typ). If either clock stops high or low, the frequency measurement result allows detection of the clock stop event.

The <u>CMON_ERRTOL</u> bit field sets the clock frequency error tolerance. The tolerance is the required number of consecutive frame clock periods (<u>PCM_SR</u>) with an incorrect clock frequency before a clock error is generated. If the error persists for the selected number of frame periods, a clock error interrupt (<u>CLK_ERR_*</u>) is generated and the device is placed into software shutdown.

In automatic mode, the <u>CMON_ERRTOL</u> bit field also sets the number of consecutive frame clock periods without clock frequency errors (LRCLK or BCLK) that are required for automatic restart to occur. Once the selected number of

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consecutive error-free frames are detected, a clock recovery interrupt (<u>CLK_RECOVER_*</u>) is generated and the device automatically exits software shutdown.

In manual mode, no clock recovery interrupts are generated. The clock monitor remains disabled and the device remains in software shutdown until the host software sets <u>EN</u> back to 1.



Figure 30. Clock Monitor LRCLK Rate Error Example With CMON_ERRTOL = 0x1

Clock Frame Error Detection

When the clock monitor is enabled, the bit clock (BCLK) to frame clock (LRCLK) ratio is monitored. The clock monitor counts the number of BCLK periods per frame (LRCLK period) and then compares the count to the configured clock ratio (*PCM_BSEL*). In addition, in I²S and left-justified modes the clock monitor verifies the LRCLK duty cycle by checking that the number of BCLK periods per channel is equal. In TDM mode, data transport is synchronized to the active frame clock (LRCLK) edge, so no duty cycle restrictions are enforced.

A frame error is detected in each frame where the monitored clock ratio (and duty cycle in I²S and left-justified modes) differs from the configured settings. The <u>CMON_BSELTOL</u> bit field sets the number of consecutive frames with frame errors that are required before a clock error interrupt is generated (<u>CLK_ERR_*</u>) and the device is placed into software shutdown.

In automatic mode, the <u>CMON_BSELTOL</u> bit field also sets the number of consecutive frames without frame errors that are required for automatic restart to occur. Once the selected number of consecutive error-free frames are detected, a clock recover interrupt (<u>CLK_RECOVER_*</u>) is generated and the device automatically exits software shutdown.

In manual mode, no clock recovery interrupts are generated; the clock monitor remains disabled and the device remains in software shutdown until the host software sets <u>EN</u> back to 1.



Figure 31. Clock Monitor Framing Error Example In TDM Mode With PCM_BSEL = 0x6 and CMON_BSELTOL = 0x0

Speaker Monitor

The speaker monitor is a circuit that is designed to protect the speaker against amplifier signals that could damage it. The speaker monitor is enabled by default and can be disabled by setting the <u>SPKMON_EN</u> bit to zero. The circuit monitors the amplifier's PWM signal and shuts down the amplifier output when the signal goes above a programmed speaker

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monitor threshold (set by <u>SPKMON_THRESH</u>) for a programmed amount of time (set by <u>SPKMON_DURATION</u>). Additionally, the device also generates an <u>INT_SPKMON_ERR</u> interrupt.

The speaker monitor circuit uses PWM signals of the amplifier, and in the case of DC signals, the amplifier accurately detects signals above the threshold. However, for a sine wave with a DC offset, the average DC detected by the circuit is lower because of the zeroes presented from the sine signal. In this case, the speaker monitor threshold (set by <u>SPKMON_THRESH</u>) and/or the speaker monitor duration (set by <u>SPKMON_DURATION</u>) can be adjusted to protect the speaker against the DC present in the signal.

Thermal Protection

When the device is active, the measurement ADC thermal channel is automatically enabled and monitors die temperature to ensure that it does not exceed the configured thermal thresholds. Interrupt registers are provided so that the device can notify the host when the die temperature crosses either the thermal warning or thermal-shutdown threshold, or when thermal foldback starts and stops.

Thermal Warning and Thermal Shutdown Configuration

The device features two thermal-warning thresholds. The thermal-warning thresholds are configured by <u>*THERMWARN1_THRESH[6:0]*</u> and <u>*THERMWARN2_THRESH[6:0]*</u> bit fields and the thermal shutdown threshold is configured by the <u>*THERMSHDN_THRESH[5:0]*</u> bit field. The thermal-warning2 threshold should always be set to a temperature higher than or equal to thermal-warning1 temperature. Additionally, the thermal-warning2 threshold temperature should never be configured higher than the thermal shutdown threshold temperature minus hysteresis. When the die temperature is decreasing, hysteresis is applied to thermal-shutdown, thermal-warning1, and thermal-warning2 thresholds. The temperature hysteresis is configured with <u>*THERM_HYST*</u> bit field.

Thermal Shutdown Recovery Configuration

The device thermal-shutdown recovery behavior is determined by the state of <u>THERM_AUTORESTART_EN</u> bit. When the <u>THERM_AUTORESTART_EN</u> bit is set to 0, the thermal-shutdown recovery is in manual mode. In manual mode, when the die temperature exceeds the thermal shutdown threshold, an interrupt is generated and the amplifier output is automatically disabled. Once the die temperature drops below both of the thermal-shutdown threshold minus the hysteresis and the thermal-warning2 threshold minus the hysteresis, the appropriate interrupts are generated to notify the host. In addition, once the die temperature drops below the thermal-warning2 threshold minus the hysteresis, the device is placed into software shutdown (<u>EN</u> is set to 0) and remains in that state until the host manually re-enables the device. When the <u>THERM_AUTORESTART_EN</u> bit is set to 1, the thermal-shutdown recovery is in automatic mode. In automatic mode, when the die temperature exceeds the thermal-shutdown threshold, an interrupt is generated and the amplifier is automatically disabled. Once the die temperature drops below the thermal shutdown threshold minus the hysteresis, an interrupt is generated but the amplifier remains disabled. When the temperature drops below the thermal shutdown threshold minus the hysteresis, an interrupt is generated but the amplifier remains disabled. When the temperature drops below the thermal-shutdown threshold minus the hysteresis, an interrupt is generated but the amplifier remains disabled. When the temperature drops below the thermal-warning2 threshold minus the hysteresis, another interrupt is generated and (unlike manual mode) the amplifier is then automatically re-enabled.

Thermal Foldback

The device features thermal foldback to allow for a smoother audio response to high temperature events. Thermal foldback is enabled by setting the <u>THERMFB_EN</u> bit to 1. The device provides two thermal-warning thresholds that are configured by the <u>THERMWARN1_THRESH[6:0]</u> and <u>THERMWARN2_THRESH[6:0]</u> bit fields. They should be set such that thermal-warning2 threshold temperature is higher than or equal to thermal-warning1 threshold temperature. Additionally, the thermal-warning2 threshold temperature should never be configured higher than the thermal shutdown threshold temperature minus hysteresis.

Once enabled, thermal foldback begins when the die temperature exceeds the configured thermal-warning1 threshold, interrupts are generated (<u>THERMFB_BGN_*</u> and <u>THERMWARN1_BGN_*</u>), and attenuation is applied to the speaker amplifier path. The slope of the thermal foldback attenuation is programmed with the <u>THERMFB_SLOPE1</u> bit field.

If the die temperature continues to increase and exceeds the configured thermal-warning2 threshold, an interrupt (<u>THERMWARN2_BGN_*</u>) is generated and attenuation continues to be applied to the speaker amplifier path. The slope of the attenuation applied to the speaker amplifier path is programmed with the <u>THERMFB_SLOPE2</u> bit field. As the die

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temperature increases, the level of attenuation also increases proportionally up to a maximum level of -12dB (unless the thermal shutdown threshold is exceeded first). When thermal foldback is active, the attack time for a gain change can be a maximum of two samples. Additionally, there is a sample delay in the signal path attenuation due to the group delay of the amplifier.

When the die temperature starts to decrease and drops below the thermal-warning2 threshold minus the programmed hysteresis level and remains there for longer than the programmed hold time (set with the <u>THERMFB_HOLD</u> bit field), the attenuation starts to release and an interrupt (<u>THERMWARN2_END_*</u>) is generated. If the die temperature continues to reduce and drops below the thermal-warning1 threshold temperature minus the programmed hysteresis level, thermal foldback ends and interrupts (<u>THERMFB_END_*</u> and <u>THERMWARN1_END_*</u>) are generated. The attenuation release rate (for decreasing temperature) is programmable and configured with the <u>THERMFB_RLS</u> bit field.

Tone Generator

The device includes a tone generator which is enabled using the <u>TONE_EN</u> bit field and replaces the PCM interface as the input source to the speaker playback path. When the tone generator is enabled, both it and the speaker playback path operate without the need for any external clocks.

The tone generator output is configured to generate sine wave or DC tones (using the <u>TONE_CONFIG</u> bit field).

The tone generator can create sine waves with either a 1kHz fixed frequency or a variable sample rate dependent frequency. When a sample rate based sinewave output is selected, the tone generator output frequency is set by the playback sample rate setting (<u>PCM_SR</u>) divided by the selected ratio (as set by <u>TONE_CONFIG</u>). For the playback sample rate of 44.1kHz and its multiples, the tone generator output frequency can vary by up to 9%. The tone generator supports all available sample rate settings (<u>PCM_SR</u>). The amplitude of the output sine wave relative to full-scale is selected with the <u>TONE_AMPLITUDE</u> bit field.

The tone generator can output either a fixed or a programmable DC output level (as set by <u>TONE_CONFIG</u>). Fixed DC output levels of zero code, positive half-scale, and negative half-scale are provided for quick configuration. If the programmable DC output level is selected (<u>TONE_CONFIG</u>), the DC level is configured as a signed two's complement value with the <u>TONE_DC</u> bit field.

Pink Noise Generator

The device includes a pink noise generator, which is enabled using the PINK_NOISE_EN bit field and replaces the PCM interface as the input source to the speaker playback path. The pink noise generator and the tone generator cannot be enabled at the same time. When the pink noise generator is enabled, both it and the speaker playback path operate without the need for any external clocks. The output level of the generator is fixed, so the amplifier gain and speaker volume must be used to adjust the level.

Interchip Communication

The device features an interchip communication (ICC) interface that uses a shared data bus to facilitate synchronized speaker amplifier path attenuation adjustments across groups of devices. Depending on the configuration, the ICC interface can synchronize brownout-prevention engine (BPE), DHT, and thermal foldback. Each device receives the data of the other grouped devices and reacts accordingly.

ICC Operation and Data Format

The bidirectional ICC bus is used to synchronize the responses of grouped devices. To create the ICC bus, the ICC interface pins of each device are externally connected together (whether or not the devices are in the same group). The ICC bus operates with the same clock sources and data format configuration as the PCM interface data input (DIN), and can support a maximum of 16 channels. For a given valid PCM interface configuration, the number of available ICC data channels per frame is calculated as follows (based on the <u>PCM_CHANSZ</u>, <u>PCM_BSEL</u>, and <u>PCM_FORMAT</u> settings):

Number of Available Data Input Channels = BCLK to LRCLK Ratio / Channel Length

The ICC interface is disabled when both the ICC data transmit output (<u>ICC_TX_EN</u>) and the ICC data link (<u>ICC_LINK_EN</u>) are disabled. To enable the ICC interface, both <u>ICC_TX_EN</u> and <u>ICC_LINK_EN</u> must be set to

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1. It is invalid to set these controls to different values, and both must always be set to the same state (either enabled or disabled). Once the ICC link and data transmit are enabled, the ICC data output channel is assigned with the <u>ICC_TX_DEST</u> bit field. The ICC pin is Hi-Z during all other data channels, and can be configured (with the <u>ICC_RX_CHn_EN</u> bits) to accept data from the output data channels of grouped devices.

The transmitted ICC data is always the same size as the configured PCM data input word size (set by <u>PCM_CHANSZ</u>). When a 16-bit data word is selected, the ICC data word is not long enough to synchronize BPE, DHT, and thermal foldback. In this case, the <u>ICC_DATA_SEL</u> bit is used to choose whether the DHT function or thermal foldback function is synchronized in addition to BPE state. When a 24-bit or 32-bit data word size is selected, ICC can synchronize BPE, DHT, and thermal foldback across a given group. In these cases, the <u>ICC_DATA_SEL</u> bit has no effect. Active ICC data channels always contain ICC data words followed by zero padding bit up to the ICC data channel length (which is equal to PCM input data channel length). If BPE, DHT, or thermal foldback is disabled for any given group, then the transmitted ICC data for the disabled function(s) is always zero code.

Multiamplifier Grouping

The ICC interface allows multiple devices to be grouped so that BPE, DHT, and thermal foldback behavior can be synchronized. The receive channel enables ($ICC_RX_CHn_EN$) are used to define groups. A given device monitors all selected channels (when $ICC_RX_CHn_EN$ = 1, and n denotes the channel number) on the ICC data bus. The configured set of receive channels must also include the assigned transmit channel (as set by ICC_TX_DEST) for any given device. Each device in a given group must have identical settings for all ICC receive channel enables ($ICC_RX_CHn_EN$). Furthermore, all devices in the same group must have identical DHT, thermal protection, and thermal foldback settings to achieve a synchronized response across the group. The behavior of a group as a whole is undefined if any given device in a group has different settings.

The ICC bus can support a maximum of 16 data channels. The minimum size of a group is two devices, and as a result the maximum number of concurrent groups on a single ICC bus is eight. A group can contain as many as 16 devices, but then only a single group is possible on a single ICC bus.

ICC Multi-Group Example

Consider a system design that includes four devices that require DHT synchronization, and that two distinct groups of two devices each (with different DHT settings) must share single ICC bus. The PCM interface (and thus ICC bus) is configured in TDM mode 1 with four 16-bit data channels available. One possible configuration (among many) is to assign devices 1 and 3 to the first group (denoted group A), and to assign devices 2 and 4 to the second group (denoted group B).

To configure group A, both devices 1 and 3 are set to monitor channels 0 and 2 by programming $\underline{ICC_RX_CH0_EN} = 1$ and $\underline{ICC_RX_CH2_EN} = 1$ on both devices (all other ICC receive bit fields are 0). Device 1 transmits on channel 0 ($\underline{ICC_TX_DEST} = 0x0$) and device 3 transmits on channel 2 ($\underline{ICC_TX_DEST} = 0x2$).

To configure group B, both devices 2 and 4 are set to monitor channels 1 and 3 by programming $\underline{ICC_{RX}_{CH1}_{EN}} = 1$ and $\underline{ICC_{RX}_{CH3}_{EN}} = 1$ on both devices (all other ICC receive bit fields are 0). Device 2 transmits on channel 1 ($\underline{ICC_{TX}_{DEST}} = 0x1$) and device 4 transmits on channel 3 ($\underline{ICC_{TX}_{DEST}} = 0x3$).

Since the ICC channel length and data word size is limited to 16 bits, the <u>ICC_DATA_SEL</u> bit field in all four devices must be set to 0 to select DHT target attenuation synchronization. Finally, on all four devices set <u>ICC_LINK_EN</u> = 1 and <u>ICC_TX_EN</u> = 1 to enable the ICC interfaces.

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Figure 32. ICC Multi-Group Example with 2 Groups and 4 Total Devices

I²C Serial Interface

The I²C serial control interface is activated when the device detects a valid I²C start condition at the I2C1 and I2C2 pins. The I2C1 and I2C2 pins can each act as either SCL or SDA respectively, and the start condition configures the device address and state of each pin. After the first I²C transaction, the I²C interface configuration should remain fixed.

Slave Address

The slave address is defined as the seven most significant bits (MSBs) followed by the read/write bit. The seven most significant bits are programmable through the ADDR connection, and the required I2C1 and I2C2 connections for each address are shown in <u>Table 10</u>. The device does not communicate if ADDR is floating. Setting the read/write bit to 1 configures the device for read mode. Setting the read/write bit to 0 configures the device for write mode. The address is the first byte of information sent to the IC after the START condition.

I2C1	12C2	ADDR CONNECTION	I ² C SLAVE ADDRESS (BINARY)	I ² C WRITE ADDRESS (BINARY)	I ² C READ ADDRESS (BINARY)
SDA	SCL	Connected to DVDDIO	0111000x	01110000	01110001
SDA	SCL	Connected to GND	0111001x	01110010	01110011
SDA	SCL	Connected to SDA	0111010x	01110100	01110101
SDA	SCL	Connected to SCL	0111011x	01110110	01110111
SCL	SDA	Connected to DVDDIO	0111100x	01111000	01111001
SCL	SDA	Connected to GND	0111101x	01111010	01111011
SCL	SDA	Connected to SDA	0111110x	01111100	01111101
SCL	SDA	Connected to SCL	0111111x	01111110	01111111

Table 10. I²C Slave Address

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The IC features an I²C/SMBusTM-compatible, 2-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA and SCL facilitate communication between the IC and the master at clock rates up to 1MHz. Figure <u>33</u> shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the IC by transmitting the proper slave address followed by two register address bytes (most significant byte first) and then the data word. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the IC is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the IC transmits the proper slave address followed by a series of nine SCL pulses. The IC transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START (S) or REPEATED START (Sr) condition, a not acknowledge, and a STOP (P) condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500Ω, is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than 500Ω, is required on SDA and SCL are optional. Series resistors protect the digital inputs of the IC from high voltage spikes on the bus lines, and minimize crosstalk and undershoot of the bus signals.



Figure 33. I²C Interface Timing Diagram

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the <u>START and STOP Conditions</u> section).

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high. A START condition from the master signals the beginning of a transmission to the IC. The master terminates transmission and frees the bus by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

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Figure 34. I²C START, STOP, and REPEATED START Conditions

Early STOP Conditions

The IC recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the IC uses to handshake receipt each byte of data when in write mode. The IC pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master retries communication. The master pulls down SDA during the 9th clock cycle to acknowledge receipt of data when the IC is in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not-acknowledge is sent when the master reads the final byte of data from the IC, followed by a STOP condition.



Figure 35. I²C Acknowledge

Write Data Format

A write to the IC includes transmission of a START condition, the slave address with the R/W bit set to 0, two bytes of data to configure the internal register address pointer, one or more bytes of data, and a STOP condition.

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The slave address with the R/W bit set to 0 indicates that the master intends to write data to the IC. The IC acknowledges receipt of the address byte during the master-generated 9th SCL pulse.

The second and third bytes transmitted from the master configure the ICs internal register address pointer. The pointer tells the IC where to write the next byte of data. An acknowledge pulse is sent by the IC upon receipt of the address pointer data.

The third byte sent to the IC contains the data that is written to the chosen register. An acknowledge pulse from the IC signals receipt of the data byte. The address pointer auto-increments to the next register address after each received data byte. This auto-increment feature allows the master to write to sequential registers within one continuous frame. The master signals the end of transmission by issuing a STOP condition.



Figure 36. I²C Writing One Byte of Data to the Slave



Figure 37. I²C Writing n-Bytes of Data to the Slave

Read Data Format

Initiate a read operation by sending the slave address with the R/W bit set to 1. The IC acknowledges receipt of its slave address by pulling SDA low during the 9th SCL clock pulse. A START command followed by a read command resets the address pointer to register 0x2000.

The first byte transmitted from the IC is the content of register 0x00. Transmitted data is valid on the rising edge of SCL. The address pointer auto-increments after each read data byte. This auto-increment feature allows all registers to be read sequentially within one continuous frame. A STOP condition can be issued after any number of read data bytes. If a STOP condition is issued followed by another read operation, the first data byte to be read is from register 0x00.

The address pointer can be preset to a specific register before a read command is issued. The master presets the address pointer by first sending the ICs slave address with the R/W bit set to 0 followed by the two byte register address. A REPEATED START condition is then sent followed by the slave address with the R/W bit set to 1. The IC then transmits the contents of the specified register. The address pointer auto-increments after transmitting the first byte.

The master acknowledges receipt of each read byte during the acknowledge clock pulse. The master must acknowledge

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all correctly received bytes except the last byte. The final byte must be followed by a not acknowledge from the master and then a STOP condition.



Figure 38. I²C Reading One Byte of Data from the Slave



Figure 39. I²C Reading n-Bytes of Data from the Slave

I²C Register Map

Control Bit Field Types and Write Access Restrictions

The device control bit fields fall into one of three basic types: read, write, or read and write. There are no read restrictions, and any read enabled bit field can be read back anytime the I²C control interface is active. However, there are write restrictions, and every write enabled bit field falls into one of two write access subtypes.

The first write access subtype is dynamic. Dynamic bit fields effectively have no write access restrictions, and can be safely changed (written) in any device state where the l^2C control interface is active. The second bit field access subtype is restricted. Restricted bit fields should only be changed (written) when the related functional block (as shown in <u>Table 11</u>) is powered down.

If the write access is restricted to the global enable (restrictions EN and ENL), then the restricted bit field should only be changed (written) when the device is in software-shutdown. As a form of system protection, write access to some critical global enable restricted bit fields (ENL) is locked out by the hardware when the device is not in the software-shutdown state. Attempting to change (write to) these locked restricted bit fields when the device is not in the software-shutdown state has no effect (read access is still allowed).

The bit field type and write access subtype is provided for every bit field in the detailed register description tables. For all bit fields with the restricted subtype, the dependency is also denoted in the "RES" column.

<u>Table 11</u> provides a detailed description of all device register types, access subtypes, and restriction dependencies that are used by this device. The write access restrictions describe the specific device condition(s) that should be met (and the corresponding bit field settings) before the system attempts to change (write to) bit fields with that restriction type.

Table 11. Control Bit Types and Write Access Restrictions

BIT FIELD	WRITE	WRITE ACCESS RESTRICTIONS						
TYPE	ACCESS	DESCRIPTION	CONDITION	SYMBOL				

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Read	Read Only	_	_	_
	Dynamic	_	—	_
		Device in Software Shutdown	EN = 0	EN
		Write Access Locked Out by Hardware Unless the Device in Software Shutdown	EN = 0	ENL
		Speaker Amplifier Output and Feedback Disabled	SPK_EN = 0 and SPK_FB_EN = 0	SPK
		Voltage and Current Sense ADCs Disabled	IVADC_V_EN = 0 and IVADC_I_EN = 0	IVS
		Thermal Foldback Disabled	THERMFB_EN = 0	TFB
Write or Read/ Write	Restricted	Noise Gate Disabled	NOISEGATE_EN = 0	NG
Winte		Dynamic-Headroom Tracking Disabled	DHT_EN = 0	DHT
		Brownout-Prevention Engine Disabled	BPE_EN = 0	BPE
		PCM Interface Data Input and Output Disabled	PCM_RX_EN = 0 and PCM_TX_EN = 0	РСМ
		PCM Data Output Disabled	PCM_TX_EN = 0	TXEN
		IRQ Bus Output Disabled	IRQ_EN = 0	IRQ
		Interchip Communication (ICC) Interface Disabled	ICC_LINK_EN = 0 and ICC_TX_EN = 0	ICC

Table 11. Control Bit Types and Write Access Restrictions (continued)

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Register Map

Register Map

ADDRESS	NAME	MSB							LSB
Reset				1		1		1	
0x2000	Software Reset[7:0]	_	_	_	_	_	_	_	RST
Interrupts			•						
0x2001	Interrupt Raw 1[7:0]	THERM SHDN_B GN_RA W	THERM SHDN_E ND_RA W	THERM WARN1_ BGN_RA W	THERM WARN1_ END_RA W	THERMF B_BGN_ RAW	THERMF B_END_ RAW	OTP_FAI L_RAW	SPK_OV C_RAW
0x2002	Interrupt Raw 2[7:0]	THERM WARN2_ BGN_RA W	THERM WARN2_ END_RA W	INT_SPK MON_E RR_RA W	INT_CLK _ERR_R AW	_	CLK_RE COVER_ RAW	CLK_ER R_RAW	DMON_ ERR_RA W
0x2003	Interrupt Raw 3[7:0]	_	_	PWRUP _DONE_ RAW	PWRDN _DONE_ RAW	PVDD_U VLO_SH DN_RA W	VBAT_U VLO_SH DN_RA W	DHT_AC TIVE_B GN_RA W	DHT_AC TIVE_EN D_RAW
0x2004	Interrupt Raw 4[7:0]	_	_	_	-	BPE_L0 _RAW	BPE_LE VEL_RA W	BPE_AC TIVE_B GN_RA W	BPE_AC TIVE_EN D_RAW
0x2006	Interrupt State 1[7:0]	THERM SHDN_B GN_STA TE	THERM SHDN_E ND_STA TE	THERM WARN1_ BGN_ST ATE	THERM WARN1_ END_ST ATE	THERMF B_BGN_ STATE	THERMF B_END_ STATE	OTP_FAI L_STAT E	SPK_OV C_STAT E
0x2007	Interrupt State 2[7:0]	THERM WARN2_ BGN_ST ATE	THERM WARN2_ END_ST ATE	INT_SPK MON_E RR_STA TE	INT_CLK _ERR_S TATE	_	CLK_RE COVER_ STATE	CLK_ER R_STAT E	DMON_ ERR_ST ATE
0x2008	Interrupt State 3[7:0]	-	_	PWRUP _DONE_ STATE	PWRDN _DONE_ STATE	PVDD_U VLO_SH DN_STA TE	VBAT_U VLO_SH DN_STA TE	DHT_AC TIVE_B GN_STA TE	DHT_AC TIVE_EN D_STAT E
0x2009	Interrupt State 4[7:0]	-	_	_	_	BPE_L0 _STATE	BPE_LE VEL_ST ATE	BPE_AC TIVE_B GN_STA TE	BPE_AC TIVE_EN D_STAT E
0x200B	Interrupt Flag 1[7:0]	THERM SHDN_B GN_FLA G	THERM SHDN_E ND_FLA G	THERM WARN1_ BGN_FL AG	THERM WARN1_ END_FL AG	THERMF B_BGN_ FLAG	THERMF B_END_ FLAG	OTP_FAI L_FLAG	SPK_OV C_FLAG
0x200C	Interrupt Flag 2[7:0]	THERM WARN2_ BGN_FL AG	THERM WARN2_ END_FL AG	INT_SPK MON_E RR_FLA G	INT_CLK _ERR_F LAG	_	CLK_RE COVER_ FLAG	CLK_ER R_FLAG	DMON_ ERR_FL AG

ADDRESS	NAME	MSB							LSB	
0x200D	Interrupt Flag 3[7:0]	_	_	PWRUP _DONE_ FLAG	PWRDN _DONE_ FLAG	PVDD_U VLO_SH DN_FLA G	VBAT_U VLO_SH DN_FLA G	DHT_AC TIVE_B GN_FLA G	DHT_AC TIVE_EN D_FLAG	
0x200E	Interrupt Flag 4[7:0]	_	_	_	_	BPE_L0 _FLAG	BPE_LE VEL_FL AG	BPE_AC TIVE_B GN_FLA G	BPE_AC TIVE_EN D_FLAG	
0x2010	Interrupt Enable 1[7:0]	THERM SHDN_B GN_EN	THERM SHDN_E ND_EN	THERM WARN1_ BGN_EN	THERM WARN1_ END_EN	THERMF B_BGN_ EN	THERMF B_END_ EN	OTP_FAI L_EN	SPK_OV C_EN	
0x2011	Interrupt Enable 2[7:0]	THERM WARN2_ BGN_EN	THERM WARN2_ END_EN	INT_SPK MON_E RR_EN	INT_CLK _ERR_E N	-	CLK_RE COVER_ EN	CLK_ER R_EN	DMON_ ERR_EN	
0x2012	Interrupt Enable 3[7:0]	-	-	PWRUP _DONE_ EN	PWRDN _DONE_ EN	PVDD_U VLO_SH DN_EN	VBAT_U VLO_SH DN_EN	DHT_AC TIVE_B GN_EN	DHT_AC TIVE_EN D_EN	
0x2013	Interrupt Enable 4[7:0]	-	-	-	-	BPE_L0 _EN	BPE_LE VEL_EN	BPE_AC TIVE_B GN_EN	BPE_AC TIVE_EN D_EN	
0x2015	Interrupt Flag Clear 1[7:0]	THERM SHDN_B GN_CLR	THERM SHDN_E ND_CLR	THERM WARN1_ BGN_CL R	THERM WARN1_ END_CL R	THERMF B_BGN_ CLR	THERMF B_END_ CLR	OTP_FAI L_CLR	SPK_OV C_CLR	
0x2016	Interrupt Flag Clear 2[7:0]	THERM WARN2_ BGN_CL R	THERM WARN2_ END_CL R	INT_SPK MON_E RR_CLR	INT_CLK _ERR_C _LR	_	CLK_RE COVER_ CLR	CLK_ER R_CLR	DMON_ ERR_CL R	
0x2017	Interrupt Flag Clear 3[7:0]	-	-	PWRUP _DONE_ CLR	PWRDN _DONE_ CLR	PVDD_U VLO_SH DN_CLR	VBAT_U VLO_SH DN_CLR	DHT_AC TIVE_B GN_CLR	DHT_AC TIVE_EN D_CLR	
0x2018	Interrupt Flag Clear 4[7:0]	-	-	-	_	BPE_L0 _CLR	BPE_LE VEL_CL R	BPE_AC TIVE_B GN_CLR	BPE_AC TIVE_EN D_CLR	
0x201F	IRQ Control[7:0]	-	-	-	-	-	IRQ_MO DE	IRQ_PO L	IRQ_EN	
Thermal Pro	otection									
0x2020	Thermal Warning Threshhold[7:0]	_			THERMV	/ARN1_THF	RESH[6:0]			
0x2021	Warning Threshold 2[7:0]	-	THERMWARN2_THRESH[6:0]							
0x2022	Thermal Shutdown Threshold[7:0]	_	THERMSHDN_THRESH[6:0]							
0x2023	Thermal Hysteresis[7:0]	-	-	-	-	-	-	THERM_	HYST[1:0]	
0x2024	Thermal Foldback Settings[7:0]	THERMFE (Rectain Control (MFB_HOLD[1: 0]THERMFB_RLS[1:0]THERMFB_SLOPE2THERMFB_SLOPE2[1:0][1:0][1:0]						3_SLOPE1 :0]	
0x2027	Thermal Foldback Enable[7:0]	_	_	_	_	_	_	_	THERMF B_EN	

ADDRESS	NAME	MSB							LSB
Noise Gate	and Idle Mode								
0x2030	Noise Gate/Idle Mode Control[7:0]	l	UNMUTE_T	HRESH[3:0]		MUTE_TH	RESH[3:0]	
0x2033	Noise Gate/Idle Mode Enables[7:0]	_	_	_	_	_	_	_	NOISEG ATE_EN
Clock and I	Data Monitor Control	1	I	I	I	1	1	I	I
0x2038	Clock Monitor Control[7:0]	_	СМО	N_BSELTO	L[2:0]	CMON_ERRTOL[2:0]			CMON_ AUTORE START_ EN
0x2039	Data Monitor Control[7:0]	_	_	DMON_M S[´	AG_THRE 1:0]	DMON_S RES	TUCK_TH [1:0]	DMON_D 1:	URATION[0]
0x203A	Speaker Monitor Threshold[7:0]			:	SPKMON_T	HRESH[7:0]		
0x203B	Speaker Monitor Duration[7:0]	-	-	-	-	S	PKMON_DU	JRATION[3:	0]
0x203F	Enable Controls[7:0]	-	_	_	_	SPKMO N_EN N_EN SPKMO MAG_E N EN			
PCM Regis	ters								
0x2040	Pin Config[7:0]	LV_EN_	DRV[1:0]	ICC_D	RV[1:0]	IRQ_D	RV[1:0]	DOUT_[DRV[1:0]
0x2041	PCM Mode Config[7:0]	PCM_CH	ANSZ[1:0]	PCM	/_format	[2:0]	PCM_TX _INTERL EAVE	PCM_C HANSEL	PCM_TX _EXTRA _HIZ
0x2042	PCM Clock Setup[7:0]	-	-	-	PCM_BC LKEDGE		PCM_B	SEL[3:0]	
0x2043	PCM Sample Rate Setup 1[7:0]		IVADC_	_SR[3:0]			PCM_	SR[3:0]	
0x2044	PCM TX Control 1[7:0]	-	-			PCM_VMO	V_SLOT[5:0]	
0x2045	PCM TX Control 2[7:0]	-	-			PCM_IMON	I_SLOT[5:0]		
0x2046	PCM TX Control 3[7:0]	-	-			PCM_PVDE	_SLOT[5:0]]	
0x2047	PCM TX Control 4[7:0]	_	_			PCM_VBAT	_SLOT[5:0]		
0x2048	PCM TX Control 5[7:0]	-	-		P	CM_DHT_A	TN_SLOT[5	:0]	
0x2049	PCM TX Control 6[7:0]	_	_		Р	CM_STATL	IS_SLOT[5:	0]	
0x204A	PCM TX Control 7[7:0]	-	-		PCM	_DSP_MON	IITOR_SLO	T[5:0]	
0x204B	PCM TX Control 8[7:0]	-	-			PCM_BPE	_SLOT[5:0]		
0x204C	PCM Tx HiZ Control 1[7:0]			P	CM_TX_SLO	DT_HIZ[63:8	56]		
0x204D	PCM Tx HiZ Control 2[7:0]			P	CM_TX_SLO	DT_HIZ[55:4	18]		
0x204E	PCM Tx HiZ Control 3[7:0]	PCM_TX_SLOT_HIZ[47:40]							
0x204F	PCM Tx HiZ Control 4[7:0]	PCM_TX_SLOT_HIZ[39:32]							
0x2050	PCM Tx HiZ Control 5[7:0]			P	CM_TX_SLO	DT_HIZ[31:2	24]		

ADDRESS	NAME	MSB							LSB
0x2051	PCM Tx HiZ Control6[7:0]			P	CM_TX_SLO	DT_HIZ[23:	[6]		
0x2052	PCM Tx HiZ Control 7[7:0]			Р	CM_TX_SL	OT_HIZ[15:	8]		
0x2053	PCM Tx HiZ Control 8[7:0]			F	PCM_TX_SL	_OT_HIZ[7:0)]		
0x2055	PCM RX Source 1[7:0]	-	-	-	-	-	-	PCM_DM 1:	MIX_CFG[0]
0x2056	PCM RX Source 2[7:0]	PCM	_DMMIX_CH	H1_SOURC	E[3:0]	PCM	_DMMIX_CH	H0_SOURC	E[3:0]
0x2058	PCM Bypass Source[7:0]	_	-	_	-	PC	M_BYPASS	_SOURCE[3:0]
0x205D	PCM TX Source Enables[7:0]	PCM_BP E_EN	PCM_ST ATUS_E N	PCM_D HT_ATN _EN	PCM_VB AT_EN	PCM_PV PCM_DS PCM_IM PCM DD_EN OR_EN ON_EN N			
0x205E	PCM Rx Enables[7:0]	-	-	-	-	-	-	PCM_BY P_EN	PCM_RX _EN
0x205F	PCM Tx Enables[7:0]	-	-	-	-	-	-	-	PCM_TX _EN
Interchip C	ommunication								
0x2070	ICC Rx Enables A[7:0]	ICC_RX _CH7_E N	ICC_RX _CH6_E N	ICC_RX _CH5_E N	ICC_RX _CH4_E N	ICC_RX _CH3_E N	ICC_RX _CH2_E N	ICC_RX _CH1_E N	ICC_RX _CH0_E N
0x2071	ICC Rx Enables B[7:0]	ICC_RX _CH15_ EN	ICC_RX _CH14_ EN	ICC_RX _CH13_ EN	ICC_RX _CH12_ EN	ICC_RX _CH11_ EN	ICC_RX _CH10_ EN	ICC_RX _CH9_E N	ICC_RX _CH8_E N
0x2072	ICC Tx Control[7:0]	-	ICC_INT ERLEAV E_MOD E	ICC_DA TA_SEL	_		ICC_TX_I	DEST[3:0]	
0x207F	ICC Enables[7:0]	_	-	_	-	-	-	ICC_LIN K_EN	ICC_TX_ EN
Tone Gener	ator Control								
0x2083	Tone Generator and DC Config[7:0]	_	-	TONE_AM 1:	IPLITUDE[0]		TONE_CC	DNFIG[3:0]	
0x2084	Tone Generator DC Level 1[7:0]				TONE_D	C[23:16]			
0x2085	Tone Generator DC Level 2[7:0]				TONE_I	DC[15:8]			
0x2086	Tone Generator DC Level 3[7:0]	TONE_DC[7:0]							
0x208F	Tone Generator Enable[7:0]	-	_	-	_	TONE_E			
Speaker Pa	th Control		1						
0x2090	AMP volume control[7:0]	-			S	PK_VOL[6:	0]		
0x2091	AMP Path Gain[7:0]	_	_	_		SPK	_GAIN_MA>	< [4:0]	

ADDRESS	NAME	MSB							LSB
0x2092	AMP DSP Config[7:0]	_	SPK_WB AND_FIL T_EN	SPK_SA FE_EN	SPK_VO L_RMPD N_BYPA SS	SPK_VO L_RMPU P_BYPA SS	SPK_IN VERT	SPK_DIT H_EN	SPK_DC BLK_EN
0x2093	SSM Configuration[7:0]	-	-	-	-	SPK_SS M_EN SPK_SSM_MOD_INDEX[2:0]			
0x2094	SPK Class DG Threshold[7:0]	-	-	_		SPK_	_DG_THRE	S[4:0]	
0x2095	SPK Class DG Headroom[7:0]	-	-	SPK_DG	_SEL[1:0]	SF	PK_DG_HE	ADROOM[3	:0]
0x2096	<u>SPK Class DG Hold</u> Time[7:0]	-	SPK_D	G_PEAK_H	YST[2:0]	SI	PK_DG_HO	LD_TIME[3	:0]
0x2097	<u>SPK Class DG</u> <u>Delay[7:0]</u>	-	-			SPK_DG_I	DELAY[5:0]		
0x2098	<u>SPK Class DG</u> Mode[7:0]	-	-	_	-	-	-	SPK_M	DDE[1:0]
0x2099	<u>SPK Class DG VBAT</u> Level[7:0]	-	-	-	-	-	VBATL	-OW_OK_L	VL[2:0]
0x209A	SPK Edge Control[7:0]	-	-	-	-	-	SPK_FS W_SEL	-	-
0x209B	SPK Path Wideband Only Enable[7:0]	-	_	_	_	_	_	_	SPK_WI DEBAND _ONLY_ EN
0x209C	SPK Edge Control 1[7:0]	-	-	-	-	SP	K_SL_RATE	E_GMODE[3:0]
0x209D	SPK Edge Control 2[7:0]		SPK_SL_R	ATE_LS[3:0]	:	SPK_SL_RA	ATE_HS[3:0]
0x209E	Amp Clip Gain[7:0]	_	_	_	_		SPK_G	AIN[3:0]	
0x209F	Bypass Path Config[7:0]	_	_	-	-	-	-	BYP_WB AND_FIL T_EN	BYP_IN VERT
0x20A0	Amplifier Supply Control[7:0]	-	-	-	-	-	-	-	NOVBAT
0x20AF	AMP enables[7:0]	-	-	-	-	-	-	SPK_FB _EN	SPK_EN
Meas ADC									
0x20B0	Meas ADC Sample Rate[7:0]	-	-	MEAS_AI _SR	DC_TEMP [1:0]	MEAS_ADC_PVDD MEAS_ADC_VBAT_ _SR[1:0] SR[1:0]			0C_VBAT_ [1:0]
0x20B1	Meas ADC PVDD Config[7:0]	-	_	_	MEAS_A DC_PVD D_FILT_ EN	MEAS_ADC_PVDD_FILT_COEFF[3:0]			EFF[3:0]
0x20B2	Meas ADC VBAT Config[7:0]	_	_	_	MEAS_A DC_VBA T_FILT_ EN	MEAS_ADC_VBAT_FILT_COEFF[3:0]			EFF[3:0]

ADDRESS	NAME	MSB							LSB	
0x20B3	Meas ADC Thermal Config[7:0]	_	_	_	MEAS_A DC_TEM P_FILT_ EN	MEAS_	ADC_TEMF	P_FILT_CO	EFF[3:0]	
0x20B4	Meas ADC Readback Control 1[7:0]	_	_	_	_	_	MEAS_A DC_THE RM_RD_ MODE	MEAS_A DC_VBA T_RD_M ODE	MEAS_A DC_PVD D_RD_M ODE	
0x20B5	Meas ADC Readback Control 2[7:0]	_	_	_	_	_	MEAS_A DC_THE RM_RD_ UPD	MEAS_A DC_VBA T_RD_U PD	MEAS_A DC_PVD D_RD_U PD	
0x20B6	Meas ADC PVDD Readback MSB[7:0]			ME	AS_ADC_P	VDD_DATA	[8:1]	•		
0x20B7	Meas ADC PVDD Readback LSB[7:0]	_	_	_	_	_	_	_	MEAS_A DC_PVD D_DATA [0]	
0x20B8	<u>Meas ADC VBAT</u> <u>Readback MSB[7:0]</u>			ME	AS_ADC_V	BAT_DATA	[8:1]			
0x20B9	Meas ADC VBAT Readback LSB[7:0]	_	_	_	_	_	_	_	MEAS_A DC_VBA T_DATA[0]	
0x20BA	<u>Meas ADC Temp</u> <u>Readback MSB[7:0]</u>	MEAS_ADC_THERM_DATA[8:1]								
0x20BB	Meas ADC Temp Readback LSB[7:0]	_	_	_	_	_	_	-	MEAS_A DC_THE RM_DAT A[0]	
0x20BC	Meas ADC Lowest PVDD Readback MSB[7:0]			LC	WEST_PVI	DD_DATA[8	:1]			
0x20BD	Meas ADC Lowest PVDD Readback LSB[7:0]	-	-	-	-	-	-	-	LOWES T_PVDD _DATA[0]	
0x20BE	Meas ADC Lowest VBAT Readback MSB[7:0]			LC)WEST_VB	AT_DATA[8	:1]			
0x20BF	<u>Meas ADC Lowest</u> <u>VBAT Readback</u> LSB[7:0]	-	-	-	-	-	-	-	LOWES T_VBAT _DATA[0]	
0x20C7	Meas ADC Config[7:0]	-	-	-	-	-	-	MEAS_A DC_VBA T_EN	MEAS_A DC_PVD D_EN	
Dynamic He	eadroom Tracking									
0x20D0	DHT Configuration 1[7:0]	-	-	-	-		DHT_VRO	T_PNT[3:0]		

ADDRESS	NAME	MSB							LSB	
0x20D1	Limiter Configuration 1[7:0]	-	-	-		ſ	DHT_HR[4:0)]		
0x20D2	Limiter Configuration 2[7:0]	-	-		DHT_I	LIM_THRES	6H[4:0]		DHT_LI M_MOD E	
0x20D3	DHT Configuration 2[7:0]	-	-	_		DHT	_MAX_ATN	I[4:0]		
0x20D4	DHT Configuration 3[7:0]	-	-	-	-		DHT_ATK	_RATE[3:0]		
0x20D5	DHT Configuration 4[7:0]	-	-	-	-		DHT_RLS	_RATE[3:0]		
0x20D6	DHT Supply Hysteresis Configuration[7:0]	-	-	-	-	DHT_S	UPPLY_HY	'ST[2:0]	DHT_SU PPLY_H YST_EN	
0x20DF	DHT Enable[7:0]	-	-	-	-	_	-	-	DHT_EN	
I_V Sense F	Path Control									
0x20E0	I <u>V Sense Path</u> Config[7:0]	_	_	_	_	IVADC_ WBAND _FILT_E N	IVADC_ DITH_E N	IVADC_I _DCBLK _EN	IVADC_ V_DCBL K_EN	
0x20E4	I_V Sense Path Enables[7:0]	-	-	-	-	-	-	IVADC_I _EN	IVADC_ V_EN	
Brownout F	Prevention Engine									
0x20E5	BPE State[7:0]	-	-	-	-	– – BPE_STATE[2:0]				
0x20E6	BPE L3 Threshold MSB[7:0]			I	BPE_L3_VT	HRESH[8:1]			
0x20E7	BPE L3 Threshold LSB[7:0]	-	-	-	-	-	-	-	BPE_L3 _VTHRE SH[0]	
0x20E8	BPE L2 Threshold MSB[7:0]			I	BPE_L2_VT	HRESH[8:1]			
0x20E9	BPE L2 Threshold LSB[7:0]	-	-	_	-	-	-	-	BPE_L2 _VTHRE SH[0]	
0x20EA	BPE L1 Threshold MSB[7:0]			l	BPE_L1_VT	HRESH[8:1]			
0x20EB	BPE L1 Threshold LSB[7:0]	-	-	-	-	-	-	-	BPE_L1 _VTHRE _SH[0]	
0x20EC	BPE L0 Threshold MSB[7:0]			I	BPE_L0_VTHRESH[8:1]					
0x20ED	BPE L0 Threshold LSB[7:0]	-	-	_	_	BP S			BPE_L0 _VTHRE _SH[0]	
0x20EE	BPE L3 Dwell and Hold Time[7:0]	-	-	BPE	_L3_DWELI	_[2:0]	BPE	L3_HOLD	[2:0]	
0x20EF	BPE L2 Dwell and Hold Time[7:0]	_	_	BPE	_L2_DWELI	_[2:0]	BPE	L2_HOLD	[2:0]	

ADDRESS	NAME	MSB							LSB	
0x20F0	BPE L1 Dwell and Hold Time[7:0]	-	-	BPE	_L1_DWELI	_[2:0]	BPE	L1_HOLD	[2:0]	
0x20F1	BPE L0 Hold Time[7:0]	_	_	_	_	_	BPE	_L0_HOLD	[2:0]	
0x20F2	BPE L3 Attack and Release Step[7:0]	-	-	-	-		BPE_L3_STEP[3:0]			
0x20F3	BPE L2 Attack and Release Step[7:0]	-	_	_	_		BPE_L2_S	STEP[3:0]		
0x20F4	BPE L1 Attack and Release Step[7:0]	_	_	_	_		BPE_L1_S	STEP[3:0]		
0x20F5	BPE L0 Attack and Release Step[7:0]	_	_	_	_		BPE_L0_	STEP[3:0]		
0x20F6	BPE L3 Max Gain Attn[7:0]	_	_	-		BPE_l	_3_MAXATT	⁻ N[4:0]		
0x20F7	BPE L2 Max Gain Attn[7:0]	-	-	-		BPE_I	_2_MAXATT	⁻ N[4:0]		
0x20F8	BPE L1 Max Gain Attn[7:0]	-	-	-		BPE_I	_1_MAXATT	N[4:0]		
0x20F9	BPE L0 Max Gain Attn[7:0]	-	-	_		BPE_I	_0_MAXATT	N[4:0]		
0x20FA	BPE L3 Gain Attack and RIs Rates[7:0]	_	-	BPE_L	.3_GAIN_R	BPE_L3_GAIN_ATK[2:0]				
0x20FB	BPE L2 Gain Attack and RIs Rates[7:0]	_	_	BPE_L	.2_GAIN_R	LS[2:0] BPE_L2_GAIN_ATK[2:0]				
0x20FC	BPE L1 Gain Attack and Rls Rates[7:0]	-	-	BPE_L	_1_GAIN_R	LS[2:0] BPE_L1_GAIN_ATK[2:0]				
0x20FD	BPE L0 Gain Attack and Rls Rates[7:0]	-	-	BPE_L	.0_GAIN_R	LS[2:0]	BPE_L	.0_GAIN_A	TK[2:0]	
0x20FE	BPE L3 Limiter Config[7:0]	-	-	-	-		BPE_L3	_LIM[3:0]		
0x20FF	BPE L2 Limiter Config[7:0]	-	-	-	-		BPE_L2_	_LIM[3:0]		
0x2100	BPE L1 Limiter Config[7:0]	-	-	-	-		BPE_L1_	_LIM[3:0]		
0x2101	BPE L0 Limiter Config[7:0]	_	-	_	_		BPE_L0_	_LIM[3:0]		
0x2102	BPE L3 Limiter Attack and Release Rates[7:0]	_	_	BPE_	L3_LIM_RL	S[2:0]	BPE_	L3_LIM_AT	K[2:0]	
0x2103	BPE L2 Limiter Attack and Release Rates[7:0]	_	-	BPE_	L2_LIM_RL	S[2:0]	BPE_	L2_LIM_AT	K[2:0]	
0x2104	BPE L1 Limiter Attack and Release Rates[7:0]	-	-	BPE_	BPE_L1_LIM_ATK[2:0]				K[2:0]	
0x2105	BPE L0 Limiter Attack and Release Rates[7:0]	-	-	BPE_	L0_LIM_RL	S[2:0]	BPE_	L0_LIM_AT	K[2:0]	
0x2106	BPE Threshold Hysteresis[7:0]			BF	PE_VTHRESH_HYST[7:0]					
0x2107	BPE Infinite Hold Clear[7:0]	_	_	_	_	_	_	_	BPE_HL D_RLS	

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ADDRESS	NAME	MSB							LSB	
0x2108	BPE Supply Source[7:0]	-	-	_	-	_	_	-	BPE_SR C_SEL	
0x2109	BPE Lowest State[7:0]	-	-	-	-	-	BPE	BPE_LOWEST[2:0]		
0x210A	BPE Lowest Gain[7:0]			В	PE_LOWE	ST_GAIN[7:	0]			
0x210B	BPE Lowest Limiter[7:0]			В	PE_LOWE	ST_LIMIT[7:	0]			
0x210D	BPE Enable[7:0]	-	-	-	-	-	-	BPE_LI M_EN	BPE_EN	
System Co	nfiguration									
0x210E	<u>Auto-Restart</u> <u>Behavior[7:0]</u>	_	-	_	_	OVC_AU TOREST ART_EN	THERM_ AUTORE START_ EN	VBAT_A UTORES TART_E N	PVDD_A UTORES TART_E N	
0x210F	Global Enable[7:0]	-	-	-	-	-	-	-	EN	
Device and	Revision ID									
0x21FF <u>Revision ID[7:0]</u> REV_ID[7:0]										

Register Details

Software Reset (0x2000)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	_	-	-	-	RST
Reset	-	-	-	_	-	-	-	0b0
Access Type	-	-	_	-	_	_	-	Write Only
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
RST	0	_	This bit field is used to trigger a software reset event. Writing a 1 resets the device and returns the control registers to their power-on reset states. Writing a 0 has no effect, and readback always returns 0.			0: No action 1: Triggers a s	oftware reset e	vent

Interrupt Raw 1 (0x2001)

BIT	7	6	5	4	3	2	1	0
Field	THERMSH DN_BGN_R AW	THERMSH DN_END_R AW	THERMWA RN1_BGN_ RAW	THERMWA RN1_END_ RAW	THERMFB_ BGN_RAW	THERMFB_ END_RAW	OTP_FAIL_ RAW	SPK_OVC_ RAW
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERMSH DN_BGN_R AW	7	_	Raw value of thermal shutdown begin indicator			0: Die tempera shutdown limit 1: Die tempera shutdown limit	ture below the ture above the	rmal

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
THERMSH DN_END_R AW	6	_	Raw value of thermal shutdown end indicator	0: Die temperature above thermal shutdown limit 1: Die temperature has dropped below thermal shutdown limit
THERMWA RN1_BGN_ RAW	5	-	Raw value of thermal-warning1 begin indicator	0: Die temperature below thermal- warning1 limit 1: Die temperature above thermal- warning1 limit
THERMWA RN1_END_ RAW	4	_	Raw value of thermal-warning1 end indicator	0: Die temperature above thermal- warning1 limit 1: Die temperature has dropped below thermal-warning1 limit
THERMFB_ BGN_RAW	3	-	Raw value of thermal foldback begin	0: Thermal foldback is not active 1: Thermal foldback is active
THERMFB_ END_RAW	2	-	Raw value of thermal foldback end	0: Thermal foldback is active 1: Thermal foldback has ended
OTP_FAIL_ RAW	1	-	Raw status of OTP load fail	0: No OTP load failure 1: OTP load routine did not complete succesfully
SPK_OVC_ RAW	0	-	Raw value of speaker overcurrent limit	0: Speaker overcurrent limit inactive 1: Speaker overcurrent limit active

Interrupt Raw 2 (0x2002)

BIT	7	6	5	4	3	2	1	0
Field	THERMWA RN2_BGN_ RAW	THERMWA RN2_END_ RAW	INT_SPKM ON_ERR_R AW	INT_CLK_E RR_RAW	_	CLK_RECO VER_RAW	CLK_ERR_ RAW	DMON_ER R_RAW
Reset	0b0	0b0	0b0	0x0	_	0x0	0x0	0b0
Access Type	Read Only	Read Only	Read Only	Read Only	_	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERMWA RN2_BGN_ RAW	7	_	Raw value of thermal-warning2 begin indicator			0: Die temperature below thermal- warning2 limit 1: Die temperature above thermal- warning2 limit		
THERMWA RN2_END_ RAW	6	_	Raw value of thermal-warning2 end indicator			0: Die tempera warning2 limit 1: Die tempera thermal-warnin	ture above the ture has dropp g2 limit	mal- ed below
INT_SPKM ON_ERR_R AW	5	_	Raw value of the internal speaker monitor status indicator			0: Internal spea data error 1: Internal spea error	aker monitor no aker monitor re	t reporting
INT_CLK_E RR_RAW	4	_	Raw value of internal clock error indicator			0: Internal cloc error 1: Internal cloc error	k monitor not re k monitor repor	eporting clock ting clock

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
CLK_RECO VER_RAW	2	-	Raw value of the external clock monitor error recovery indicator	0: Clock monitor not reporting clock error recovery1: Clock monitor reporting clock error recovery
CLK_ERR_ RAW	1	-	Raw value of the external clock monitor error indicator	0: No external clock error detected1: Clock monitor reporting clock error
DMON_ER R_RAW	0	-	Raw value of external data monitor error indicator	0: No external data error detected 1: Data monitor reporting data error

Interrupt Raw 3 (0x2003)

BIT	7	6	5	4	3	2	1	0
Field	_	-	PWRUP_D ONE_RAW	PWRDN_D ONE_RAW	PVDD_UVL O_SHDN_R AW	VBAT_UVL O_SHDN_R AW	DHT_ACTI VE_BGN_R AW	DHT_ACTI VE_END_R AW
Reset	-	-	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	-	-	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
PWRUP_D ONE_RAW	5	_	Raw value of power-up done): Device is not reporting a power-up event 1: Device is reporting a power-up into the active state with the speaker amplifier enabled		
PWRDN_D ONE_RAW	4	_	Raw value of power-down done			0: Device is not reporting a power-down into software shutdown event1: Device is reporting a power-down into software shutdown event		
PVDD_UVL O_SHDN_R AW	3	_	Raw value of P	VDD UVLO er	ror indicator	0: No PVDD U 1: PVDD below active state	VLO error v UVLO thresho	old in the
VBAT_UVL O_SHDN_R AW	2	_	Raw value of VBAT UVLO error indicator			0: No VBAT U\ 1: VBAT below active state	/LO error UVLO thresho	ld in the
DHT_ACTI VE_BGN_R AW	1	_	Raw value of DHT active begin			0: DHT is not a 1: DHT is activ	ctive e	
DHT_ACTI VE_END_R AW	0	_	Raw value of DHT active end			0: DHT is curre applied attenua 1: DHT activity	ently active or h ation has ended	as not yet

Interrupt Raw 4 (0x2004)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L0_R AW	BPE_LEVE L_RAW	BPE_ACTIV E_BGN_RA W	BPE_ACTIV E_END_RA W
Reset	-	-	-	-	0x0	0x0	0x0	0x0
Access Type	_	-	-	-	Read Only	Read Only	Read Only	Read Only

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L0_R AW	3	-	Indicates that BPE has transitioned into level 0	0: BPE controller is not in level 0 1: BPE controller has transitioned into level 0
BPE_LEVE L_RAW	2	_	Indicates that BPE has transitioned between levels	0: BPE is static 1: BPE level is changing
BPE_ACTIV E_BGN_RA W	1	_	Indicates that the BPE is active	0: BPE is inactive 1: BPE is active
BPE_ACTIV E_END_RA W	0	_	Indicates that the BPE is no longer active	0: BPE is active 1: BPE is inactive

Interrupt State 1 (0x2006)

BIT	7	6	5	4	3	2	1	0	
Field	THERMSH DN_BGN_S TATE	THERMSH DN_END_S TATE	THERMWA RN1_BGN_ STATE	THERMWA RN1_END_ STATE	THERMFB_ BGN_STAT E	THERMFB_ END_STAT E	OTP_FAIL_ STATE	SPK_OVC_ STATE	
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0	
Access Type	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE		
THERMSH DN_BGN_S TATE	7	-	Unmaskable in THERMSHDN	terrupt state, c _BGN_CLR.	leared by	0: No rising ed THERMSHDN THERMSHDN 1: Rising edge THERMSHDN THERMSHDN	o rising edge of RMSHDN_BGN_RAW since last RMSHDN_BGN_CLR ising edge of RMSHDN_BGN_RAW since last RMSHDN_BGN_CLR		
THERMSH DN_END_S TATE	6	-	Unmaskable interrupt state, cleared by THERMSHDN_END_CLR.			0: No rising edge of THERMSHDN_END_RAW since last THERMSHDN_END_CLR 1: Rising edge of THERMSHDN_END_RAW since last THERMSHDN_END_CLR			
THERMWA RN1_BGN_ STATE	5	_	Unmaskable interrupt state, cleared by THERMWARN1_BGN_CLR.			0: No rising ed THERMWARN THERMWARN 1: Rising edge THERMWARN THERMWARN	ge of 1_BGN_RAW 1_BGN_CLR of 1_BGN_RAW 1_BGN_CLR	since last since last	
THERMWA RN1_END_ STATE	4	_	Unmaskable interrupt state, cleared by THERMWARN1_END_CLR.			0: No rising ed THERMWARN THERMWARN 1: Rising edge THERMWARN THERMWARN	ng edge of /ARN1_END_RAW since last /ARN1_END_CLR edge of /ARN1_END_RAW since last /ARN1_END_CLR		
THERMFB_ BGN_STAT E	3	-	Unmaskable interrupt state, cleared by THERMFB_BGN_CLR.			0: No rising ed THERMFB_BC THERMFB_BC 1: Rising edge since last THE	ge of GN_RAW since GN_CLR of THERMFB_ RMFB_BGN_C	last BGN_RAW LR	

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
THERMFB_ END_STAT E	2	_	Unmaskable interrupt state, cleared by THERMFB_END_CLR.	0: No rising edge of THERMFB_END_RAW since last THERMFB_END_CLR 1: Rising edge of THERMFB_END_RAW since last THERMFB_END_CLR
OTP_FAIL_ STATE	1	_	Unmaskable interrupt state, cleared by OTP_FAIL_CLR.	0: No rising edge of OTP_FAIL_RAW since last OTP_FAIL_CLR 1: Rising edge of OTP_FAIL_RAW since last OTP_FAIL_CLR
SPK_OVC_ STATE	0	_	Unmaskable interrupt state, cleared by SPK_OVC_CLR.	0: No rising edge of SPK_OVC_RAW since last SPK_OVC_CLR 1: Rising edge of SPK_OVC_RAW since last SPK_OVC_CLR

Interrupt State 2 (0x2007)

BIT	7	6	5	4	3	2	1	0
Field	THERMWA RN2_BGN_ STATE	THERMWA RN2_END_ STATE	INT_SPKM ON_ERR_S TATE	INT_CLK_E RR_STATE	_	CLK_RECO VER_STAT E	CLK_ERR_ STATE	DMON_ER R_STATE
Reset	0b0	0b0	0b0	0x0	-	0x0	0x0	0b0
Access Type	Read Only	Read Only	Read Only	Read Only	_	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
THERMWA RN2_BGN_ STATE	7	-	Unmaskable in THERMWARN	terrupt state, c 2_BGN_CLR.	leared by	0: No rising ed THERMWARN THERMWARN 1: Rising edge THERMWARN THERMWARN	ge of 2_BGN_RAW 2_BGN_CLR of 2_BGN_RAW 2_BGN_CLR	since last since last
THERMWA RN2_END_ STATE	6	-	Unmaskable interrupt state, cleared by THERMWARN2_END_CLR.			0: No rising ed THERMWARN THERMWARN 1: Rising edge THERMWARN THERMWARN	ge of 2_END_RAW = 2_END_CLR of 2_END_RAW = 2_END_CLR	since last since last
INT_SPKM ON_ERR_S TATE	5	-	Unmaskable interrupt state, cleared by INT_SPKMON_ERR_CLR.			0: No rising ed INT_SPKMON INT_SPKMON 1: Rising edge INT_SPKMON INT_SPKMON	ge of _ERR_RAW si _ERR_CLR of _ERR_RAW si _ERR_CLR	nce last nce last
INT_CLK_E RR_STATE	4	_	Unmaskable interrupt state, cleared by INT_CLK_ERR_CLR.			0: No rising ed since last INT_ 1: Rising edge since last INT_	ge of INT_CLK CLK_ERR_CL of INT_CLK_E CLK_ERR_CL	_ERR_RAW R RR_RAW R
CLK_RECO VER_STAT E	2	_	Unmaskable interrupt state, cleared by CLK_RECOVER_CLR.			0: No rising ed CLK_RECOVE CLK_RECOVE 1: Rising edge since last CLK	ge of R_RAW since R_CLR of CLK_RECO _RECOVER_C	last VER_RAW LR

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
CLK_ERR_ STATE	1	_	Unmaskable interrupt state, cleared by CLK_ERR_CLR.	0: No rising edge of CLK_ERR_RAW since last CLK_ERR_CLR 1: Rising edge of CLK_ERR_RAW since last CLK_ERR_CLR
DMON_ER R_STATE	0	_	Unmaskable interrupt state, cleared by DMON_ERR_CLR.	0: No rising edge of DMON_ERR_RAW since last DMON_ERR_CLR 1: Rising edge of DMON_ERR_RAW since last DMON_ERR_CLR

Interrupt State 3 (0x2008)

BIT	7	6	5	4	3	2 1		0
Field	-	-	PWRUP_D ONE_STAT E	PWRDN_D ONE_STAT E	PVDD_UVL O_SHDN_S TATE	VBAT_UVL O_SHDN_S TATE	DHT_ACTI VE_BGN_S TATE	DHT_ACTI VE_END_S TATE
Reset	-	-	0b0 0b0 0b0		0b0	0b0	0b0	
Access Type	-	-	Read Only Read Only Read Only		Read Only	Read Only	Read Only	
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
PWRUP_D ONE_STAT E	5	_	Unmaskable in PWRUP_DON	iterrupt state, c E_CLR.	leared by	0: No rising edge of PWRUP_DONE_RAW since last PWRUP_DONE_CLR 1: Rising edge of PWRUP_DONE_RAW since last PWRUP_DONE_CLR		
PWRDN_D ONE_STAT E	4	_	Unmaskable in PWRDN_DON	iterrupt state, c E_CLR.	leared by	0: No rising edge of PWRDN_DONE_RAW since last PWRDN_DONE_CLR 1: Rising edge of PWRDN_DONE_RAW since last PWRDN_DONE_CLR		
PVDD_UVL O_SHDN_S TATE	3	_	Unmaskable interrupt state, cleared by PVDD_UVLO_SHDN_CLR.			0: No rising ed PVDD_UVLO_ PVDD_UVLO_ 1: Rising edge PVDD_UVLO_ PVDD_UVLO_	ge of SHDN_RAW s SHDN_CLR of SHDN_RAW s SHDN_CLR	ince last ince last
VBAT_UVL O_SHDN_S TATE	2	-	Unmaskable in VBAT_UVLO_3	terrupt state, c SHDN_CLR.	leared by	0: No rising ed VBAT_UVLO_ VBAT_UVLO_ 1: Rising edge VBAT_UVLO_ VBAT_UVLO_	ge of SHDN_RAW si SHDN_CLR of SHDN_RAW si SHDN_CLR	ince last
DHT_ACTI VE_BGN_S TATE	1	_	Unmaskable interrupt state, cleared by DHT_ACTIVE_BGN_CLR.			0: No rising edge of DHT_ACTIVE_BGN_RAW since last DHT_ACTIVE_BGN_CLR 1: Rising edge of DHT_ACTIVE_BGN_RAW since last DHT_ACTIVE_BGN_CLR		
DHT_ACTI VE_END_S TATE	0	_	Unmaskable in DHT_ACTIVE_	terrupt state, c _END_CLR.	leared by	0: No rising ed DHT_ACTIVE_ DHT_ACTIVE_ 1: Rising edge DHT_ACTIVE_ DHT_ACTIVE_	ge of END_RAW sir END_CLR of END_RAW sir END_CLR	nce last

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Interrupt State 4 (0x2009)

BIT	7	6	5 4 3 2		1	0			
Field	-	-	_	_	BPE_L0_ST ATE	BPE_LEVE L_STATE	BPE_ACTIV E_BGN_ST ATE	BPE_ACTIV E_END_ST ATE	
Reset	-	-	-	-	0x0	0x0	0x0	0x0	
Access Type	_	_	_	_	Read Only	Read Only	Read Only	Read Only	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L0_ST ATE	3	_	Unmaskable in BPE_L0_CLR.	terrupt state, c	leared by	0: No rising edge of BPE_L0_RAW since last BPE_L0_CLR 1: Rising edge of BPE_L0_RAW since last BPE_L0_CLR			
BPE_LEVE L_STATE	2	_	Unmaskable interrupt state, cleared by BPE_LEVEL_CLR.			0: No rising ed since last BPE 1: Rising edge last BPE_LEVE	ge of BPE_LE\ _LEVEL_CLR of BPE_LEVEI EL_CLR	/EL_RAW RAW since	
BPE_ACTIV E_BGN_ST ATE	1	-	Unmaskable in BPE_ACTIVE_	Jnmaskable interrupt state, cleared by BPE_ACTIVE_END_CLR.			0: No rising edge of BPE_ACTIVE_BGN_RAW since last BPE_ACTIVE_BGN_CLR 1: Rising edge of BPE_ACTIVE_BGN_RAW since last BPE_ACTIVE_BGN_CLR		
BPE_ACTIV E_END_ST ATE	0	_	Unmaskable in BPE_ACTIVE_	terrupt state, c END_CLR.	leared by	0: No rising ed BPE_ACTIVE_ BPE_ACTIVE_ 1: Rising edge BPE_ACTIVE_ BPE_ACTIVE	ge of END_RAW sir END_CLR of END_RAW sir END_CLR	nce last nce last	

Interrupt Flag 1 (0x200B)

BIT	7	6	5	4	3	2	1	0
Field	THERMSH DN_BGN_F LAG	THERMSH DN_END_F LAG	THERMWA RN1_BGN_ FLAG	THERMWA RN1_END_ FLAG	THERMFB_ BGN_FLAG	THERMFB_ END_FLAG	OTP_FAIL_ FLAG	SPK_OVC_ FLAG
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	DESCRIPTION DECODE					
THERMSH DN_BGN_F LAG	7	_	Description Decode Thermal shutdown begin event maskable interrupt flag. Masked by 0: No rising edge of THERMSHDN_END_EN and cleared by THERMSHDN_BGN_CLR THERMSHDN_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge. 0: No rising edge of					nce last w high and BGN_RAW N_CLR

BITFIELD	BITS	RES	DESCRIPTION	DECODE
THERMSH DN_END_F LAG	6	_	Thermal shutdown end event maskable interrupt flag. Masked by THERMSHDN_END_EN and cleared by THERMSHDN_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of THERMSHDN_END_RAW since last THERMSHDN_END_CLR or THERMSHDN_END_EN is low 1: THERMSHDN_END_EN is high and rising edge of THERMSHDN_END_RAW since last THERMSHDN_END_CLR
THERMWA RN1_BGN_ FLAG	5	_	Thermal-warning1 begin event maskable interrupt flag. Masked by THERMWARN1_BGN_EN and cleared by THERMWARN1_BGN_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of THERMWARN1_BGN_RAW since last THERMWARN1_BGN_CLR or THERMWARN1_BGN_EN is low 1: THERMWARN1_BGN_EN is high and rising edge of THERMWARN1_BGN_RAW since last THERMWARN1_BGN_CLR
THERMWA RN1_END_ FLAG	4	_	Thermal-warning1 end event maskable interrupt flag. Masked by THERMWARN1_END_EN and cleared by THERMWARN1_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of THERMWARN1_END_RAW since last THERMWARN1_END_CLR or THERMWARN1_END_EN is low 1: THERMWARN1_END_EN is high and rising edge of THERMWARN1_END_RAW since last THERMWARN1_END_CLR
THERMFB_ BGN_FLAG	3	_	Thermal foldback begin event maskable interrupt flag. Masked by THERMFB_BGN_EN and cleared by THERMFB_BGN_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of THERMFB_BGN_RAW since last THERMFB_BGN_CLR or THERMFB_BGN_EN is low 1: THERMFB_BGN_EN is high and rising edge of THERMFB_BGN_RAW since last THERMFB_BGN_CLR
THERMFB_ END_FLAG	2	_	Thermal foldback end event maskable interrupt flag. Masked by THERMFB_END_EN and cleared by THERMFB_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of THERMFB_END_RAW since last THERMFB_END_CLR or THERMFB_END_EN is low 1: THERMFB_END_EN is high and rising edge of THERMFB_END_RAW since last THERMFB_END_CLR
OTP_FAIL_ FLAG	1	_	OTP load routine fail event maskable interrupt flag. Masked by OTP_FAIL_EN and cleared by OTP_FAIL_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of OTP_FAIL_RAW since last OTP_FAIL_CLR or OTP_FAIL_EN is low 1: OTP_FAIL_EN is high and rising edge of OTP_FAIL_RAW since last OTP_FAIL_CLR
SPK_OVC_ FLAG	0	_	Speaker overcurrent event maskable interrupt flag. Masked by SPK_OVC_EN and cleared by SPK_OVC_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of SPK_OVC_RAW since last SPK_OVC_CLR or SPK_OVC_EN is low 1: SPK_OVC_EN is high and rising edge of SPK_OVC_RAW since last SPK_OVC_CLR

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Interrupt Flag 2 (0x200C)

BIT	7	6	5	4	3	2	1	0
Field	THERMWA RN2_BGN_ FLAG	THERMWA RN2_END_ FLAG	INT_SPKM ON_ERR_F LAG	INT_CLK_E RR_FLAG	_	CLK_RECO VER_FLAG	CLK_ERR_ FLAG	DMON_ER R_FLAG
Reset	0b0	0b0	0b0	0x0	-	0x0	0x0	0b0
Access Type	Read Only	Read Only	Read Only Read Only – Read Only Read Only Read Only Read				Read Only	
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERMWA RN2_BGN_ FLAG	7	-	Thermal-warning2 begin event maskable interrupt flag. Masked by THERMWARN2_BGN_EN and cleared by THERMWARN2_BGN_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.					since last or low is high and 2_BGN_RAW GN_CLR
THERMWA RN2_END_ FLAG	6	-	Thermal-warning2 end event maskable interrupt flag. Masked by THERMWARN2_END_EN and cleared by THERMWARN2_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.					since last or low is high and 2_END_RAW ND_CLR
INT_SPKM ON_ERR_F LAG	5	-	Internal speake maskable inter INT_SPKMON INT_SPKMON enabled, an int flag bit rising e	er data monitor rupt flag. Mask _ERR_EN and _ERR_CLR. If terrupt is gener dge.	error event ed by cleared by IRQ is ated on a	0: No rising ed INT_SPKMON INT_SPKMON INT_SPKMON 1: INT_SPKMO edge of INT_S last INT_SPKM	ge of _ERR_RAW si _ERR_CLR or _ERR_EN is lo DN_ERR_EN h PKMON_ERR_ 10N_ERR_CLF	nce last w igh and rising _RAW since R
INT_CLK_E RR_FLAG	4	_	Internal clock r maskable inter INT_CLK_ERF INT_CLK_ERF an interrupt is g rising edge.	nonitor error ev rupt flag. Mask {_EN and clear {_CLR. If IRQ i generated on a	rent ed by ed by s enabled, flag bit	0: No rising ed since last INT_ INT_CLK_ERF 1: INT_CLK_E of INT_CLK_E INT_CLK_ERF	ge of INT_CLK CLK_ERR_CL LEN is low RR_EN high ar RR_RAW since CLR	_ERR_RAW R or nd rising edge e last
CLK_RECO VER_FLAG	2	-	PCM input clock error recovery event maskable interrupt flag. Masked by CLK_RECOVER_EN and cleared by CLK_RECOVER_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge. 0: No rising edge of CLK_RECOVER_RAW since last CLK_RECOVER_EN is low 1: BCLK_RECOVER_EN is low 1: BCLK_RECOVER_EN high and edge of BCLK_RECOVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_EN high and edge of BCLK_RECOVER_COVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_EN high and edge of BCLK_RECOVER_COVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_EN high and edge of BCLK_RECOVER_COVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_EN high and edge of BCLK_RECOVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_EN high and edge of BCLK_RECOVER_COVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_COVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_RAW since last CLK_RECOVER_RAW since last CLK_RECOVER_EN high and edge of BCLK_RECOVER_RAW since last CLK_RECOVER_RAW since l				last n and rising AW since last	
CLK_ERR_ FLAG	1	-	PCM input cloc interrupt flag. M and cleared by enabled, an int flag bit rising e	ck error event n Masked by CLK CLK_ERR_CL terrupt is gener dge.	naskable _ERR_EN .R. If IRQ is ated on a	0: No rising ed last CLK_ERR low 1: CLK_ERR_E CLK_ERR_RA CLK_ERR_CL	ge of CLK_ERI _CLR or CLK_I EN high and ris W since last R	R_RAW since ERR_EN is ing edge of

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DMON_ER R_FLAG	0	_	PCM data input error event maskable interrupt flag. Masked by DMON_ERR_EN and cleared by DMON_ERR_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of DMON_ERR_RAW since last DMON_ERR_CLR or DMON_ERR_EN is low 1: DMON_ERR_EN high and rising edge of DMON_ERR_RAW since last DMON_ERR_CLR

Interrupt Flag 3 (0x200D)

BIT	7	6	5	4	3	2	1	0
Field	-	-	PWRUP_D ONE_FLAGPWRDN_D ONE_FLAGPVDD_UVL O_SHDN_F LAG		VBAT_UVL O_SHDN_F LAG	DHT_ACTI VE_BGN_F LAG	DHT_ACTI VE_END_F LAG	
Reset	-	-	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	_	-	Read Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
PWRUP_D ONE_FLAG	5	_	Device power-up done event maskable interrupt flag. Masked by PWRUP_DONE_EN and cleared by PWRUP_DONE_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.			ge of PWRUP_ RUP_DONE_CI E_EN is low DNE_EN is higt IP_DONE_RAV E_CLR	DONE_RAW _R or n and rising V since last	
PWRDN_D ONE_FLAG	4	-	Device power-down done event maskable interrupt flag. Masked by PWRDN_DONE_EN and cleared by PWRDN_DONE_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.			0: No rising ed since last PWF PWRDN_DON 1: PWRDN_DO edge of PWRD PWRDN_DON	ge of PWRDN_ RDN_DONE_CI E_EN is low DNE_EN is higt N_DONE_RA\ E_CLR	DONE_RAW LR or n and rising N since last
PVDD_UVL O_SHDN_F LAG	3	_	PVDD supply UVLO event maskable interrupt flag. Masked by PVDD_UVLO_SHDN_EN and cleared by PVDD_UVLO_SHDN_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.			0: No rising ed PVDD_UVLO_ PVDD_UVLO_ PVDD_UVLO_ 1: PVDD_UVLO rising edge of F since last PVD	ge of SHDN_RAW s SHDN_CLR or SHDN_EN is lo O_SHDN_EN i PVDD_UVLO_S D_UVLO_SHD	ince last ow s high and SHDN_RAW N_CLR
VBAT_UVL O_SHDN_F LAG	2	-	VBAT supply UVLO event maskable interrupt flag. Masked by VBAT_UVLO_SHDN_EN and cleared by VBAT_UVLO_SHDN_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.			0: No rising edge of VBAT_UVLO_SHDN_RAW since last VBAT_UVLO_SHDN_CLR or VBAT_UVLO_SHDN_EN is low 1: VBAT_UVLO_SHDN_EN is high and rising edge of VBAT_UVLO_SHDN_RAW since last VBAT_UVLO_SHDN_CLR		
DHT_ACTI VE_BGN_F LAG	1	_	Integration of the sector o				nce last w high and BGN_RAW J_CLR	

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_ACTI VE_END_F LAG	0	_	DHT active end event maskable interrupt flag. Masked by DHT_ACTIVE_END_EN and cleared by DHT_ACTIVE_END_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.	0: No rising edge of DHT_ACTIVE_END_RAW since last DHT_ACTIVE_END_CLR or DHT_ACTIVE_END_EN is low 1: DHT_ACTIVE_END_EN is high and rising edge of DHT_ACTIVE_END_RAW since last DHT_ACTIVE_END_CLR

Interrupt Flag 4 (0x200E)

BIT	7	6	5	4	3	2	1	0
Field	-	-	_	_	BPE_L0_FL AG	BPE_LEVE L_FLAG	BPE_ACTIV E_BGN_FL AG	BPE_ACTIV E_END_FL AG
Reset	-	-	-	-	0x0	0x0	0x0	0x0
Access Type	-	-	-	_	Read Only	Read Only	Read Only	Read Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
BPE_L0_FL AG	3	_	Brownout-prevention engine level 0 entry event maskable interrupt flag. Masked by BPE_L0_EN and cleared by BPE_L0_CLR. If IRQ is enabled, an interrupt is generated on a flag bit rising edge.					RAW since EN is low g edge of L0_CLR
BPE_LEVE L_FLAG	2	-	Brownout-prev maskable inter BPE_LEVEL_E BPE_LEVEL_C interrupt is gen edge.	ention engine l rupt flag. Mask EN and cleared CLR. If IRQ is e erated on a fla	evel change ed by by enabled, an g bit rising	0: No rising ed since last BPE BPE_LEVEL_E 1: BPE_LEVEL BPE_LEVEL_E BPE_LEVEL_C	ge of BPE_LE\ _LEVEL_CLR (EN is low EN high and RAW since last CLR	/EL_RAW or rising edge of
BPE_ACTIV E_BGN_FL AG	1	_	Brownout-prev maskable inter BPE_ACTIVE_ BPE_ACTIVE_ enabled, an int flag bit rising e	ention engine a rupt flag. Mask _BGN_EN and _BGN_CLR. If I errupt is gener dge.	active end ed by cleared by RQ is ated on a	0: No rising ed BPE_ACTIVE_ BPE_ACTIVE_ BPE_ACTIVE_ 1: BPE_ACTIV edge of BPE_A last BPE_ACT	ge of _BGN_RAW sir _BGN_CLR or _BGN_EN is lov E_BGN_EN hi ACTIVE_BGN_ VE_BGN_CLR	nce last w gh and rising RAW since
BPE_ACTIV E_END_FL AG	0	-	flag bit rising edge. Iast BPE_ACTIVE_BGN_CLR Brownout-prevention engine active end 0: No rising edge of maskable interrupt flag. Masked by BPE_ACTIVE_END_EN and cleared by BPE_ACTIVE_END_CLR. If IRQ is BPE_ACTIVE_END_EN is low enabled, an interrupt is generated on a 1: BPE_ACTIVE_END_EN hic flag bit rising edge. 0: No rising edge of					nce last w gh and rising RAW since

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Interrupt Enable 1 (0x2010)

BIT	7	6	5	4	3	2	1	0	
Field	THERMSH DN_BGN_E N	THERMSH DN_END_E N	THERMWA RN1_BGN_ EN	THERMWA RN1_END_ EN	THERMFB_ BGN_EN	THERMFB_ END_EN	OTP_FAIL_ EN	SPK_OVC_ EN	
Reset	0b0	0b0	0b0	0b0 0b0 0b0		0b0	0b1	0b0	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
THERMSH DN_BGN_E N	7	_	Enable (unmask) control for THERMSHDN_BGN_FLAG.			0: THERMSHDN_BGN_FLAG cannot go high 1: THERMSHDN_BGN_FLAG goes high if there is a rising edge on THERMSHDN_BGN_RAW since last THERMSHDN_BGN_CLR.			
THERMSH DN_END_E N	6	_	Enable (unmas THERMSHDN	sk) control for _END_FLAG.		 0: THERMSHDN_END_FLAG cannot go high 1: THERMSHDN_END_FLAG goes high if there is a rising edge on THERMSHDN_END_RAW since last THERMSHDN_END_CLR. 			
THERMWA RN1_BGN_ EN	5	_	Enable (unmas THERMWARN	sk) control for 1_BGN_FLAG		0: THERMWAF high 1: THERMWAF if there is a risi THERMWARN THERMWARN	RN1_BGN_FLA RN1_BGN_FLA ng edge on 1_BGN_RAW 1_BGN_CLR.	AG cannot go AG goes high since last	
THERMWA RN1_END_ EN	4	_	Enable (unmas THERMWARN	sk) control for 1_END_FLAG		0: THERMWAF high 1: THERMWAF if there is a risi THERMWARN THERMWARN	RN1_END_FLA RN1_END_FLA ng edge on 1_END_RAW 1_END_CLR.	AG cannot go AG goes high since last	
THERMFB_ BGN_EN	3	-	Enable (unmas THERMFB_BG	sk) control for SN_FLAG.		0: THERMFB_ 1: THERMFB_ there is a rising THERMFB_BG THERMFB_BG	BGN_FLAG ca BGN_FLAG go g edge on GN_RAW since GN_CLR.	nnot go high bes high if last	
THERMFB_ END_EN	2	-	Enable (unmask) control for THERMFB_END_FLAG.			0: THERMFB_ 1: THERMFB_ there is a rising THERMFB_EN THERMFB_EN	END_FLAG ca END_FLAG gc g edge on ID_RAW since ID_CLR.	nnot go high bes high if last	
OTP_FAIL_ EN	1	-	Enable (unmas OTP_FAIL_FL	Enable (unmask) control for OTP_FAIL_FLAG.			FLAG cannot g FLAG goes hig OTP_FAIL_RA R.	o high h if there is a W since last	
SPK_OVC_ EN	0	_	Enable (unmask) control for 0: SPK_OVC_FLAG cannot go high SPK_OVC_FLAG. 1: SPK_OVC_FLAG goes high if the rising edge on SPK_OVC_RAW sin SPK_OVC_C_CLR SPK_OVC_C_CLR			o high h if there is a W since last			

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Interrupt Enable 2 (0x2011)

BIT	7	6	5	4	3	2	1	0	
Field	THERMWA RN2_BGN_ EN	THERMWA RN2_END_ EN	INT_SPKM ON_ERR_E N	INT_CLK_E RR_EN	_	CLK_RECO VER_EN	CLK_ERR_ EN	DMON_ER R_EN	
Reset	0b0	0b0	0b0	0x0	_	0x0	0x0	0b0	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	_	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
THERMWA RN2_BGN_ EN	7	_	Enable (unmask) control for THERMWARN2_BGN_FLAG.			0: THERMWARN2_BGN_FLAG cannot go high 1: THERMWARN2_BGN_FLAG goes high if there is a rising edge on THERMWARN2_BGN_RAW since last THERMWARN2_BGN_CLR.			
THERMWA RN2_END_ EN	6	_	Enable (unmas THERMWARN	sk) control for l2_END_FLAG		0: THERMWARN2_END_FLAG cannot go high 1: THERMWARN2_END_FLAG goes high if there is a rising edge on THERMWARN2_END_RAW since last THERMWARN2_END_CLR.			
INT_SPKM ON_ERR_E N	5	_	Enable (unmas INT_SPKMON	sk) control for _ERR_FLAG.		0: INT_SPKMC high 1: INT_SPKMC there is a rising INT_SPKMON INT_SPKMON	DN_ERR_FLAC DN_ERR_FLAC gedge on _ERR_RAW si _ERR_CLR.	G cannot go G goes high if nce last	
INT_CLK_E RR_EN	4	_	Enable (unmas INT_CLK_ERF	sk) control for R_FLAG.		0: INT_CLK_ERR_FLAG cannot go high 1: INT_CLK_ERR_FLAG goes high if there is a rising edge on INT_CLK_ERR_RAW since last INT_CLK_ERR_CLR.			
CLK_RECO VER_EN	2	_	Enable (unmas CLK_RECOVE	sk) control for ER_FLAG.		0: CLK_RECO 1: CLK_RECO there is a rising CLK_RECOVE CLK_RECOVE	VER_FLAG ca VER_FLAG go g edge on R_RAW since R_CLR.	nnot go high es high if last	
CLK_ERR_ EN	1	-	Enable (unmask) control for 0: CLK_ERR_FLAG can CLK_ERR_FLAG. 1: CLK_ERR_FLAG goes rising edge on CLK_ERR CLK_ERR_CLR.				FLAG cannot g FLAG goes hig CLK_ERR_RA R.	o high h if there is a W since last	
DMON_ER R_EN	0	-	Enable (unmas DMON_ERR_I	sk) control for FLAG.		0: DMON_ERF 1: DMON_ERF a rising edge o last DMON_EF	R_FLAG canno R_FLAG goes h n DMON_ERR R CLR.	t go high high if there is _RAW since	

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Interrupt Enable 3 (0x2012)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	PWRUP_D ONE_EN	PWRDN_D ONE_EN	PVDD_UVL O_SHDN_E N	VBAT_UVL O_SHDN_E N	DHT_ACTI VE_BGN_E N	DHT_ACTI VE_END_E N	
Reset	_	-	0b0	0b0	0b0	0b0	0b0	0b0	
Access Type	-	-	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
PWRUP_D ONE_EN	5	_	Enable (unmask) control for PWRUP_DONE_FLAG. 0: PWRUP_DONE_FLAG g there is a rising edge on PWRUP_DONE_RAW since PWRUP_DONE_CLR.			DNE_FLAG car DNE_FLAG goe g edge on E_RAW since l E_CLR.	nnot go high es high if last		
PWRDN_D ONE_EN	4	_	Enable (unmas PWRDN_DON	inable (unmask) control for			0: PWRDN_DONE_FLAG cannot go high 1: PWRDN_DONE_FLAG goes high if there is a rising edge on PWRDN_DONE_RAW since last PWRDN_DONE_CLR.		
PVDD_UVL O_SHDN_E N	3	-	Enable (unmask) control for PVDD_UVLO_SHDN_FLAG.			0: PVDD_UVL high 1: PVDD_UVL there is a rising PVDD_UVLO_ PVDD_UVLO_	D_SHDN_FLA D_SHDN_FLA gedge on SHDN_RAW s SHDN_CLR.	G cannot go G goes high if ince last	
VBAT_UVL O_SHDN_E N	2	-	Enable (unmas VBAT_UVLO_3	sk) control for SHDN_FLAG.		0: VBAT_UVLC high 1: VBAT_UVLC there is a rising VBAT_UVLO_ VBAT_UVLO_	D_SHDN_FLAC D_SHDN_FLAC g edge on SHDN_RAW si SHDN_CLR.	G cannot go G goes high if ince last	
DHT_ACTI VE_BGN_E N	1	_	Enable (unmask) control for DHT_ACTIVE_BGN_FLAG.			0: DHT_ACTIV high 1: DHT_ACTIV there is a rising DHT_ACTIVE_ DHT_ACTIVE_	E_BGN_FLAG E_BGN_FLAG edge on BGN_RAW sir BGN_CLR.	a cannot go a goes high if nce last	
DHT_ACTI VE_END_E N	0	-	Enable (unmas DHT_ACTIVE_	DHT_ACTIVE_BGN_CLR. 0: DHT_ACTIVE_END_FLAG (high 1: DHT_ACTIVE_END_FLAG (DHT_ACTIVE_END_FLAG. DHT_ACTIVE_END_FLAG. DHT_ACTIVE_END_RAW sinc DHT_ACTIVE_END_CLR				cannot go goes high if nce last	
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Interrupt Enable 4 (0x2013)

BIT	7	6	5	4	3	2	1	0
Field	_	-			BPE_L0_E N	BPE_LEVE L_EN	BPE_ACTIV E_BGN_EN	BPE_ACTIV E_END_EN
Reset	-	-	-	_	0x0	0x0	0x0	0x0
Access Type	-	-	-	-	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
BPE_L0_E N	3	_	Enable (unmask) control for BPE_L0_FLAG.			0: BPE_L0_FLAG cannot go high 1: BPE_L0_FLAG goes high if there is a rising edge on BPE_L0_RAW since last BPE_L0_CLR.		
BPE_LEVE L_EN	2	_	Enable (unmask) control for BPE_LEVEL_FLAG.			0: BPE_LEVEL_FLAG cannot go high 1: BPE_LEVEL_FLAG goes high if there is a rising edge on BPE_LEVEL_RAW since last BPE_LEVEL_CLR.		
BPE_ACTIV E_BGN_EN	1	_	Enable (unmask) control for BPE_ACTIVE_BGN_FLAG.			0: BPE_ACTIV high 1: BPE_ACTIV there is a rising BPE_ACTIVE_ BPE_ACTIVE_	E_BGN_FLAG E_BGN_FLAG dege on BGN_RAW sir BGN_CLR.	cannot go goes high if nce last
BPE_ACTIV E_END_EN	0	-	Enable (unmask) control for BPE_ACTIVE_END_FLAG.			0: BPE_ACTIV high 1: BPE_ACTIV there is a rising BPE_ACTIVE_ BPE_ACTIVE_	E_END_FLAG E_END_FLAG dge on END_RAW sir END_CLR.	cannot go goes high if nce last

Interrupt Flag Clear 1 (0x2015)

BIT	7	6	5	4	3	2	1	0
Field	THERMSH DN_BGN_C LR	THERMSH DN_END_C LR	THERMWA RN1_BGN_ CLR	THERMWA RN1_END_ CLR	THERMFB_ BGN_CLR	THERMFB_ END_CLR	OTP_FAIL_ CLR	SPK_OVC_ CLR
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	Write Only	Write Only	Write Only	Write Only	Write Only	Write Only	Write Only	Write Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERMSH DN_BGN_C LR	7	-	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one THERMSHDN THERMSHDN	has no effect clears _BGN_STATE _BGN_FLAG to	and o zero
THERMSH DN_END_C LR	6	-	Clears associated FLAG and STATE bits.			0: Writing zero 1: Writing one THERMSHDN THERMSHDN	has no effect clears _END_STATE _END_FLAG to	and o zero

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
THERMWA RN1_BGN_ CLR	5	_	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears THERMWARN1_BGN_STATE and THERMWARN1_BGN_FLAG to zero
THERMWA RN1_END_ CLR	4	-	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears THERMWARN1_END_STATE and THERMWARN1_END_FLAG to zero
THERMFB_ BGN_CLR	3	_	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears THERMFB_BGN_STATE and THERMFB_BGN_FLAG to zero
THERMFB_ END_CLR	2	_	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears THERMFB_END_STATE and THERMFB_END_FLAG to zero
OTP_FAIL_ CLR	1	-	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears OTP_FAIL_STATE and OTP_FAIL_FLAG to zero
SPK_OVC_ CLR	0	_	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears SPK_OVC_STATE and SPK_OVC_FLAG to zero

Interrupt Flag Clear 2 (0x2016)

BIT	7	6	5	4	3	2	1	0
Field	THERMWA RN2_BGN_ CLR	THERMWA RN2_END_ CLR	INT_SPKM ON_ERR_C LR RR_CLR -			CLK_RECO VER_CLR	CLK_ERR_ CLR	DMON_ER R_CLR
Reset	0b0	0b0	0b0	0x0	-	0x0	0x0	0b0
Access Type	Write Only	Write Only	Write Only	Write Only	_	Write Only	Write Only	Write Only
BITFIELD	BITS	RES	D	DESCRIPTION			DECODE	
THERMWA RN2_BGN_ CLR	7	_	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one THERMWARN THERMWARN	has no effect clears 2_BGN_STAT 2_BGN_FLAG	E and to zero
THERMWA RN2_END_ CLR	6	_	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one THERMWARN THERMWARN	has no effect clears 2_END_STAT 2_END_FLAG	E and to zero
INT_SPKM ON_ERR_C LR	5	-	Clears associa	Clears associated FLAG and STATE bits.			has no effect clears _ERR_STATE _ERR_FLAG to	and o zero
INT_CLK_E RR_CLR	4	_	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one INT_CLK_ERF INT_CLK_ERF	has no effect clears R_STATE and R_FLAG to zero)

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
CLK_RECO VER_CLR	2	_	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears CLK_RECOVER_STATE and CLK_RECOVER_FLAG to zero
CLK_ERR_ CLR	1	-	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears CLK_ERR_STATE and CLK_ERR_FLAG to zero
DMON_ER R_CLR	0	-	Clears associated FLAG and STATE bits.	0: Writing zero has no effect 1: Writing one clears DMON_ERR_STATE and DMON_ERR_FLAG to zero

Interrupt Flag Clear 3 (0x2017)

BIT	7	6	5	4	3	2	1	0
Field	-	-	PWRUP_D ONE_CLR	PWRDN_D ONE_CLR	PVDD_UVL O_SHDN_C LR	VBAT_UVL O_SHDN_C LR	DHT_ACTI VE_BGN_C LR	DHT_ACTI VE_END_C LR
Reset	-	-	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	-	-	Write Only	Write Only	Write Only	Write Only	Write Only	Write Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
PWRUP_D ONE_CLR	5	-	Clears associa	ted FLAG and	STATE bits.	0: Writing zero has no effect 1: Writing one clears PWRUP_DONE_STATE and PWRUP_DONE_FLAG to zero		
PWRDN_D ONE_CLR	4	-	Clears associa	Clears associated FLAG and STATE bits.			has no effect clears E_STATE and E_FLAG to zer	·0
PVDD_UVL O_SHDN_C LR	3	_	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one PVDD_UVLO_ PVDD_UVLO_	has no effect clears SHDN_STATE SHDN_FLAG	and to zero
VBAT_UVL O_SHDN_C LR	2	-	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one VBAT_UVLO_ VBAT_UVLO_	has no effect clears SHDN_STATE SHDN_FLAG t	and o zero
DHT_ACTI VE_BGN_C LR	1	_	Clears associated FLAG and STATE bits.			0: Writing zero 1: Writing one DHT_ACTIVE_ DHT_ACTIVE	has no effect clears _BGN_STATE _BGN_FLAG to	and o zero
DHT_ACTI VE_END_C LR	0	_	Clears associa	Clears associated FLAG and STATE bits. Clears associated FLAG and STATE bits. DHT_ACTIVE_EN DHT_ACTIVE_EN DHT_ACTIVE EN				and o zero

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Interrupt Flag Clear 4 (0x2018)

BIT	7	6	5 4 3		2	1	0	
Field	-	-	_	-	BPE_L0_CL R	BPE_LEVE L_CLR	BPE_ACTIV E_BGN_CL R	BPE_ACTIV E_END_CL R
Reset	-	-	-	-	0x0	0x0	0x0	0x0
Access Type	_	-	_	_	Write Only	Write Only	Write Only	Write Only
BITFIELD	BITS	RES	DESCRIPTION			DECODE		
BPE_L0_CL R	3	-	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one BPE_L0_FLAC	has no effect clears BPE_L0 6 to zero	_STATE and
BPE_LEVE L_CLR	2	-	Clears associa	ted FLAG and	STATE bits.	0: Writing zero 1: Writing one and BPE_LEV	has no effect clears BPE_LE EL_FLAG to ze	VEL_STATE
BPE_ACTIV E_BGN_CL R	1	-	Clears associa	Clears associated FLAG and STATE bits.			has no effect clears _BGN_STATE _BGN_FLAG to	and o zero
BPE_ACTIV E_END_CL R	0	_	Clears associated FLAG and STATE bits. 0: Writing zero has no effect 1: Writing one clears BPE_ACTIVE_END_STATE a BPE_ACTIVE_END_FLAG to				and zero	

IRQ Control (0x201F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	IRQ_MODE	IRQ_POL	IRQ_EN
Reset	-	-	-	-	-	0b0	0b0	0b0
Access Type	-	_			Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	DESCRIPTION			DECODE		
IRQ_MODE	2	IRQ	Controls the dr output.	Controls the drive mode of the IRQ output.			output (an exte ired) -pull output	rnal pullup
IRQ_POL	1	IRQ	Controls the IR	Controls the IRQ output assert polarity.			s low when any high (i.e., active s high when an high (i.e.,active	/ interrupt e-low) y interrupt i-high)
IRQ_EN	0	_	Enables the IRQ Output.			0: IRQ output is 1: IRQ output is the interrupt co	s disabled and s enabled and ontroller	is Hi-Z controlled by

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Thermal Warning Threshhold (0x2020)

BIT	7	6	5	4	3	2	1	0			
Field	-		THERMWARN1_THRESH[6:0]								
Reset	-				0x46						
Access Type	_		Write, Read								
BITFIELD	BITS	RES	ES DESCRIPTION DECODE								
THERMWA RN1_THRE SH	6:0	EN	Sets the first thermal-warning threshold temperature. 0x00: 50°C 0x01: 51°C 0x02: 52°C 0x62: 148°C 0x63: 149°C 0x63: 149°C 0x63: 149°C								

Warning Threshold 2 (0x2021)

BIT	7	6	5	4	3	2	1	0		
Field	-			THERM	WARN2_THR	ESH[6:0]				
Reset	-				0x46					
Access Type	_		Write, Read							
BITFIELD	BITS	RES	RES DESCRIPTION DECODE							
THERMWA RN2_THRE SH	6:0	EN	Sets the second thermal-warning threshold temperature. 0x00: 50°C (0x01: 51°C (0x02: 52°C (0							

Thermal Shutdown Threshold (0x2022)

BIT	7	6	5	4	3	2	1	0				
Field	-		THERMSHDN_THRESH[6:0]									
Reset	-				0x64							
Access Type	_		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE					
THERMSH DN_THRES H	6:0	EN	Sets the therm temperature.	al-shutdown th	reshold	0x00: 50°C 0x01: 51°C 0x02: 52°C 0x30: 98°C 0x31: 99°C 0x64 to 0x7F: 150°C						

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Thermal Hysteresis (0x2023)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	THERM_I	HYST[1:0]
Reset	-	-	-	-	-	-	0:	x2
Access Type	_	-	-	-	-	-	Write,	Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERM_HY ST	1:0	EN	Controls the amount of hysteresis applied to the thermal threshold measurements. 0x0: 2°C 0x1: 5°C 0x2: 7°C 0x3: 10°C					

Thermal Foldback Settings (0x2024)

BIT	7	6	5	4	3	2	1	0
Field	THERMFE	B_HOLD[1:0]	THERMFE	THERMFB_RLS[1:0]		SLOPE2[1:0]	THERMFB_	SLOPE1[1:0]
Reset	C)x3	0>	0x0		0x1		x1
Access Type	Write	e, Read	Write, Read		Write	e, Read	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
THERMFB_ HOLD	7:6	TFB	The thermal fol how long the d remain below t threshold hyste foldback releas	dback hold tim evice temperat he configured t eresis before th se begins.	e controls ure must hermal ermal	0x0: 0ms 0x1: 20ms 0x2: 40ms 0x3: 80ms		
THERMFB_ RLS	5:4	TFB	This sets the release rate of the thermal foldback attenuation.			0x0: 3ms/dB 0x1: 10ms/dB 0x2: 100ms/dB 0x3: 300ms/dB		
THERMFB_ SLOPE2	3:2	TFB	This sets the sl foldback attenu temperature ex THERMWARN	This sets the slope of the thermal foldback attenuation when die temperature exceeds THERMWARN2_THRESH.				
THERMFB_ SLOPE1	1:0	TFB	This sets the sl foldback attenu temperature ex threshold (THE but is lower tha threshold (THE	lope of the ther lation when die cceeds thermal RMWARN1_T In thermal-warr RMWARN2_T	mal -warning1 HRESH) hing2 HRESH).	0x0: 0.25dB/°C 0x1: 0.5dB/°C 0x2: 1.0dB/°C 0x3: 2.0dB/°C		

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Thermal Foldback Enable (0x2027)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	_	_	-	THERMFB_ EN
Reset	-	-	-	-	-	-	-	0b1
Access Type	_	-	-	-	_	_	-	Write, Read
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
THERMFB_ EN	0	_	Enables Thermal Foldback.			0: Thermal fold 1: Thermal fold	lback disabled lback enabled	

Noise Gate/Idle Mode Control (0x2030)

BIT	7	6	5	4	3	2	1	0	
Field		UNMUTE_	THRESH[3:0]			MUTE_THRESH[3:0]			
Reset		(0x3			0:	x2		
Access Type		Write	e, Read		Write, Read				
BITFIELD	BITS	RES	D		DECODE				
UNMUTE_T HRESH	7:4	NG	Sets the thresh toggling) at wh mode deactiva	nold (number of lich the noise g ltes.	f LSBs ate/idle	0x0: 1 LSB 0x1: 2 LSBs 0x2: 3 LSBs 0x3: 4 LSBs 0x4: 5 LSBs 0x5: 6 LSBs 0x6: 7 LSBs 0x7: 8 LSBs 0x8: 9 LSBs 0x9: 10 LSBs 0xA to 0xF: Reserved			
MUTE_THR ESH	3:0	NG	Sets the thresh toggling) at wh mode is activa	nold (number of nich the noise g ted.	f LSBs ate/Idle	0x0: 1 LSB 0x1: 2 LSBs 0x2: 3 LSBs 0x3: 4 LSBs 0x4: 5 LSBs 0x5: 6 LSBs 0x6: 7 LSBs 0x7: 8 LSBs 0x8: 9 LSBs 0x9: 10 LSBs 0xA to 0xF: Re	eserved		

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Noise Gate/Idle Mode Enables (0x2033)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	_	-	-	NOISEGAT E_EN
Reset	-	-	-	-	-	-	-	0x0
Access Type	-	-	-	_	_	-	_	Write, Read
BITFIELD	BITS	RES	D	DESCRIPTION			DECODE	
NOISEGAT E_EN	0	-	Enables the noise gate.			0: Noise gate o 1: Noise gate e	lisabled enabled	

Clock Monitor Control (0x2038)

BIT	7	6	5	4	3	2	1	0
Field	-	CM	ION_BSELTOL	[2:0]	CN	ION_ERRTOL[CMON_AU TORESTAR T_EN	
Reset	-		0b0			0x0		0x0
Access Type	-		Write, Read			Write, Read		
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
CMON_BS ELTOL	6:4	EN	The number of correct clock ra needed to trigg framing error.	frames of inco atio (BCLKs per jer or recover fr	rrect or ⁻ LRCLK) rom a	0x0: Trigger af frame, recover frame 0x1: Trigger af frames, recover frames 0x2: Trigger af frames, recover frame 0x3: Trigger af frames, recover frames 0x4: Trigger af frames, recover frames 0x5: Trigger af frames, recover frames 0x6: Trigger af frames, recover frames 0x7: Trigger af frames, recover frames	ter 1 incorrect I after 1 correct I after 1 correct ter 2 incorrect I r after 16 correct ter 3 incorrect I r after 24 correct ter 4 incorrect I r after 32 correct ter 5 incorrect I r after 40 correct ter 6 incorrect I r after 48 correct ter 7 incorrect I r after 56 correct ter 8 incorrect I r after 64 correct	-RCLK -RCLK -CLRCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK -RCLK

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
CMON_ER RTOL	3:1	EN	Selects the number of incorrect or correct LRCLK periods needed to trigger or recover from a frame clock rate error.	0x0: Trigger after 1 incorrect LRCLK frame, recover after 1 correct LRCLK frame 0x1: Trigger after 2 incorrect LRCLK frames, recover after 16 correct LRCLK frames 0x2: Trigger after 3 incorrect LRCLK frames, recover after 24 correct LRCLK frames, recover after 24 correct LRCLK frames 0x3: Trigger after 4 incorrect LRCLK frames, recover after 32 correct LRCLK frames, recover after 32 correct LRCLK frames, recover after 40 correct LRCLK frames, recover after 40 correct LRCLK frames, recover after 40 correct LRCLK frames, recover after 48 correct LRCLK frames, recover after 48 correct LRCLK frames, recover after 7 incorrect LRCLK frames, recover after 56 correct LRCLK frames, recover after 64 correct LRCLK frames, recover after 64 correct LRCLK frames
CMON_AU TORESTAR T_EN	0	EN	Controls whether or not the device automatically resumes playback when the clocks become valid after the device is disabled due to a clock monitor error.	 Device does not automatically restart after valid clocks are reapplied. Device automatically restarts after valid clocks are reapplied.

Data Monitor Control (0x2039)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	DMON_MAG	_THRES[1:0]	DMON_STU	ICK_THRES[1 :0]	DMON_DUF	DMON_DURATION[1:0]	
Reset	-	-	0:	x0	()x0	0)	x0	
Access Type	_	-	Write,	Read	Write	e, Read Write, Read		Read	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
DMON_MA G_THRES	5:4	EN	Sets the data magnitude error threshold that the input PCM amplitude level is compared against. If the input signal is above this threshold for longer than the DMON_DURATION, data monitor error is asserted			0x0: -30.1030d 0x1: -24.0824d 0x2: -18.0618d 0x3: -12.0412d	B (5-bits) B (4-bits) B (3-bits) B (2-bits)		
DMON_ST UCK_THRE S	3:2	EN	Sets the data stuck error threshold that the input PCM amplitude level is compared against. If the input signal is stuck at the same value above this threshold for longer than the DMON_DURATION, data monitor error is asserted.			0x0: 15-bits (-9 0x1: 13-bits (-7 0x2: 11-bits (-6 0x3: 9-bits (-54	0.3090dBFS) 8.2678dBFS) 6.2266dBFS) .1854dBFS)		

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DMON_DU RATION	1:0	EN	Sets the time duration over which the Data Monitor must consecutively detect erroneous input PCM data before asserting a data monitor error.	0x0: 64ms 0x1: 256ms 0x2: 1024ms 0x3: 4096ms

Speaker Monitor Threshold (0x203A)

BIT	7	6	5	4	3	2	1	0				
Field		SPKMON_THRESH[7:0]										
Reset				0d	58							
Access Type		Write, Read										
BITFIELD	BITS	BITS RES DESCRIPTION DECODE										
SPKMON_T HRESH	7:0	_	Sets the speak signal power re above this thre DMON_DURA error is asserte as % of f _S . Full voltage hit the The voltage thit from the registe following equat Threshold (vo (SPKMON_TH Class-D Supp	er power thres ecovered by the shold for longe TION, speaker ed. Threshold is -scale means t rails. reshold can be er setting using tion: oltage) = IRESH/160) x / Iy Voltage	hold. If the e circuit is r than the monitor s calculated he output calculated the	Threshold = (S	PKMON_THR	ESH*2)/320				

Speaker Monitor Duration (0x203B)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	SPKMON_DURATION[3:0]			
Reset	-	-	-	-	0x2			
Access Type	-	-	-	_	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
SPKMON_ DURATION	3:0	_	Sets the time duration over which the speaker monitor must consecutively detect power above threshold before asserting a speaker monitor error.	Value: Decode 0x0: 10ms 0x1: 25ms 0x2: 50ms 0x3: 75ms 0x4: 100ms 0x5: 200ms 0x6: 300ms 0x7: 400ms 0x8: 500ms 0x8: 500ms 0x9: 600ms 0xA: 700ms 0xB: 800ms 0xC: 900ms 0xC: 900ms 0xC: 1100ms 0xF: 1200ms

Enable Controls (0x203F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	_	_	SPKMON_ EN	DMON_MA G_EN	DMON_ST UCK_EN	CMON_EN
Reset	-	-	-	-	0x1	0x1	0x1	0x1
Access Type	_	_	_	– – Write, Read		Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
SPKMON_ EN	3	ENL	Enables the internal speaker protection monitor			0x0: Disable in 0x1: Enable inf	ternal speaker ternal speaker	data monitor data monitor
DMON_MA G_EN	2	ENL	Enables the da monitor PCM in magnitude (DC	ta monitor circ nput data for la c) audio	uit to rge	0: Data magnit 1: Data magnit	ude check disa ude check ena	bled bled
DMON_ST UCK_EN	1	ENL	Enables the data monitor circuit to monitor PCM input for stuck data.			0: Data Stuck-/ 1: Data Stuck-/	AT monitor disa AT monitor ena	abled bled
CMON_EN	0	ENL	Enables the clo PCM input cloc	ock monitor to r cks for clock er	nonitor rors.	0: Clock monito 1: Clock monito	or disabled or enabled	

Pin Config (0x2040)

BIT	7	6	5	4	3	2	1	0
Field	LV_EN_DRV[1:0]		ICC_D	ICC_DRV[1:0]		IRQ_DRV[1:0]		DRV[1:0]
Reset	0)x1	0:	x1	0x1		0x1	
Access Type	Write	e, Read	Write, Read V		Write, Read		Write, Read	
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
LV_EN_DR V	7:6	-	Configures the output drive strength of LV_EN pin.			0x0: Reduced drive mode 0x1: Normal drive mode 0x2: High drive mode 0x3: Maximum drive mode		

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
ICC_DRV	5:4	ICC	Configures the output drive strength of ICC pin.	00: Reduced drive mode 01: Normal drive mode 10: High drive mode 11: Maximum drive mode
IRQ_DRV	3:2	IRQ	Configures the output drive strength of IRQ pin.	00: Reduced drive mode 01: Normal drive mode 10: High drive mode 11: Maximum drive mode
DOUT_DRV	1:0	TXEN	Configures the output drive strength of DOUT pin.	00: Reduced drive mode 01: Normal drive mode 10: High drive mode 11: Maximum drive mode

PCM Mode Config (0x2041)

BIT	7	6	5	4	3	2	1	0	
Field	PCM_CH	IANSZ[1:0]	PCM_FORMAT[2:0]			PCM_TX_I NTERLEAV E	PCM_CHA NSEL	PCM_TX_E XTRA_HIZ	
Reset	()x3	0x0			0x0	0b0	0b0	
Access Type	Write	e, Read	Write, Read			Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	DESCRIPTION				DECODE		
PCM_CHA NSZ	7:6	ENL	Configures the each channel.	Configures the PCM data word size for each channel.					
PCM_FOR MAT	5:3	ENL	Selects the PCM data format.			0x0: I ² S mode 0x1: Left-justified 0x2: Reserved 0x3: TDM mode 0 (0 BCLK delay from LRCLK) 0x4: TDM mode 1 (1 BCLK delay from LRCLK) 0x5: TDM mode 2 (2 BCLK delay from LRCLK) 0x6 to 0x7: Reserved			
PCM_TX_I NTERLEAV E	2	ENL	Controls wheth assigned to the interleaved on (DOUT).	er or not I/V se same channe the PCM data o	nse data l is frame output	0: Disable interleave mode 1: Enable interleave mode			
PCM_CHA NSEL	1	ENL	0: I ² S and left-justified mode: Falli LRCLK edge starts a new frame. In TDM modes: Rising LRCLK edge a new frame. frame (Channel 0 or Slot 0). LRCLK edge starts a new frame. In I ² S and left-justified mode: R LRCLK edge starts a new frame. In I ² S and left-justified mode: R LRCLK edge starts a new frame. In TDM modes: Falling LRCLK edge a new frame.					Falling ne. < edge starts le: Rising ne. < edge starts	

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_TX_E XTRA_HIZ	0	ENL	Select whether DOUT is driven to zero or Hi-Z during extra BCLK cycles in I ² S and left-justified mode.	0: Drive DOUT to zero for extra BCLK cycles 1: Drive DOUT to Hi-Z for extra BCLK cycles

PCM Clock Setup (0x2042)

BIT	7	6	5	4	3	2	1	0		
Field	-	-	-	PCM_BCLK EDGE		PCM_BSEL[3:0]				
Reset	-	-	-	0b0		0:	x4			
Access Type	-	-	_	Write, Read		Write, Read				
BITFIELD	BITS	RES	DESCRIPTION			DECODE				
PCM_BCLK EDGE	4	ENL	Selects the act	ive BCLK edge	LK edge. 0: Input data captured and output data valid on rising edge of BCLK 1: Input data captured and output data valid on falling edge of BCLK					
PCM_BSEL	3:0	ENL	Selects the nur expected by th	mber of BCLKs e PCM Interfac	per LRCLK e.	0x0: Reserved 0x1: Reserved 0x2: 32 0x3: 48 0x4: 64 0x5: 96 0x6: 128 0x7: 192 0x8: 256 0x9: 384 0xA: 512 0xB: 320 0xC: 250 0xD: 125 0xE to 0xF: Re	served			

PCM Sample Rate Setup 1 (0x2043)

BIT	7	6	5	4	3	2	1	0	
Field		IVADC_	_SR[3:0]		PCM_SR[3:0]				
Reset		0:	x8		0x8				
Access Type		Write,	Read		Write, Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
IVADC_SR	7:4	ENL	Sets the sample rate of the I/V sense ADC path.	0x0: 8kHz 0x1: 11.025kHz 0x2: 12kHz 0x3: 16kHz 0x4: 22.05kHz 0x6: 32kHz 0x6: 32kHz 0x7: 44.1kHz 0x8: 48kHz 0x9: 88.2kHz 0xA: 96kHz 0xA: 96kHz 0xB: 176.4kHz 0xC: 192kHz 0xD to 0xF: Reserved
PCM_SR	3:0	ENL	Sets the sample rate of the PCM interface. This corresponds to the expected LRCLK frequency.	0x0: 8kHz 0x1: 11.025kHz 0x2: 12kHz 0x3: 16kHz 0x4: 22.05kHz 0x5: 24kHz 0x6: 32kHz 0x7: 44.1kHz 0x8: 48kHz 0x9: 88.2kHz 0xA: 96kHz 0xA: 96kHz 0xB: 176.4kHz 0xC: 192kHz 0xD to 0xF: Reserved

PCM TX Control 1 (0x2044)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_VMON_SLOT[5:0]						
Reset	-	-		0x0						
Access Type	-	-		Write, Read						
BITFIELD	BITS	RES	D	DESCRIPTION DECODE						
PCM_VMO N_SLOT	5:0	TXEN	Selects the dat the voltage ser TDM mode, or valid.	ta output (DOU nse output data ily Slot 0 and S	T) slots for . In non- lot 1 are	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x22 to 0x3D: 0x3E: Slot 62/6 0x3F: Reserve	2 33 d			

PCM TX Control 2 (0x2045)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_IMON_SLOT[5:0]						
Reset	-	-		0x0						
Access Type	-	-		Write, Read						

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_IMON _SLOT	5:0	TXEN	IMON Data Output Slot Select. IMON data requires two slots. In non-TDM mode, only Slot 0 and Slot 1 are valid.	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x22 to 0x3D: 0x3E: Slot 62/63 0x3F: Reserved

PCM TX Control 3 (0x2046)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_PVDD_SLOT[5:0]						
Reset	-	-		0x0						
Access Type	-	-		Write, Read						
BITFIELD	BITS	RES	D	DESCRIPTION DECODE						
PCM_PVD D_SLOT	5:0	TXEN	PVDD Data (A PVDD data rec	DC) Output Slo quires two slots	it Select.	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x22 to 0x3D: 0x3E: Slot 62/63 0x3E: Passarved				

PCM TX Control 4 (0x2047)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_VBAT_SLOT[5:0]						
Reset	-	-		0x0						
Access Type	-	-		Write, Read						
BITFIELD	BITS	RES	D	DESCRIPTION DECODE						
PCM_VBAT _SLOT	5:0	TXEN	VBAT Data (Al VBAT data req	DC) Output Slo uires two slots.	t Select.	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x22 to 0x3D: 0x3E: Slot 62/6 0x3F: Reserve	2 3 53 d			

PCM TX Control 5 (0x2048)

BIT	7	6	5	4	3	2	1	0		
Field	_	-		PCM_DHT_ATN_SLOT[5:0]						
Reset	_	-		0x0						
Access Type	-	-			Write,	Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_DHT_ ATN_SLOT	5:0	TXEN	DHT Attenuation Data Output Slot Select. DHT attenuation data requires two slots.	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x22 to 0x3D: 0x3E: Slot 62/63 0x3F: Reserved

PCM TX Control 6 (0x2049)

BIT	7	6	5	4	3	2	1	0		
Field	-	-			PCM_STAT	JS_SLOT[5:0]				
Reset	-	-			0	x0				
Access Type	_	-		Write, Read						
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE			
PCM_STAT US_SLOT	5:0	TXEN	Device Satus I Device status I	Device Satus Data Output Slot Select. Device status requires two slots. 0x00: Slot 00/010x01: Slot 01/020x02 to 0x3D:0x3E: Slot 62/630x3F: Reserved						

PCM TX Control 7 (0x204A)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_DSP_MONITOR_SLOT[5:0]						
Reset	-	-			0	x0				
Access Type	_	-		Write, Read						
BITFIELD	BITS	RES	D	DESCRIPTION DECODE						
PCM_DSP_ MONITOR_ SLOT	5:0	TXEN	DSP Monitor D DSP montior d	Data Output Slo lata requires 4	t Select. slots.	0x0: Slot 00/01 0x1: Slot 01/02 0x2: Slot 02/03 0x3 to 0x3B: 0x3C: Slot 60/0 0x3D: Reserve 0x3E: Reserve 0x3F: Reserve	/02/03 2/03/04 3/04/05 61/62/63 d d d			

PCM TX Control 8 (0x204B)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		PCM_BPE_SLOT[5:0]						
Reset	-	-			0:	k 0				
Access Type	-	_			Write,	Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_BPE_ SLOT	5:0	TXEN	BPE State Output Slot Select. BPE state requires one slot.	0x0: Slot 00 0x1: Slot 01 0x2: Slot 02 0x22 to 0x3D: 0x3E: Slot 62 0x3F: Slot 62

PCM Tx HiZ Control 1 (0x204C)

BIT	7	6	5	4	3	2	1	0			
Field		PCM_TX_SLOT_HIZ[63:56]									
Reset		0xFF									
Access Type		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the slots to transm	unused PCM of the interval of	data output 0.	Value: Decode 0: Output 0 on idle slots from 63 to 56 1: Output Hi-Z on slots from 63 to 56					

PCM Tx HiZ Control 2 (0x204D)

BIT	7	6	5	4	3	2	1	0			
Field		PCM_TX_SLOT_HIZ[55:48]									
Reset		0xFF									
Access Type		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the them to Hi-Z or	unused PCM s [•] 0.	slots to set	0: Output 0 on idle slots from 55 to 48 1: Output Hi-Z on slots from 55 to 48					

PCM Tx HiZ Control 3 (0x204E)

BIT	7	6	5	4	3	2	1	0			
Field		PCM_TX_SLOT_HIZ[47:40]									
Reset		0xFF									
Access Type		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the them all to Hi-2	unused PCM s Z or 0.	slots to set	0: Output 0 on idle slots from 47 to 40 1: Output Hi-Z on slots from 47 to 40					

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PCM Tx HiZ Control 4 (0x204F)

BIT	7	6	5	4	3	2	1	0		
Field		PCM_TX_SLOT_HIZ[39:32]								
Reset				0x	FF					
Access Type		Write, Read								
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE			
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the them all to Hi-2	unused PCM s Z or 0.	slots to set	0: Output 0 on idle slots from 39 to 3 1: Output Hi-Z on slots from 39 to 32				

PCM Tx HiZ Control 5 (0x2050)

BIT	7	6	5	4	3	2	1	0			
Field		PCM_TX_SLOT_HIZ[31:24]									
Reset		0xFF									
Access Type		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the them all to Hi-2	unused PCM s Z or 0.	slots to set	0: Output 0 on slots from 31 to 24 1: Output Hi-Z on idle slots from 31 to 24					

PCM Tx HiZ Control6 (0x2051)

BIT	7	6	5	4	3	2	1	0			
Field		PCM_TX_SLOT_HIZ[23:16]									
Reset		0xFF									
Access Type		Write, Read									
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the unused PCM slots to set them all to Hi-Z or 0.0: Output 0 on idle slots from 23 1: Output Hi-Z on slots from 23 t				23 to 16 3 to 16				

PCM Tx HiZ Control 7 (0x2052)

BIT	7	6	5	4	3	2	1	0		
Field		PCM_TX_SLOT_HIZ[15:8]								
Reset		0xFF								
Access Type				Write,	Read					

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the unused PCM slots to set them all to Hi-Z or 0.	0: Output 0 on slots from 15 to 8 1: Output Hi-Z on idle slots from 15 to 8

PCM Tx HiZ Control 8 (0x2053)

BIT	7	6	5	4	3	2	1	0				
Field		PCM_TX_SLOT_HIZ[7:0]										
Reset		0xFF										
Access Type		Write, Read										
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE					
PCM_TX_S LOT_HIZ	7:0	TXEN	Configures the them all to Hi-2	unused PCM s Z or 0.	slots to set	0: Output 0 on idle slots from 7 to 0 1: Output Hi-Z on slots from 7 to 0						

PCM RX Source 1 (0x2055)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	-	-	PCM_DMM	IX_CFG[1:0]	
Reset	-	-	-	-	-	-	0	x0	
Access Type	-	-	-	-	_	-	Write, Read		
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
PCM_DMMI X_CFG	1:0	РСМ	Determines the mixer circuit.	e behavior of th	e mono	0x0: Output of monomixer is Channel 0 0x1: Output of monomixer is Channel 1 0x2: Output of monomixer is (Channel 0 - Channel1)/2 0x3: Reserved			

PCM RX Source 2 (0x2056)

BIT	7	6	5	4	3	3 2 1				
Field	P	CM_DMMIX_C	H1_SOURCE[3	3:0]	PCM_DMMIX_CH0_SOURCE[3:0]					
Reset		0	0x0			0>	(0			
Access Type		Write, Read Write, Read								
BITFIELD	BITS	RES	DESCRIPTION DECODE							
PCM_DMMI X_CH1_SO URCE	7:4	РСМ	Selects the PC is routed to the mono mixer.	M data input cl channel 1 of tl	nannel that ne digital	0x0: PCM Inpu 0x1: PCM Inpu 0x2: PCM Inpu 0xE: PCM Inpu 0xF: PCM Inpu	t Channel 0 t Channel 1 t Channel 2 it Channel 14 t Channel 15			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_DMMI X_CH0_SO URCE	3:0	РСМ	Selects the PCM data input channel that is routed to the channel 0 of the digital mono mixer.	0x0: PCM Input Channel 0 0x1: PCM Input Channel 1 0x2: PCM Input Channel 2 : 0xE: PCM Input Channel 14 0xF: PCM Input Channel 15

PCM Bypass Source (0x2058)

BIT	7	6	5	4	3 2 1 0				
Field	-	-	-	-	PCM_BYPASS_SOURCE[3:0]				
Reset	-	-	-	-	0x0				
Access Type	-	-	-	_	Write, Read				
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
PCM_BYPA SS_SOURC E	3:0	PCM	Selects the PC is routed to the bypass path.	M data input cl speaker audic	nannel that processing	0x0: PCM Inpu 0x1: PCM Inpu 0x2: PCM Inpu 0xE: PCM Inpu 0xF: PCM Inpu	it Channel 0 it Channel 1 it Channel 2 it Channel 14 it Channel 15		

PCM TX Source Enables (0x205D)

BIT	7	6	5	4	3	2	1	0
Field	PCM_BPE_ EN	PCM_STAT US_EN	PCM_DHT_ ATN_EN	PCM_VBAT _EN	PCM_PVD D_EN	PCM_DSP MONITOR_ EN	PCM_IMON _EN	PCM_VMO N_EN
Reset	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	DESCRIPTION DECODE					
PCM_BPE_ EN	7	TXEN	Enables transn prevention eng data output (D0 can be transmi	nit of the BPE (iine) state on th OUT) slot. This tted only in TD	brownout- le assigned output data M mode.	0: Disable BPE state transmit 1: Enable BPE state transmit		
PCM_STAT US_EN	6	TXEN	Enables transm the assigned d This output dat in TDM mode.	nit of the device ata output (DO a can be transi	e status on UT) slots. mitted only	0: Disable device status transmit 1: Enable device status transmit		
PCM_DHT_ ATN_EN	5	TXEN	Enables transmit of the applied DHT attenuation on the assigned data output (DOUT) slot. This output data can be transmitted only in TDM mode.			ata transmit ta transmit		
PCM_VBAT _EN	4	TXEN	Enables transn supply voltage output (DOUT) be transmitted	nit of the meas on the assigne slot. This outp only in TDM m	ured VBAT d data ut data can ode.	 O: Disable VBAT supply voltage data transmit 1: Enable VBAT supply voltage data transmit 		

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
PCM_PVD D_EN	3	TXEN	Enables transmit of the measured PVDD supply voltage on the assigned data output (DOUT) slot. This output data can be transmitted only in TDM mode.	0: Disable PVDD supply voltage data transmit 1: Enable PVDD supply voltage data transmit
PCM_DSP MONITOR_ EN	2	TXEN	Enables transmit of the playback path DSP output data on the assigned data output (DOUT) slot.	0: Disable playback path data transmit 1: Enable playback path data transmit
PCM_IMON _EN	1	TXEN	Enables transmit of the current sense output data on the assigned data output (DOUT) slot.	0: Disable current sense data transmit 1: Enable current sense data transmit
PCM_VMO N_EN	0	TXEN	Enables transmit of the voltage sense output data on the assigned data output (DOUT) slot.	0: Disable voltage sense data transmit 1: Enable voltage sense data transmit

PCM Rx Enables (0x205E)

BIT	7	6	5	4	3	2	1	0
Field	-	-	_	-	_	_	PCM_BYP_ EN	PCM_RX_E N
Reset	-	-	-	_	-	-		0b0
Access Type	-	-	_	-	_	_	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
PCM_BYP_ EN	1	_	Enables the PC amplifier throug path bypasses audio processi control, gains, Foldback.	er through the bypass path. This ypasses the speaker playback path processing features like—volume I, gains, DHT, BPE and Thermal ack.				s path s path
PCM_RX_E N	0	-	Enables the speaker amplifier playback path.0: PCM data input disabled 1: PCM data input enabled					

PCM Tx Enables (0x205F)

BIT	7	6	5	4	3	2	1	0
Field	_	_	-	-	-	-	_	PCM_TX_E N
Reset	-	-	_	-	_	-	-	0b0
Access Type	-	-	_	-	_	-	-	Write, Read
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
PCM_TX_E N	0	TXEN	Enables the data output (DOUT) of the PCM interface.			0: PCM data of 1: PCM data of	utput disabled utput enabled	

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ICC Rx Enables A (0x2070)

BIT	7	6	5	4	3	2	1	0	
Field	ICC_RX_C H7_EN	ICC_RX_C H6_EN	ICC_RX_C ICC_RX_C ICC_RX_C H5_EN H4_EN H3_EN		ICC_RX_C H2_EN	ICC_RX_C H1_EN	ICC_RX_C H0_EN		
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
ICC_RX_C H7_EN	7	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive channel 7 is disabled 1: ICC receive channel 7 is enabled			
ICC_RX_C H6_EN	6	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 6 is di channel 6 is er	sabled nabled	
ICC_RX_C H5_EN	5	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 5 is di channel 5 is er	sabled nabled	
ICC_RX_C H4_EN	4	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 4 is di channel 4 is er	sabled nabled	
ICC_RX_C H3_EN	3	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 3 is di channel 3 is er	sabled nabled	
ICC_RX_C H2_EN	2	ICC	Configures whether or not the ICC interface accepts data from this channel.			0: ICC receive 1: ICC receive	channel 2 is di channel 2 is er	sabled nabled	
ICC_RX_C H1_EN	1	ICC	Configures whether or not the ICC interface accepts data from this channel.			0: ICC receive channel 1 is disabled 1: ICC receive channel 1 is enabled			
ICC_RX_C H0_EN	0	ICC	Configures who interface accept	ether or not the ots data from the	ICC is channel.	0: ICC receive 1: ICC receive	channel 0 is di channel 0 is er	sabled nabled	

ICC Rx Enables B (0x2071)

BIT	7	6	5	4	3	2	1	0
Field	ICC_RX_C H15_EN	ICC_RX_C H14_EN	ICC_RX_C ICC_RX_C ICC_RX_C H13_EN H12_EN H11_EN			ICC_RX_C H10_EN	ICC_RX_C H9_EN	ICC_RX_C H8_EN
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
ICC_RX_C H15_EN	7	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive channel 15 is disabled 1: ICC receive channel 15 is enabled		
ICC_RX_C H14_EN	6	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive channel 14 is disabled 1: ICC receive channel 14 is enabled		
ICC_RX_C H13_EN	5	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 13 is o channel 13 is e	lisabled enabled
ICC_RX_C H12_EN	4	ICC	Configures whether or not the ICC interface accepts data from this channel.			0: ICC receive 1: ICC receive	channel 12 is o channel 12 is e	lisabled enabled
ICC_RX_C H11_EN	3	ICC	Configures whether or not the ICC interface accepts data from this channel.			0: ICC receive 1: ICC receive	channel 11 is o channel 11 is e	lisabled enabled
ICC_RX_C H10_EN	2	ICC	Configures who interface accept	ether or not the ots data from th	ICC is channel.	0: ICC receive 1: ICC receive	channel 10 is o channel 10 is e	lisabled enabled

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
ICC_RX_C H9_EN	1	ICC	Configures whether or not the ICC interface accepts data from this channel.	0: ICC receive channel 9 is disabled 1: ICC receive channel 9 is enabled
ICC_RX_C H8_EN	0	ICC	Configures whether or not the ICC interface accepts data from this channel.	0: ICC receive channel 8 is disabled 1: ICC receive channel 8 is enabled

ICC Tx Control (0x2072)

BIT	7	6	5	4	3 2 1 0			
Field	-	ICC_INTER LEAVE_MO DE	ICC_DATA			ICC_TX_DEST[3:0]		
Reset	-	0x0	0x0	-		0:	x0	
Access Type	_	Write, Read	Write, Read	_	Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
ICC_INTER LEAVE_MO DE	6	ICC	Select whether DHT and thern interleaving fas size (data widtl no effect when or 32-bits.	the ICC pin transl the ICC pin transl the data word the data word	ansmits ta in M data word s. This has size is 24-	0: ICC transmi foldback data t 1: ICC transmi DHT and therm alternatively	ts either DHT o based on ICC_ ts in interleaved nal foldback da	r thermal DATA_SEL d mode which ta are sent
ICC_DATA_ SEL	5	ICC	Select whether the ICC pin transmitsDHT or thermal foldback data when PCM0: ICC transmits DHT data +data word size (data width) is only1: ICC transmits thermal fold16-bits. This has no effect when the dataBPE stateword size is 24- or 32-bits.BPE state				BPE state back data +	
ICC_TX_DE ST	3:0	ICC	Selects the device transmit channel for ICC data. 0x0: ICC Channel 0 0x1: ICC Channel 1 : 0xE: ICC Channel 14 0xF: ICC Channel 15			nel 0 nel 1 inel 14 inel 15		

ICC Enables (0x207F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	ICC_LINK_ EN	ICC_TX_EN
Reset	-	-	-	-	-	-	0b0	0x0
Access Type	_	_	-	-	_	-	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
ICC_LINK_ EN	1	_	Enables ICC li	nk between dev	vices.	0: ICC thermal 1: ICC thermal	link disabled link enabled	
ICC_TX_EN	0	_	Select whether enabled/disabl	the ICC pin tra	ansmitter is	0: ICC transmit 1: ICC transmit	t disabled t enabled	

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Tone Generator and DC Config (0x2083)

BIT	7	6	5	5 4 3		2	1	0		
Field	-	-	TONE_AMP	TONE_AMPLITUDE[1:0]			TONE_CONFIG[3:0]			
Reset	-	-	0:	0x0 0x4						
Access Type	-	-	Write,	Read	d Write, Read					
BITFIELD	BITS	RES	DESCRIPTION			DECODE				
TONE_AMP LITUDE	5:4	EN	Sets the sine w register is not u the tone gener	Sets the sine wave amplitude. This register is not used when programming the tone generator to output DC signals.			0x0: -6dBFS 0x1: -4.8dBFS 0x2: 0dBFS 0x3: Reserved			
TONE_CO NFIG	3:0	EN	Configures the generator. For frequency is a (f _S).	Configures the output of the tone generator. For signal outputs, the requency is a division of the sample rate $f_{\rm S}$).			programmed by 0] ullScale/2 ullScale/2 ue at all sample served	/ rates		

Tone Generator DC Level 1 (0x2084)

BIT	7	6	5	4	3	2	1	0		
Field		TONE_DC[23:16]								
Reset		0x0								
Access Type		Write, Read								
BITFIELD	E	BITS RES DESCRIPTION								
TONE_DC		7:0	EN	Sets the tone generator DC output level as a signed binary relative to full-scale.						

Tone Generator DC Level 2 (0x2085)

BIT	7	6	5	4	3	2	1	0		
Field		TONE_DC[15:8]								
Reset		0x0								
Access Type		Write, Read								
BITFIELD	E	BITS RES DESCRIPTION								
TONE_DC		7:0	EN	Sets the tone generator DC output level as a signed binary relative to full-scale.						

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Tone Generator DC Level 3 (0x2086)

BIT	7	6	5	4	3	2	1	0	
Field		TONE_DC[7:0]							
Reset		0x0							
Access Type		Write, Read							
BITFIELD	BITS RES DESCRIPTION								
TONE_DC		7:0	EN	Sets the tone generator DC output level as a signed binary relative to full-scale.					

Tone Generator Enable (0x208F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	-	TONE_EN
Reset	-	-	-	-	-	-	-	0b0
Access Type	_	-	_	_	_	_	_	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
TONE_EN	0	ENL	Enables the tone generator. When enabled, it replaces the PCM interface as the input to the speaker amplifier path.			0: Tone genera 1: Tone genera	ator disabled ate enabled	

AMP volume control (0x2090)

BIT	7	6	5	4	3	2	1	0		
Field	-		SPK_VOL[6:0]							
Reset	-		0x0							
Access Type	_		Write, Read							
BITFIELD	BITS	RES	DESCRIPTION DECODE							
SPK_VOL	6:0	_	Sets the digita speaker amplit	volume level ïer path.	of the	0x00: 0dB 0x01: -0.5dB 0x02: -1.0dB : (-0.5dB ste 0x7C: -62.0dB 0x7D: -62.5dB 0x7E: -63dB 0x7F: Mute	os)			

AMP Path Gain (0x2091)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	SPK_GAIN_MAX[4:0]				
Reset	-	-	-	0xB				
Access Type	-	-	-	Write, Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
SPK_GAIN _MAX	4:0	SPK	Sets the maximum peak output voltage level (V _{MPO}) for the speaker path (no- load). Values in dB are relative to the baseline speaker path DAC full-scale output level of 3.68dBV.	0x00: $3.43V_P$ (4dB) 0x01: $3.84V_P$ (5dB) 0x02: $4.31V_P$ (5dB) 0x03: $4.84V_P$ (7dB) 0x04: $5.43V_P$ (8dB) 0x05: $6.09V_P$ (9dB) 0x06: $6.84V_P$ (10dB) 0x07: $7.67V_P$ (11dB) 0x08: $8.61V_P$ (12dB) 0x09: $9.66V_P$ (13dB) 0x08: $12.16V_P$ (15dB) 0x0C: $13.64V_P$ (16dB) 0x0D: $15.31V_P$ (17dB) 0x0E: $17.17V_P$ (18dB) 0x0F: $19.25V_P$ (19dB) 0x10: $21.60V_P$ (20dB) 0x11: $24.24V_P$ (21dB) 0x12-0x1F: Reserved

AMP DSP Config (0x2092)

BIT	7	6	5	4	3	2	1	0
Field	-	SPK_WBA ND_FILT_E N	SPK_SAFE SPK_VOL_ SPK_VOL_ RMPDN_B RMPUP_BY _EN YPASS PASS			SPK_INVE RT	SPK_DITH_ EN	SPK_DCBL K_EN
Reset	-	0x0	0x1	0b0	0b0	0b0	0b1	0b0
Access Type	-	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
SPK_WBA ND_FILT_E N	6	SPK	Enables the wi speaker amplif passband for s 50kHz.	deband filters i ier path with in ample rates hig	n the creased gher than	0: Higher passband filters disabled 1: Higher passband filters enabled		
SPK_SAFE _EN	5	SPK	The Safe Mode bit protects any speaker connected to the device on power up. When this setting is enabled, the SPK_VOL and SPK_GAIN_MAX settings are ignored and the amplifier output is set to -18dBES			0: Speaker saf 1: Speaker saf	e mode disable e mode enable	ed d
SPK_VOL_ RMPDN_B YPASS	4	SPK	Controls wheth path volume is during shutdow changes.	her the speaker internally ramp vn and during v	amplifier bed down olume	0: Volume ram 1: Volume ram	p enabled p bypassed	
SPK_VOL_ RMPUP_BY PASS	3	SPK	Controls whether the speaker amplifier path volume is internally ramped up during startup and during volume changes.			0: Volume ram 1: Volume ram	p enabled p bypassed	
SPK_INVE RT	2	-	Inverts the speaker amplifier path output.			It. 0: Output is normal 1: Output is inverted		
SPK_DITH_ EN	1	SPK	Selects whether the data in the	er or not dither speaker amplif	is applied to ier path.	0: Dither disabled 1: Dither enabled		

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
SPK_DCBL K_EN	0	SPK	Controls the DC blocking filter in the speaker amplifier path.	0: DC blocking filter disabled 1: DC blocking filter enabled

SSM Configuration (0x2093)

BIT	7	6	5	4	3	2	2 1 0		
Field	-	-	-	-	SPK_SSM_ EN	SPK_S	SPK_SSM_MOD_INDEX[2:0]		
Reset	-	-	-	-	0x1		0x5		
Access Type	-	_	_	-	Write, Read	Write, Read			
BITFIELD	BITS	RES	DESCRIPTION DECODE						
SPK_SSM_ EN	3	SPK	Enables Sprea	d-Spectrum Cl	ocking.	0: Spread-spectrum clocking is disabled 1: Spread-spectrum clocking is enabled			
SPK_SSM_ MOD_INDE X	2:0	SPK	Selects the mo Class-D amplif clocks. The mo varied as follow	Selects the modulation index for the Class-D amplifier spread-spectrum clocks. The modulation index can be varied as follows: 0x0: MMI 0x1: MMI * 5/6 0x2: MMI * 4/6 0x3: MMI * 3/6 0x3: MMI * 3/6 0x4: MMI * 2/6 0x5: MMI * 1/6 0x5: MMI * 1/6 0x6: 0x7: Parameter					

SPK Class DG Threshold (0x2094)

BIT	7	6	5	4 3 2 1 0						
Field	-	-	-		SPK_DG_THRES[4:0]					
Reset	-	-	-			0x12				
Access Type	-	-	-	Write, Read						
BITFIELD	BITS	RES	D	DESCRIPTION DECODE						
SPK_DG_T HRES	4:0	SPK	Sets the DG m threshold (activ 0x0 or 0x2).	ode fixed peak ve when SPK_I	signal level DG_SEL =	0x00: 3.8V 0x01: 3.7V 0x02: 3.6V 0x03 to 0x1D: 0x1E: 0.8V 0x1F: 0.7V	(0.1V steps)			

SPK Class DG Headroom (0x2095)

BIT	7	6	5	4	3	2	1	0
Field	-	—	SPK_DG_SEL[1:0] SPK_DG_HEADROOM[3:0]					
Reset	-	-	0:	x1	0x7			
Access Type	-	-	Write,	Read	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
SPK_DG_S EL	5:4	SPK	Selects the method used for speaker amplifier DG mode operation.	0x0: Class-DG mode uses a fixed peak signal level threshold (SPK_DG_THRES) 0x1: Class-DG mode uses supply headroom relative to measured VBAT voltage (SPK_DG_HEADROOM) 0x2: Class-DG mode uses the lower of fixed peak signal level threshold (SPK_DG_THRES) and VBAT supply headroom (SPK_DG_HEADROOM) 0x3: Reserved
SPK_DG_H EADROOM	3:0	SPK	Sets the DG mode headroom relative to the measured V_{VBAT} supply level (active when SPK_DG_SEL = 0x1 or 0x2).	0x0: 0V 0x1: 0.25V 0x2: 0.5V 0x3 to 0xD: (0.25V steps) 0xE: 3.5V 0xF: 3.75V

SPK Class DG Hold Time (0x2096)

BIT	7	6	5	4	3	2	1	0	
Field	-	SPK_	DG_PEAK_HY	ST[2:0]		SPK_DG_HO	LD_TIME[3:0]		
Reset	-		0x1			0:	κ7		
Access Type	-		Write, Read			Write, Read			
BITFIELD	BITS	RES	DESCRIPTION DECODE						
SPK_DG_P EAK_HYST	6:4	SPK	Decord Decord Sets the signal peak hysteresis relative to the measured V _{VBAT} supply level. In order to switch from D to G, signal peak must be less than VBAT - hysteresis. 0x0: 0.5dB 0x1: 1.0dB 0x2: 1.5dB 0x3: 2.0dB 0x4: 2.5dB 0x5: 3.0dB 0x6: 4.0dB 0x7: 5.0dB						
SPK_DG_H OLD_TIME	3:0	SPK	Sets the speak time. When the below the DG r than this time, active amplifier	er amplifier DG e peak signal le mode threshold VBAT is select r supply.	6 mode hold vel falls I for longer ed as the	0x0: 0.15ms 0x1: 0.25ms 0x2: 0.5ms 0x3: 1.0ms 0x4: 2.5ms 0x5: 5.0ms 0x6: 10ms 0x7: 20ms 0x8: 30ms 0x8: 30ms 0x9: 40ms 0x8: 50ms 0x8: 125ms 0xC: 250ms 0xD: 500ms 0xE: 750ms 0xF: 1.0s			

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SPK Class DG Delay (0x2097)

BIT	7	6	5	4	3	2	1	0			
Field	-	-		SPK_DG_DELAY[5:0]							
Reset	-	-			C	0x0					
Access Type	_	-		Write, Read							
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE				
SPK_DG_D ELAY	5:0	SPK	Selects the spe delay for DG n audio output b	eaker amplifier node operation. y N samples (N	path signal Delays the x f _S).	0x0: No delay 0x1: Delay 1 sample 0x2: Delay 2 samples 0x3 to 0x1D: (1 sample step) 0x1E: Delay 30 samples 0x1F: Delay 31 samples 0x20: Delay 32 samples					

SPK Class DG Mode (0x2098)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	- SPK_MODE[1:0]	
Reset	-	-	-	-	-	-	0	×0
Access Type	-	-	_	-	_	– Write, Read		
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
SPK_MOD E	1:0	-	Selects the spe mode.	e speaker amplifier operating 0x0: DG mode is enabled. 0x1: DG mode is disabled and ampli always supplied from PVDD pin. 0x2: DG mode is disabled and ampli supplied from VBAT pin when supply conditions are met. 0x3: Reserved				d amplifier is bin. d amplifier is n supply

SPK Class DG VBAT Level (0x2099)

BIT	7	6	5	4	3	2	2 1 0		
Field	-	-	-	-	-	VBA	VBATLOW_OK_LVL[2:0]		
Reset	-	-	-	-	-		0x3		
Access Type	-	-	_	-	_	Write, Read			
BITFIELD	BITS	RES	DESCRIPTION DECODE						
VBATLOW_ OK_LVL	2:0	-	Sets the thresh which the amp PVDD mode of supply is PVDI	nold for VBAT le lifier is forced to nly (i.e., the act D only).	evel below o operate in ive amplifier	0x0: 2.5V 0x1: 2.6V 0x2: 2.7V 0x3: 2.8V 0x4: 2.9V 0x5: 3.0V 0x6: Reserved 0x7: Reserved			

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SPK Edge Control (0x209A)

BIT	7	6	5	4	3	2	1	0
Field	-	_	-	_	_	SPK_FSW_ SEL	-	_
Reset	-	-	-	-	-	0x0	-	-
Access Type	-	-	_	-	_	Write, Read	-	_
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
SPK_FSW_ SEL	2	SPK	Controls the nominal switching frequency of the speaker amplifier.			0: 472kHz 1: 666kHz		

SPK Path Wideband Only Enable (0x209B)

BIT	7	6	5	4	3	2	1	0
Field	_	-	_	-	_	_	_	SPK_WIDE BAND_ONL Y_EN
Reset	-	-	-	-	-	_	-	0b00
Access Type	-	-	-	_	_	_	-	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
SPK_WIDE BAND_ONL Y_EN	0	SPK	When enabled, only wideband signal is sent to the Amplifier			0x0: Ultrasoun 0x1: Ultrasoun	d Signal Mode d Signal Mode	Disable Enable

SPK Edge Control 1 (0x209C)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-		SPK_SL_RATE_GMODE[3:0]			
Reset	-	-	-	-		0:	хA		
Access Type	-	-	_	_		Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
SPK_SL_R ATE_GMO DE	3:0	_	These bits con side power FE supply pin. Thi rise time at OU in VBAT mode time at OUTx r fall time is stroi SPK_SL_RATI	trol the on/off ti T connected to s in effect stror ITx nodes , and weakly co nodes in VBAT ngly controlled E_LS<3:0>.	ime of high the VBAT ngly controls ontrols fall mode, as by	Previous four o	codes are prefe	rred choices.	

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SPK Edge Control 2 (0x209D)

BIT	7	6	5	4	3	2	1	0
Field		SPK_SL_R	ATE_LS[3:0]	•		SPK_SL_R/	ATE_HS[3:0]	
Reset		0	хА			0xA		
Access Type		Write	, Read		Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
SPK_SL_R ATE_LS	7:4	_	These bits control the on/off time of the low side power FET. This in effect strongly controls fall time at OUTx node, and weakly controls rise time at OUTx nodes. Rise times are strongly controlled by SPK_SL_RATE_GMODE in VBAT mode and SPK_SL_RATE_HS in PVDD			Previous table	shows four pre	ferred codes.
SPK_SL_R ATE_HS	3:0	_	These bits con side power FE supply pin. Thi rise time at OU controls fall time mode. Fall time SPK SL RATI	trol the on/off ti T connected to s in effect stron ITx nodes, and the of OUTx nod is strongly con E LS.	ime of high the PVDD ngly controls weakly les in PVDD ntrolled by	Previous table codes.	shows the pref	erred four

Amp Clip Gain (0x209E)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-		SPK_GAIN[3:0]			
Reset	-	-	-	-	0x0				
Access Type	-	-	_	-	Write, Read				
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
SPK_GAIN	3:0	_	Sets the digital speaker amplif	l clip gain level ïer path.	of the	0x00: 0dB 0x01: 0.5dB 0x02: 1.0dB 0x03: 1.5dB 0x04: 2.0dB 0x05: 2.5dB 0x06: 3.0dB 0x07: 3.5dB 0x08: 4.0dB 0x09: 5.0dB 0x0A: 6.0dB 0x0B to 0x0F:	Reserved		

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Bypass Path Config (0x209F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	_	-	_	_	BYP_WBA ND_FILT_E N	BYP_INVE RT
Reset	-	-	-	-	-	-	0x0	0b0
Access Type	-	-	_	_	_	-	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
BYP_WBA ND_FILT_E N	1	SPK	Enables the wi increased pass higher than 50 processing byp	deband filters v sband for samp kHz in the amp bass path.	vith le rates lifier audio	0x0: Higher passband filters disabled 0x1: Higher passband filters enabled		
BYP_INVE RT	0	-	Inverts the bypass amplifier path output.			0: Output is no 1: Output is inv	rmal verted	

Amplifier Supply Control (0x20A0)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	-	NOVBAT
Reset	-	-	-	-	-	-	-	0x0
Access Type	-	-	_	_	_	_	_	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE		
NOVBAT	0	-	Selects whether the VBAT pin is supplied from an external supply or not. 0: Do not manually e measurement ADC automatically enable 1: Manually force the channel to be enable is in the active state					e can be ement ADC e the device

AMP enables (0x20AF)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	SPK_FB_E N	SPK_EN
Reset	-	-	-	-	-	-	0b0	0b0
Access Type	_	-	-	-	-	– Write, Read Wri		Write, Read
BITFIELD	BITS	RES	DESCRIPTION DECODE					
SPK_FB_E N	1	TXEN	Enables PCM (the speaker an	data output fror nplifier path DS	m the end of P.	0: Speaker am disabled 1: Speaker am enabled	plifier path DSF plifier path DSF	^p feedback ^p feedback
SPK_EN	0	TXEN	Enables the speaker amplifier path.			0: Speaker am 1: Speaker am	plifier is disable plifier is enable	ed d

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Meas ADC Sample Rate (0x20B0)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	MEAS_ADC_TEMP_SR[1: MEAS_ADC 0]		_PVDD_SR[1: 0]	MEAS_ADC_	_VBAT_SR[1:)]		
Reset	-	-	0	x3	0)x0	0:	x0	
Access Type	-	-	Write	Write, Read Write,		e, Read	Write, Read		
BITFIELD	BITS	RES	DESCRIPTION				DECODE		
MEAS_ADC _TEMP_SR	5:4	EN	Configures the channel of the	Configures the sample rate of the thermal channel of the measurement ADC.					
MEAS_ADC _PVDD_SR	3:2	EN	Configures the channel of the	Configures the sample rate of the PVDD channel of the measurement ADC.					
MEAS_ADC _VBAT_SR	1:0	EN	Configures the sample rate of the VBAT channel of the measurement ADC. 0x0: 3 0x1: 1 0x2: 7 0x3: 3			0x0: 300kHz 0x1: 150kHz 0x2: 75kHz 0x3: 37.5kHz			

Meas ADC PVDD Config (0x20B1)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	MEAS_ADC _PVDD_FIL EN	ME	AS_ADC_PVDE	D_FILT_COEFF	-[3:0]	
Reset	-	-	-	0x0		0:	x0		
Access Type	_	-	-	Write, Read	Write, Read				
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
MEAS_ADC _PVDD_FIL T_EN	4	EN	Controls wheth PVDD channel	ner filtering is a l output.	pplied to the 0: Filter is bypassed 1: Filter is applied				
MEAS_ADC _PVDD_FIL T_COEFF	3:0	EN	Sets the PVDD bandwidth.	ts the PVDD channel lowpass filter ndwidth.			Value: Decode 0x0: 0.4khz (Across all sample rates) 0x1: 2.5kHz (Across all sample rates) 0x2: 7.5kHz (Across all sample rates) 0x3: 50kHz (Only 150kHz and 300kHz sample rate) 0x4: 150kHz (Only 300kHz sample rate) 0x5 to 0x5: Pasapred		

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Meas ADC VBAT Config (0x20B2)

BIT	7	6	5	4	3	2	1	0	
Field	_	_	_	MEAS_ADC _VBAT_FIL T_EN	ME	EAS_ADC_VBAT_FILT_COEFF[3:0]			
Reset	-	-	-	0x0		0×	:00		
Access Type	-	-	-	Write, Read	Write, Read				
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
MEAS_ADC _VBAT_FIL T_EN	4	EN	Controls wheth VBAT channel	ner filtering is an output.	pplied to the 0: Filter is bypassed 1: Filter is applied				
MEAS_ADC _VBAT_FIL T_COEFF	3:0	EN	Sets the VBAT channel lowpass filter bandwidth.			Value: Decode 0x0: 0.4kHz (A 0x1: 2.5kHz (/ 0x2: 7.5kHz (A 0x3: 50kHz (O sample rate) 0x4: 150kHz (C 0x5 to 0xF: Re	code Hz (Across all sample rates) Hz (Across all sample rates) Hz (Across all sample rates) Hz (Only 150kHz and 300kHz te) Hz (Only 300kHz sample rate)		

Meas ADC Thermal Config (0x20B3)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	_	MEAS_ADC _TEMP_FIL T_EN	ME	AS_ADC_TEMP_FILT_COEFF[3:0]			
Reset	-	-	-	0x0		0x	:00		
Access Type	-	-	-	Write, Read	Write, Read				
BITFIELD	BITS	RES	D	ESCRIPTION	DECODE				
MEAS_ADC _TEMP_FIL T_EN	4	EN	Controls wheth thermal channe	er filtering is a el output.	pplied to the 0: Filter is bypassed 1: Filter is applied				
MEAS_ADC _TEMP_FIL T_COEFF	3:0	EN	Sets the therm bandwidth.	Sets the thermal channel lowpass filter bandwidth.			cross all sampl Across all samp cross all samp nly 150kHz and Dnly 300kHz sa served	e rates) ble rates) le rates) d 300kHz ample rate)	

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Meas ADC Readback Control 1 (0x20B4)

BIT	7	6	5	4	3	2	1	0		
Field	-	-	_	-	_	MEAS_ADC _THERM_R D_MODE	MEAS_ADC _VBAT_RD _MODE	MEAS_ADC _PVDD_RD _MODE		
Reset	-	-	-	-	-	0x0	0x0	0x0		
Access Type	-	-			Write, Read	Write, Read	Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE			
MEAS_ADC _THERM_R D_MODE	2	_	Controls wheth channel output automatically c conversion is c	her the thermal t readback is up or manually afte completed.	ADC odated er each	0: Measuremen data is automa 1: Inititates a m result into the m readback regis	nt ADC channe tically updated neasurement a measurement A ter	el readback nd locks the ADC channel		
MEAS_ADC _VBAT_RD _MODE	1	_	Controls wheth output readbac or manually aft completed.	Controls whether the VBAT ADC channel output readback is updated automatically or manually after each conversion is completed.				ent ADC channel readback atically updated measurement and locks the measurement ADC channel ster		
MEAS_ADC _PVDD_RD _MODE	0	_	Controls whether the PVDD ADC channel output readback is updated automatically or manually after each conversion is completed.					el readback nd locks the ADC channel		

Meas ADC Readback Control 2 (0x20B5)

BIT	7	6	5	4	3	2	1	0
Field	-	-	_	-	_	MEAS_ADC _THERM_R D_UPD	MEAS_ADC _VBAT_RD _UPD	MEAS_ADC _PVDD_RD _UPD
Reset	-	-	-	_	-	0x0	0x0	0x0
Access Type	-	-	-	-	_	Write Only	Write Only	Write Only
BITFIELD	BITS	RES	DESCRIPTION DECODE					
MEAS_ADC _THERM_R D_UPD	2	_	Write 1 to inititate a measurement and lock the result into the measurement ADC thermal channel readback register				nd locks the ADC channel	
MEAS_ADC _VBAT_RD _UPD	1	_	Write 1 to initita locks the result ADC VBAT cha	Write 1 to inititate a measurement and locks the result into the measurement ADC VBAT channel readback register			neasurement a neasurement <i>A</i> ter	nd locks the ADC channel
MEAS_ADC _PVDD_RD _UPD	0	_	Write 1 to initita lock the result PVDD channel	ate a measurer into the measu readback regis	nent and rement ADC ster	0: No effect 1: Inititates a n result into the r readback regis	neasurement a neasurement <i>A</i> ter	nd locks the ADC channel

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Meas ADC PVDD Readback MSB (0x20B6)

BIT	7	6	5	4	3	2	1	0		
Field	MEAS_ADC_PVDD_DATA[8:1]									
Reset	0x0									
Access Type	Read Only									
BITFIELD		BITS	RES	DESCRIPTION						
MEAS_ADC_P	/D 7:0	7:0	-	Provides the measured PVDD value. To convert the 9-bit code into a real voltage, use the following:						
D_DATA		7.0		Measured 0.038085	Measured V _{PVDD} (V) = $2.5V + MEAS_ADC_PVDD_DATA[8:0] \times 0.038085V$					

Meas ADC PVDD Readback LSB (0x20B7)

BIT		7	6	5	4	3	2	1	0	
Field		_	_	-	-	-	-	-	MEAS_ADC _PVDD_DA TA[0]	
Reset		-	-	-	-	-	-	-	0x0	
Access Type		_	_	_	_	-	_	_	Read Only	
BITFIELD		BITS		RES		DESCRIPTION				
MEAS_ADC_PVD			0		Provides a real vol	Provides the measured PVDD value. To convert the 9-bit code into a real voltage, use the following:				
D_DATA			U	_	Measured 0.038085	Measured V _{PVDD} (V) = 2.5V + MEAS_ADC_PVDD_DATA[8:0] x 0.038085V				

Meas ADC VBAT Readback MSB (0x20B8)

BIT	7	6	5	4	3	2	1	0		
Field	MEAS_ADC_VBAT_DATA[8:1]									
Reset	0x0									
Access Type	Read Only									
BITFIELD		BITS	RES		DESCRIPTION					
MEAS_ADC_V	'BA	7:0	_	Provides a real vol	Provides the measured VBAT value. To convert the 9-bit code into a real voltage, use the following:					
T_DATA		7.0		Measured 0.01904V	Measured V _{VBAT} (V) = 1.25V + MEAS_ADC_VBAT_DATA[8:0] x 0.01904V					
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Meas ADC VBAT Readback LSB (0x20B9)

BIT		7	6	5	4	3	2	1	0	
Field		-	_	-	-	-	_	-	MEAS_ADC _VBAT_DA TA[0]	
Reset		-	-	-	-	-	-	-	0x0	
Access Type		_	_	_	_	-	_	-	Read Only	
BITFIELD		B	BITS	RES			DESCRIPTIO	ON		
MEAS_ADC_VBA		0			Provides a real vol	the measured ` tage, use the fo	VBAT value. To ollowing:	o convert the 9	-bit code into	
T_DATA		0		_	Measured 0.01904V	Measured V _{VBAT} (V) = 1.25V + MEAS_ADC_VBAT_DATA[8:0] x 0.01904V				

Meas ADC Temp Readback MSB (0x20BA)

BIT	-	7	6	5	4	3	2	1	0	
Field		MEAS_ADC_THERM_DATA[8:1]								
Reset		0x0								
Access Type		Read Only								
BITFIELD		В	ITS	RES			DESCRIPTIO	N		
MEAS_ADC_T RM_DATA	ΉE	-	7:0	_	Provides the measured temperature value. To convert the 9-bit code into a real temperature, use the following: Measured Temperature (°C) = (MEAS_ADC_THERM_DATA[8:0] 1.0°C) - 208°C					

Meas ADC Temp Readback LSB (0x20BB)

BIT		7	6	5	4	3	2	1	0
Field		-	_	-	-	_	-	-	MEAS_ADC _THERM_D ATA[0]
Reset		-	-	-	-	-	-	-	0x0
Access Type		_	Ι	-	-	_	_	-	Read Only
BITFIELD		E	ITS	RES			DESCRIPTIO	DN	
MEAS_ADC_T RM_DATA	ΉE		0	-	Provides code into Measured	the measured a real tempera d Temperature 208°C	temperature va iture, use the fo (°C) = (MEAS_	lue. To conver blowing: _ADC_THERM_	t the 9-bit _DATA[8:0] x

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Meas ADC Lowest PVDD Readback MSB (0x20BC)

BIT	7	6	5	4	3	2	1	0	
Field		LOWEST_PVDD_DATA[8:1]							
Reset		0xFF							
Access Type	Read Only								
BITFIELD		BITS	RES			DESCRIPTIO	ON		
LOWEST_PVE DATA)D_	7:0	-	Provides the lowest measured PVDD value. To convert the 9-bit code into a real voltage, use the following: Measured V _{PVDD} (V) = 2.5V + MEAS_ADC_PVDD_DATA[8:0] x 0.038085V					

Meas ADC Lowest PVDD Readback LSB (0x20BD)

BIT		7	6	5	4	3	2	1	0	
Field		Ι	_	-	-	-	_	-	LOWEST_P VDD_DATA [0]	
Reset		Ι	-	-	-	-	-	-	0x1	
Access Type		_	_	-	-	-	_	-	Read, Ext	
BITFIELD		В	BITS	RES			DESCRIPTIO	ON		
LOWEST_PVD	D		0		Provides code into	the lowest mea a real voltage,	asured PVDD v use the follow	alue. To conve ng:	ert the 9-bit	
DATA		0		-	Measured 0.038085	Measured V _{PVDD} (V) = 2.5V + MEAS_ADC_PVDD_DATA[8:0] x 0.038085V				

Meas ADC Lowest VBAT Readback MSB (0x20BE)

BIT	7	6	5	4	3	2	1	0		
Field		LOWEST_VBAT_DATA[8:1]								
Reset		0xFF								
Access Type		Read Only								
BITFIELD		BITS	RES			DESCRIPTIO	N			
LOWEST_VBA DATA	π_	7:0	_	Provides the measured VBAT value. To convert the 9-bit code a real voltage, use the following: Measured V _{VBAT} (V) = 1.25V + MEAS_ADC_VBAT_DATA[8:0 0.01904V				-bit code into DATA[8:0] x		

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Meas ADC Lowest VBAT Readback LSB (0x20BF)

BIT		7	6	5	4	3	2	1	0	
Field		-	-	-	-	-	-	-	LOWEST_V BAT_DATA[0]	
Reset		-	-	-	-	-	-	-	0x1	
Access Type		_	_	_	_	_	_	_	Read, Ext	
BITFIELD		В	BITS	RES		DESCRIPTION				
LOWEST_VBA DATA	AT_		0	_	Provides a real volt Measured 0.01904V	Provides the measured VBAT value. To convert the 9-bit code into a real voltage, use the following: Measured V _{VBAT} (V) = $1.25V + MEAS_ADC_VBAT_DATA[8:0] \times 0.01904V$				

Meas ADC Config (0x20C7)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	_	-	MEAS_ADC _VBAT_EN	MEAS_ADC _PVDD_EN
Reset	-	-	-	-	-	-	0x0	0x0
Access Type	-	-	_	-	_	_	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
MEAS_ADC _VBAT_EN	1	-	Manually enab VBAT channel.	les the measur	ement ADC	0: Do not many measurement automatically e 1: Manually for channel to be o is in the active	ually enable the ADC channel (i enabled) ce the measure enabled anytim state	e may be ement ADC e the device
MEAS_ADC _PVDD_EN	0	-	Manually enables the measurement ADC PVDD channel.			0: Do not many measurement automatically e 1: Manually for channel to be e is in the active	ually enable the ADC channel (i enabled) rce the measure enabled anytim state	e may be ement ADC e the device

DHT Configuration 1 (0x20D0)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	DHT_VROT_PNT[3:0]			
Reset	-	-	-	-	0x0			
Access Type	-	-	-	_	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_VROT _PNT	3:0	DHT	Sets the DRC rotation point.	0x0: 0dBFS 0x1: -1dBFS 0x2: -2dBFS 0x3: -3dBFS 0x4: -4dBFS 0x5: -5dBFS 0x6: -6dBFS 0x7: -8dBFS 0x8: -10dBFS 0x8: -10dBFS 0x8: -12dBFS 0x8: -15dBFS 0x8: Reserved 0xC: Reserved 0xC: Reserved 0xC: Reserved 0xF: Reserved

Limiter Configuration 1 (0x20D1)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	DHT_HR[4:0]				
Reset	-	-	-	0x8				
Access Type	-	-	-	Write, Read				

BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_HR	4:0	_	Selects the DHT supply headroom for the DRC and limiter functions.	0x0: -20% 0x1: -17.5% 0x2: -15% 0x3: -12.5% 0x4: -10% 0x5: -7.5% 0x6: -5.0% 0x7: -2.5% 0x8: 0% 0x9: +2.5% 0xA: +5.0% 0xB: +7.5% 0xC: +10% 0xD: +12.5% 0xE: +15% 0xF: +17.5% 010: +20%

Limiter Configuration 2 (0x20D2)

BIT	7	6	5	4	3	2	1	0		
Field	-	-		DHT_LIM_THRESH[4:0]						
Reset	-	-		0x0						
Access Type	-	-		Write, Read						

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_LIM_T HRESH	5:1	DHT	Selects the fixed threshold level for signal level limiter mode (SLL). Has no effect in signal distortion limiter mode (SDL).	00000: 0dBFS 00001: -1dBFS 00010: -2dBFS : (-1dBFS steps) 01110: -14dBFS 01111: -15dBFS 10000 to 11111: Reserved
DHT_LIM_ MODE	0	DHT	Selects whether the DHT limiter is in signal distortion or signal level limiter mode.	0: Signal distortion limiter mode where limiter threshold tracks supply1: Signal level limiter mode where limiter uses fixed thresholds

DHT Configuration 2 (0x20D3)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-		Dł	T_MAX_ATN	4:0]	
Reset	-	-	-			0x14		
Access Type	_	-	-			Write, Read		
BITFIELD	BITS	RES	D	DESCRIPTION DECODE				
DHT_MAX_ ATN	4:0	DHT	Selects the ma can be applied DHT.	aximum attenua I to the audio si	tion that gnal by the	0x0: Reserved 0x1: -1dB 0x2: -2dB 0x3: -3dB 0x4: -4dB 0x5: -5dB 0x6: -6dB 0x7: -7dB 0x8: -8dB 0x9: -9dB 0xA: -10dB 0xB: -11dB 0xC: -12dB 0xD: -13dB 0xE: -14dB 0xF: -15dB 0x10: -16dB 0x11: -17dB 0x12: -18dB 0x13: -19dB 0x14: -20dB 0x15-0x1F: Re	served	

DHT Configuration 3 (0x20D4)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	DHT_ATK_RATE[3:0]				
Reset	-	-	-	-	0x2				
Access Type	-	-	-	-	Write, Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_ATK_ RATE	3:0	_	Selects the DHT attack rate.	0x0: 20µs/dB 0x1: 40µs/dB 0x2: 80µs/dB 0x3: 160µs/dB 0x4: 320µs/dB 0x5: 640µs/dB 0x6: 1.28ms/dB 0x7: 2.56ms/dB 0x8: 5.12ms/dB 0x8: 5.12ms/dB 0x8: 40.96ms/dB 0x8: 40.96ms/dB 0x0: 163.84ms/dB 0x1: 163.84ms/dB 0x2: Reserved 0xF: Reserved

DHT Configuration 4 (0x20D5)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	DHT_RLS_RATE[3:0]				
Reset	-	-	-	-	0x4				
Access Type	-	_	_	-	Write, Read				

BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_RLS_ RATE	3:0	_	Selects the DHT release rate.	0x0: 2ms/dB 0x1: 4ms/dB 0x2: 8ms/dB 0x3: 16ms/dB 0x4: 32ms/dB 0x5: 64ms/dB 0x6: 128ms/dB 0x7: 256ms/dB 0x8: 512ms/dB 0x8: 512ms/dB 0x9: 1.024s/dB 0xA: 2.048s/dB 0xB: 4.096s/dB 0xC: 8.192s/dB 0xD: 16.384s/dB 0xE: Reserved 0xF: Reserved

DHT Supply Hysteresis Configuration (0x20D6)

BIT	7	6	5	4	3	2	1	0
Field	_	_	_	_	DHT_SUPPLY_HYST[2:0]			DHT_SUPP LY_HYST_ EN
Reset	-	-	-	-		0x3		
Access Type	-	_	_	_	Write, Read			Write, Read

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
DHT_SUPP LY_HYST	3:1	DHT	Selects the supply hysteresis for DHT attenuation release when supply increases.	0x0: 1 LSB 0x1: 2 LSB 0x2: 3 LSB 0x3: 4 LSB 0x4: 6 LSB 0x5: 8 LSB 0x6: 10 LSB 0x7: 12 LSB 0x8: RSVD
DHT_SUPP LY_HYST_ EN	0	DHT	Select whether PVDD DHT hysteresis is enabled or disabled.	0: DHT is disabled 1: DHT is enabled

DHT Enable (0x20DF)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	-	DHT_EN
Reset	-	-	-	-	-	-	-	0x0
Access Type	-	-	-	_	_	-	_	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
DHT_EN	0	SPK	Select whether DHT is enabled or disabled.			0: DHT is disat 1: DHT is enab	oled oled	

I_V Sense Path Config (0x20E0)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	IVADC_WB AND_FILT_ EN	IVADC_DIT H_EN	IVADC_I_D CBLK_EN	IVADC_V_ DCBLK_EN
Reset	-	-	-	-	0x0	0b1	0b0	0b0
Access Type	-	-	_	– Write, Read		Write, Read	Write, Read	Write, Read
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
IVADC_WB AND_FILT_ EN	3	IVS	Enables the wideband filters with increased passband for sample rates higher than 50kHz in the IV ADC path			0x0: Higher pa 0x1: Higher pa	ssband filters d ssband filters e	lisabled enabled
IVADC_DIT H_EN	2	IVS	Select whether the I/V sense A	or not dither is DC path.	applied to	0: Dither disabled 1: Dither enabled		
IVADC_I_D CBLK_EN	1	IVS	Enables the DC blocking filter in the current sense ADC path.			0: DC blocker disabled 1: DC blocker enabled		
IVADC_V_ DCBLK_EN	0	IVS	Enables the DC blocking filter in the voltage sense ADC path.			0: DC blocker disabled 1: DC blocker enabled		

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I_V Sense Path Enables (0x20E4)

BIT	7	6	5	4	3	2	1	0
Field	_	-	_	_	_	-	IVADC_I_E N	IVADC_V_E N
Reset	-	-	-	-	-	-	0b0	0b0
Access Type	_	-			-	Write, Read	Write, Read	
BITFIELD	BITS	RES	DESCRIPTION				DECODE	
IVADC_I_E N	1	_	Enables the sp path. When this sense ADC par device is in the	eaker current s s bit is set to 1, th is powered u active state (E	sense ADC the current p if the N = 1).	0: Speaker cur disabled 1: Speaker cur enabled	rent sense AD(rent sense AD(C path C path
IVADC_V_E N	0	_	Enables the sp path. When this sense ADC par device is in the	eaker voltage s s bit is set to 1, th is powered u active state (E	sense ADC the voltage p if the N = 1).	0: Speaker vol disabled 1: Speaker vol enabled	tage sense AD tage sense AD	C path C path

BPE State (0x20E5)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	-	E	BPE_STATE[2:	0]	
Reset	-	-	-	-	-	0x0			
Access Type	_	-	_	_	_	Read Only			
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_STAT E	2:0	-	Current level o Reads-back 00	f brownout con)0 when EN = (troller.).	000: Brownout 001: Level 3 010: Level 2 011: Level 1 100: Level 0 101 to 111: Re	000: Brownout inactive—normal operati 001: Level 3 010: Level 2 011: Level 1 100: Level 0 101 to 111: Percented		

BPE L3 Threshold MSB (0x20E6)

BIT	7	6	5	4	3	2	1	0			
Field				BPE_L3_VT	HRESH[8:1]		•				
Reset		0x0									
Access Type		Write, Read									
BITFIELD		BITS	RES		DESCRIPTION						
BPE_L3_VTHF H	RES	7:0	BPE	BPE_Ln_VTHRESH[8:0] Sets the trigger level for each thres the brownout controller. Refer to the Measurement ADC CH0 (PVDD) Result register these levels. A value of 0000 0000 (all zeros) means that sta							

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BPE L3 Threshold LSB (0x20E7)

BIT		7	6	5	4	3	2	1	0
Field		_	_	_	-	_	-	-	BPE_L3_VT HRESH[0]
Reset		-	-	-	-	-	-	-	0x0
Access Type		-	_	_	-	-	-	-	Write, Read
BITFIELD		B	BITS	RES			DESCRIPTIO	ON	
BPE_L3_VTHR H	ES		0	BPE					

BPE L2 Threshold MSB (0x20E8)

BIT	7	6	5	4	3	2	1	0			
Field				BPE_L2_VT	HRESH[8:1]						
Reset		0x0									
Access Type		Write, Read									
BITFIELD		BITS	RES		DESCRIPTION						
BPE_L2_VTHF H	RES	7:0	BPE	BPE_Ln_VTHRESH[8:0] Sets the trigger level for each thresho the brownout controller. Refer to the Measurement ADC CH0 (PVDD) Result register to these levels. A value of 0000 0000 (all zeros) means that state not used and is entirely bypassed							

BPE L2 Threshold LSB (0x20E9)

BIT		7	6	5	4	3	2	1	0
Field		_	_	_	_	_	_	-	BPE_L2_VT HRESH[0]
Reset		-	-	-	-	-	-	-	0x0
Access Type		_	_	-	_	-	-	-	Write, Read
BITFIELD		B	BITS	RES			DESCRIPTIO	ON	
BPE_L2_VTHF	RES		0	BPE					

BPE L1 Threshold MSB (0x20EA)

BIT	7	6	5	4	3	2	1	0		
Field		BPE_L1_VTHRESH[8:1]								
Reset		0x0								
Access Type				Write,	Read					

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BITFIELD	BITS	RES	DESCRIPTION
BPE_L1_VTHRES H	7:0	BPE	BPE_Ln_VTHRESH[8:0] Sets the trigger level for each threshold in the brownout controller. Refer to the Measurement ADC CH0 (PVDD) Result register to set
			not used and is entirely bypassed.

BPE L1 Threshold LSB (0x20EB)

BIT		7	6	5	4	3	2	1	0
Field		-	_	-	-	-	_	-	BPE_L1_VT HRESH[0]
Reset		-	Ι	_	_	-	-	-	0x0
Access Type		-	_	-	-	-	_	-	Write, Read
BITFIELD		B	ITS	RES			DESCRIPTIO	ON	
BPE_L1_VTHR H	RES		0	BPE					

BPE L0 Threshold MSB (0x20EC)

BIT	7	6	5	4	3	2	1	0			
Field				BPE_L0_VT	HRESH[8:1]						
Reset				0>	(0						
Access Type		Write, Read									
BITFIELD		BITS	RES		DESCRIPTION						
BPE_L0_VTHF H	RES	7:0	BPE	BPE_Ln_ the brown Refer to the these level not used a be bypass	BPE_Ln_VTHRESH[7:0] Sets the trigger level for each threshold the brownout controller. Refer to the Measurement ADC CH0 (PVDD) Result register to these levels. BA value of 0000 0000 (all zeros) means that state not used and is entirely bypassed (no hold times). Level 0 canno be bypassed by writing all zeros						

BPE L0 Threshold LSB (0x20ED)

BIT		7	6	5	4	3	2	1	0
Field		-	_	-	_	_	_	_	BPE_L0_VT HRESH[0]
Reset		_	-	-	-	-	-	-	0x0
Access Type		-	_	-	_	_	-	_	Write, Read
BITFIELD		E	BITS	RES			DESCRIPTIO	ON	
BPE_L0_VTHF H	RES		0	BPE					

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BPE L3 Dwell and Hold Time (0x20EE)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	BPI	E_L3_DWELL[2:0]	BF	PE_L3_HOLD[2	:0]	
Reset	-	-		0x0			0x0		
Access Type	-	-		Write, Read			Write, Read		
BITFIELD	BITS	RES	DESCRIPTION DECODE						
BPE_L3_D WELL	5:3	BPE	Sets BPE level time.	3 gain attenua	tion dwell	0x0: 0µs 0x1: 100µs 0x2: 250µs 0x3: 500µs 0x4: 1000µs 0x5: 2000µs 0x6: 4000µs 0x7: 8000µs			
BPE_L3_H OLD	2:0	BPE	Sets BPE level time.	l 3 gain attenua	0x6: 4000µs 0x7: 8000µs 0x0: 0ms 0x1: 10ms 0x2: 100ms 0x3: 250ms 0x4: 500ms 0x5: 1000ms 0x6: 2000ms				

BPE L2 Dwell and Hold Time (0x20EF)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	BP	E_L2_DWELL[2:0]	BF	PE_L2_HOLD[2	:0]	
Reset	-	-		0x0			0x0		
Access Type	-	-		Write, Read			Write, Read		
BITFIELD	BITS	RES	D	DESCRIPTION DECODE					
BPE_L2_D WELL	5:3	BPE	Sets BPE level time.	l 2 gain attenua	tion dwell	0x0: 0µs 0x1: 100µs 0x2: 250µs 0x3: 500µs 0x4: 1000µs 0x5: 2000µs 0x6: 4000µs 0x7: 8000µs			
BPE_L2_H OLD	2:0	BPE	Sets BPE level time.	l 2 gain attenua	tion hold	0x0: 0ms 0x1: 10ms 0x2: 100ms 0x3: 250ms 0x4: 500ms 0x5: 1000ms 0x6: 2000ms 0x7: Infinite			

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BPE L1 Dwell and Hold Time (0x20F0)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	BPI	BPE_L1_DWELL[2:0]			BPE_L1_HOLD[2:0]		
Reset	-	-		0x0			0x0		
Access Type	_	-		Write, Read		Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L1_D WELL	5:3	BPE	Sets BPE level time.	Sets BPE level 1 gain attenuation dwell ime.			0x0: 0µs 0x1: 100µs 0x2: 250µs 0x3: 500µs 0x4: 1000µs 0x5: 2000µs 0x6: 4000µs 0x7: 8000µs		
BPE_L1_H OLD	2:0	BPE	Sets BPE level 1 gain attenuation hold ime.			0x0: 0ms 0x1: 10ms 0x2: 100ms 0x3: 250ms 0x4: 500ms 0x5: 1000ms 0x6: 2000ms 0x7: Infinite			

BPE L0 Hold Time (0x20F1)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	BF	E_L0_HOLD[2	2:0]
Reset	-	-	-	-	-		0x0	
Access Type	-	-	-	-	_	Write, Read		
BITFIELD	BITS	RES	DESCRIPTION			DECODE		
BPE_L0_H OLD	2:0	BPE	Sets BPE level 0 gain attenuation hold time.			0x0: 0ms 0x1: 10ms 0x2: 100ms 0x3: 250ms 0x4: 500ms 0x5: 1000ms 0x6: 2000ms 0x7: Infinite		

BPE L3 Attack and Release Step (0x20F2)

BIT	7	6	5	4	3	2	1	0
Field	_	-	-	_	BPE_L3_STEP[3:0]			
Reset	-	-	-	-	0x0			
Access Type	_	_	_	_	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L3_ST EP	3:0	BPE	Sets BPE level 3 gain and limiter attenuation step size.	0x0: 0.0625dB 0x1: 0.125dB 0x2: 0.1875dB 0x3: 0.25dB 0x4: 0.375dB 0x5: 0.5dB 0x6: 0.75dB 0x7: 1.0dB 0x8: 1.5dB 0x9: 2.0dB 0xA: 2.5dB 0xB: 3.0dB 0xC: 4.0dB 0xD: 5.0dB for attack / 5.0dB for release 0xF: 6.0dB for attack / 5.0dB for release

BPE L2 Attack and Release Step (0x20F3)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L2_STEP[3:0]			
Reset	-	-	-	-	0x0			
Access Type	_	_	_	-	Write, Read			

BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L2_ST EP	3:0	BPE	Sets BPE level 2 gain and limiter attenuation step size.	0x0: 0.0625dB 0x1: 0.125dB 0x2: 0.1875dB 0x3: 0.25dB 0x4: 0.375dB 0x5: 0.5dB 0x6: 0.75dB 0x7: 1.0dB 0x8: 1.5dB 0x9: 2.0dB 0xA: 2.5dB 0xB: 3.0dB 0xC: 4.0dB 0xD: 5.0dB for attack / 6.0dB for release 0xF: 6.0dB for attack / 6.0dB for release

BPE L1 Attack and Release Step (0x20F4)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L1_STEP[3:0]			
Reset	-	-	-	-	0x0			
Access Type	-	-	-	-	Write, Read			

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L1_ST EP	3:0	BPE	Sets BPE level 1 gain and limiter attenuation step size.	0x0: 0.0625dB 0x1: 0.125dB 0x2: 0.1875dB 0x3: 0.25dB 0x4: 0.375dB 0x5: 0.5dB 0x6: 0.75dB 0x7: 1.0dB 0x8: 1.5dB 0x9: 2.0dB 0xA: 2.5dB 0xB: 3.0dB 0xC: 4.0dB 0xD: 5.0dB 0xE: 5.5dB for attack/ 6.0dB for release 0xF: 6.0dB for attack / 6.0dB for release

BPE L0 Attack and Release Step (0x20F5)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L0_STEP[3:0]			
Reset	-	-	-	-	0x0			
Access Type	_	_	_	_	Write, Read			

BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L0_ST EP	3:0	BPE	Sets BPE level 0 gain and limiter attenuation step size.	Value: Decode 0x0: 0.0625dB 0x1: 0.125dB 0x2: 0.1875dB 0x3: 0.25dB 0x4: 0.375dB 0x5: 0.5dB 0x6: 0.75dB 0x7: 1.0dB 0x8: 1.5dB 0x9: 2.0dB 0xA: 2.5dB 0xB: 3.0dB 0xC: 4.0dB 0xC: 5.0dB attack / 5.0dB release 0xF: 6.0dB attack / 5.0dB release

BPE L3 Max Gain Attn (0x20F6)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	BPE_L3_MAXATTN[4:0]				
Reset	-	-	-	0x0				
Access Type	-	-	-	Write, Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L3_M AXATTN	4:0	BPE	Sets BPE level 3 maximum gain attenuation.	0x0: 0dB 0x1: -1dB 0x2: -2dB 0x3: -3dB 0x4 0x1D:(-1dB steps) 0x1E: -30dB 0x1F: -31dB

BPE L2 Max Gain Attn (0x20F7)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-		BPE	_L2_MAXATTN	v [4:0]	
Reset	-	-	-			0x0		
Access Type	-	-	-	Write, Read				
BITFIELD	BITS	RES	D	DESCRIPTION DECODE				
BPE_L2_M AXATTN	4:0	BPE	Sets BPE level attenuation.	DESCRIPTION DECODE 0x0: 0dB 0x1: -1dB 0x2: -2dB 0x2: -2dB 0x3: -3dB 0x4 0x1D:(-1dB steps) 0x1E: -30dB				

BPE L1 Max Gain Attn (0x20F8)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-		BPE	_L1_MAXATTN	N[4:0]	
Reset	-	-	-			0x0		
Access Type	-	-	_	Write, Read				
BITFIELD	BITS	RES	D	DESCRIPTION DECODE				
BPE_L1_M AXATTN	4:0	BPE	Sets BPE level attenuation.	l 1 maximum g	ain	0x0: 0dB 0x1: -1dB 0x2: -2dB 0x3: -3dB 0x4 0x1D:(-1dB 0x1E: -30dB 0x1F: -31dB	steps)	

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BPE L0 Max Gain Attn (0x20F9)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-		BPE	_L0_MAXATTN	v [4:0]	
Reset	-	-	-			0x0		
Access Type	-	-	-	Write, Read				
BITFIELD	BITS	RES	D	DESCRIPTION DECODE				
BPE_L0_M AXATTN	4:0	BPE	Sets BPE level attenuation.	Ox0: 0dB 0x1: -1dB 0x2: -2dB 0x3: -3dB 0x4 0x1E: -30dB 0x4.F				

BPE L3 Gain Attack and RIs Rates (0x20FA)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	BPE_	_L3_GAIN_RL	S[2:0]	BPE_	_L3_GAIN_AT	<[2:0]	
Reset	-	-		0x0			0x0		
Access Type	-	-		Write, Read			Write, Read		
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L3_G AIN_RLS	5:3	BPE	Sets BPE level rate.	Sets BPE level 3 gain attenuation release rate.			0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step		
BPE_L3_G AIN_ATK	2:0	BPE	Sets BPE level 3 gain attenuation attack ate.			0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/ste 0x6: 250µs/ste 0x7: 500µs/ste	p p p		

BPE L2 Gain Attack and RIs Rates (0x20FB)

BIT	7	6	5	4	3	2	1	0
Field	_	_	BPE_	_L2_GAIN_RL	S[2:0]	BPE_L2_GAIN_ATK[2:0]		
Reset	-	-	0x0				0x0	
Access Type	-	-	Write, Read				Write, Read	

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L2_G AIN_RLS	5:3	BPE	Sets BPE level 2 gain attenuation release rate.	0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step
BPE_L2_G AIN_ATK	2:0	BPE	Sets BPE level 2 gain attenuation attack rate.	0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/step 0x6: 250µs/step 0x7: 500µs/step

BPE L1 Gain Attack and RIs Rates (0x20FC)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	BPE_	_L1_GAIN_RL	6[2:0]	BPE_L1_GAIN_ATK[2:0]			
Reset	-	-		0x0			0x0		
Access Type	_	-		Write, Read			Write, Read		
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L1_G AIN_RLS	5:3	BPE	Sets BPE level rate.	Sets BPE level 1 gain attenuation release ate.			0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step		
BPE_L1_G AIN_ATK	2:0	BPE	Sets BPE level 1 gain attenuation attack ate.			0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/ste 0x6: 250µs/ste 0x7: 500µs/ste	p p p		

BPE L0 Gain Attack and RIs Rates (0x20FD)

BIT	7	6	5	4	3	2	1	0
Field	-	-	BPE_	_L0_GAIN_RL	S[2:0]	BPE_L0_GAIN_ATK[2:0]		
Reset	-	-	0x0				0x0	
Access Type	_	_	Write, Read				Write, Read	

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L0_G AIN_RLS	5:3	BPE	Sets BPE level 0 gain attenuation release rate.	0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step
BPE_L0_G AIN_ATK	2:0	BPE	Sets BPE level 0 gain attenuation attack rate.	0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/step 0x6: 250µs/step 0x7: 500µs/step

BPE L3 Limiter Config (0x20FE)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L3_LIM[3:0]			
Reset	-	-	-	-		0>	k0	
Access Type	-	-	-	_	Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
BPE_L3_LI M	3:0	BPE	Sets the limiter	⁻ threshold for E	3PE level 3.	0x0: 0dBFS 0x1: -1dBFS 0x2: -2dBFS 0x3: -3dBFS 0x4: -4dBFS 0x5: -5dBFS 0x6: -6dBFS 0x7: -7dBFS 0x8: -8dBFS 0x9: -9dBFS 0xA: -10dBFS 0xB: -11dBFS 0xC: -12dBFS 0xE: -14dBFS 0xF: -15dBFS		

BPE L2 Limiter Config (0x20FF)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L2_LIM[3:0]			
Reset	-	-	-	-	0x0			
Access Type	_	_	-	_	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L2_LI M	3:0	BPE	Sets the limiter threshold for BPE level 2.	0x0: 0dBFS 0x1: -1dBFS 0x2: -2dBFS 0x3: -3dBFS 0x4: -4dBFS 0x5: -5dBFS 0x6: -6dBFS 0x7: -7dBFS 0x8: -8dBFS 0x8: -8dBFS 0x9: -9dBFS 0xA: -10dBFS 0xA: -10dBFS 0xB: -11dBFS 0xC: -12dBFS 0xD: -13dBFS 0xE: -14dBFS 0xF: -15dBFS

BPE L1 Limiter Config (0x2100)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L1_LIM[3:0]			
Reset	-	-	-	-	0x0			
Access Type	_	_	_	_	Write, Read			

BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L1_LI M	3:0	BPE	Sets the limiter threshold for BPE level 1.	0x0: 0dBFS 0x1: -1dBFS 0x2: -2dBFS 0x3: -3dBFS 0x4: -4dBFS 0x5: -5dBFS 0x6: -6dBFS 0x7: -7dBFS 0x8: -8dBFS 0x8: -8dBFS 0x8: -10dBFS 0x8: -11dBFS 0xC: -12dBFS 0xD: -13dBFS 0xE: -14dBFS 0xF: -15dBFS

BPE L0 Limiter Config (0x2101)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	BPE_L0_LIM[3:0]			
Reset	-	-	-	-	0x0			
Access Type	-	-	-	-	Write, Read			

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L0_LI M	3:0	BPE	Sets the limiter threshold for BPE level 0.	0x0: 0dBFS 0x1: -1dBFS 0x2: -2dBFS 0x3: -3dBFS 0x4: -4dBFS 0x5: -5dBFS 0x6: -6dBFS 0x7: -7dBFS 0x8: -8dBFS 0x8: -8dBFS 0x8: -10dBFS 0x8: -10dBFS 0x8: -11dBFS 0xC: -12dBFS 0xD: -13dBFS 0xE: -14dBFS 0xF: -15dBFS

BPE L3 Limiter Attack and Release Rates (0x2102)

BIT	7	6	5 4 3			2	1	0	
Field	-	-	BPE	L3_LIM_RLS	[2:0]	BPE_L3_LIM_ATK[2:0]			
Reset	-	-	0x0			0x0			
Access Type	-	-	Write, Read			Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L3_LI M_RLS	5:3	BPE	Sets BPE level	Sets BPE level 3 limiter release rate.			0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step		
BPE_L3_LI M_ATK	2:0	BPE	Sets BPE level	ts BPE level 3 limiter attack rate.			p p p		

BPE L2 Limiter Attack and Release Rates (0x2103)

BIT	7	6	5	4	3	2	1	0
Field	-	-	BPE_L2_LIM_RLS[2:0]			BPE_L2_LIM_ATK[2:0]		
Reset	-	-	0x0			0x0		
Access Type	_	_		Write, Read				

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L2_LI M_RLS	5:3	BPE	Sets BPE level 2 limiter release rate.	0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step
BPE_L2_LI M_ATK	2:0	BPE	Sets BPE level 2 limiter attack rate.	0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/step 0x6: 250µs/step 0x7: 500µs/step

BPE L1 Limiter Attack and Release Rates (0x2104)

BIT	7	6	5	5 4 3			1	0	
Field	-	-	BPE	_L1_LIM_RLS	[2:0]	BPE_L1_LIM_ATK[2:0]			
Reset	-	-		0x0			0x0		
Access Type	_	-	Write, Read			Write, Read			
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE			
BPE_L1_LI M_RLS	5:3	BPE	Sets BPE level 1 limiter release rate.			0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step			
BPE_L1_LI M_ATK	2:0	BPE	Sets BPE level	ets BPE level 1 limiter attack rate.			p p p		

BPE L0 Limiter Attack and Release Rates (0x2105)

BIT	7	6	5	4	3	2	1	0
Field	-	-	BPE_L0_LIM_RLS[2:0]			BPE_L0_LIM_ATK[2:0]		
Reset	-	_	0x0			0x0		
Access Type	-	-	Write, Read Write, Read					

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
BPE_L0_LI M_RLS	5:3	BPE	Sets BPE level 0 limiter release rate.	0x0: 5ms/step 0x1: 10ms/step 0x2: 25ms/step 0x3: 50ms/step 0x4: 100ms/step 0x5: 250ms/step 0x6: 500ms/step 0x7: 1000ms/step
BPE_L0_LI M_ATK	2:0	BPE	Sets BPE level 0 limiter attack rate.	0x0: 2.5µs/step 0x1: 5µs/step 0x2: 10µs/step 0x3: 25µs/step 0x4: 50µs/step 0x5: 100µs/step 0x6: 250µs/step 0x7: 500µs/step

BPE Threshold Hysteresis (0x2106)

BIT	7	6	5	4	3	2	1	0				
Field				BPE_VTHRES	SH_HYST[7:0]							
Reset		0x0										
Access Type		Write, Read										
BITFIELD	BITS	RES	D	ESCRIPTION		DECODE						
BPE_VTHR ESH_HYST	7:0	BPE	Sets the hyster next level in the Refer to the Me VBAT channel levels.	resis to move u e brownout cor easurement AE result register	p to the htroller. DC PVDD or to set these	00000000: No hysteresis 00000001: 1 LSB of hysteresis 00000010: 2 LSBs of hysteresis : 1 LSB steps 11111101: 253 LSBs of hysteresis 11111110: 254 LSBs of hysteresis 11111111: 255 LSBs of hysteresis						

BPE Infinite Hold Clear (0x2107)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	_	BPE_HLD_ RLS
Reset	-	-	_	-	_	-	-	
Access Type	-	-	_	-	_	-	-	Write Only
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
BPE_HLD_ RLS	0	BPE	Manually releases the BPE controller when infinite hold is enabled.			0x0: Writing 0 0x1: Release b controller from	has no effect prownout-preve infinite hold	ntion-engine

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BPE Supply Source (0x2108)

BIT	7	6	5	4	3	2	1	0	
Field	_	_	_	-	-	-	-	BPE_SRC_ SEL	
Reset	-	-	-	-	-	-	-	0x0	
Access Type	_	-	-	_	_	-	_	Write, Read	
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE		
BPE_SRC_ SEL	0	BPE	This bit selects the measurement ADC channel that is used as the input to the brownout-prevention-engine controller.			0x0: Measuren the input to the 0x1: Measuren the input to the	feasurement ADC PVDD channel is out to the BPE controller feasurement ADC VBAT channel is out to the BPE controller		

BPE Lowest State (0x2109)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	-	BF	BPE_LOWEST[2:0]		
Reset	-	-	-	-	-		0x0		
Access Type	-	-	-	_	_	Read, Ext			
BITFIELD	BITS	RES	DESCRIPTION				DECODE		
BPE_LOWE ST	2:0	-	Returns the lowest level the brownout- prevention engine has transitioned to. Upon reading the register it is updated to show the current level of the brownout controller.			000: Brownout 001: Level 3 010: Level 2 011: Level 1 100: Level 0 101 to 111: Re	inactive—norr	nal operation	

BPE Lowest Gain (0x210A)

BIT	7	6	5	4	3	2	1	0		
Field		BPE_LOWEST_GAIN[7:0]								
Reset		0x0								
Access Type		Read, Ext								
BITFIELD		BITS	RES	DESCRIPTION						
BPE_LOWEST_G 7:0 - Returns the lowest gain (highest gain attenuation) a brownout-prevention engine since the register was Gain format: 5 bit integer and 3 bit fraction. Integer part is 1dB per step while fractional part is 1			ittenuation) app register was las tion. onal part is 1/8	blied by the st read. dB per step.						

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BPE Lowest Limiter (0x210B)

BIT	7	6	5	4	3	2	1	0		
Field		BPE_LOWEST_LIMIT[7:0]								
Reset		0x0								
Access Type		Read, Ext								
BITFIELD		BITS	RES	DESCRIPTION						
BPE_LOWEST MIT	LI	7:0	-	Returns the lowest limiter setting applied by the brownon prevention engine since the register was last read. Limiter format: 4 bit integer and 4 bit fraction. Integer part is 1dB per step while fractional part is 1/16d				nout- 6dB per step.		

BPE Enable (0x210D)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	BPE_LIM_E N	BPE_EN
Reset	-	-	_	-	-	-	0x0	0x0
Access Type	_	_	_	-	_	_	Write, Read	Write, Read
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
BPE_LIM_E N	1	EN	Enables BPE Limiter function			0x0: BPE Limiter disabled 0x1: BPE Limiter enabled		
BPE_EN	0	_	Enables BPE function			0x0: BPE disal 0x1: BPE enab	oled oled	

Auto-Restart Behavior (0x210E)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	_	-	OVC_AUTO RESTART_ EN	THERM_AU TORESTAR T_EN	VBAT_AUT ORESTART _EN	PVDD_AUT ORESTART _EN	
Reset	-	-	-	-	0b0	0b0	0b0	0b0	
Access Type	-	-	_	-	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS	RES	DESCRIPTION				DECODE		
OVC_AUTO RESTART_ EN	3	EN	Controls whether or not the speaker amplifier is automatically reenabled after an overcurrent fault condition.			0: Overcurrent 1: Overcurrent	ercurrent recovery is in manual mode ercurrent recovery is in auto mode		
THERM_AU TORESTAR T_EN	2	EN	Controls whether or not the device automatically returns to the active state when the die temperature recovers from thermal shutdown.			0: Thermal shu mode 1: Thermal shu mode	tdown recover	y is in manual y is in auto	

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BITFIELD	BITS	RES	DESCRIPTION	DECODE
VBAT_AUT ORESTART _EN	1	EN	Controls whether or not the device automatically returns to the active state when VBAT recovers from UVLO event.	0: VBAT UVLO recovery is in manual mode 1: VBAT UVLO recovery is in auto mode
PVDD_AUT ORESTART _EN	0	EN	Controls whether or not the device automatically returns to the active state when PVDD recovers from UVLO event.	0: PVDD UVLO recovery is in manual mode 1: PVDD UVLO recovery is in auto mode

Global Enable (0x210F)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	_	-	-	EN
Reset	-	-	-	-	-	-	-	0x0
Access Type	_	-	_	-	_	_	_	Write, Read, Ext
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
EN	0	_	Disable or enable all blocks and reset all logic except the I ² C interface and control registers.			0: Device powered down 1: Device enabled		

Revision ID (0x21FF)

BIT	7	6	5	4	3	2	1	0
Field		REV_ID[7:0]						
Reset		0x40						
Access Type		Read Only						
BITFIELD	BITS	RES	D	ESCRIPTION			DECODE	
REV_ID	7:0	_	Revision of the device revision	e device. Updat	ed at every	0x40: Device revision		

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Applications Information

Layout and Grounding

Proper layout and grounding are essential for optimal performance; use at least four PCB layers and add thermal vias to the ground/power plane close to the device to ensure good thermal performance and high-end output power. Good grounding improves audio performance and prevents switching noise from coupling into the audio signal. Ground the power signals and the analog signals of the IC separately at the system ground plane to prevent switching interference from corrupting sensitive analog signals. Place the recommended supply decoupling capacitors as close as possible to the IC. The PVDD to PGND connection must be kept short and should have minimal trace length and loop area to ensure optimal performance. Use wide, low-resistance output, supply, and ground traces. As load impedance decreases, the current drawn from the device outputs increase. At higher current, the resistance of the output traces decreases the power delivered to the load. For example, if 2W is delivered from the speaker output to a 4 Ω load through a 100m Ω trace, 49mW is consumed in the trace. If power is delivered through a 10m Ω trace, only 5mW is consumed in the trace. Wide output, supply, and ground traces also improve the power dissipation of the device. The device is inherently designed for excellent RF immunity. For best performance, add ground fills around all signal traces on the top and bottom PCB planes. It is advisable to follow the layout of the MAX98396 EV kit as closely as possible in the application. Thermal and performance measurements shown in this data sheet were measured with a 6-layer board (θ_{JA} = 33°C/W). As a result, the EV kit performance is likely better than what can be achieved with a JEDEC standard board.

Recommended External Components

Table 12 shows the recommended external components. See the Typical Application Circuits for more details.

BUMP	VALUE	SIZE	VOLTAGE RATING (V)	DIELECTRIC
PVDD	220µF ± 20%	_	35	Alum-Elec
PVDD	10µF ± 20%	0603	25	X5R
PVDD	10µF ± 20%	0603	25	X5R
PVDD	0.1µF ± 10%	0402	25	X5R
PVDD	0.1µF ± 10%	0402	25	X5R
VBAT	1µF	0201	16	X5R
VBAT	10µF	0603	25	X5R
VREFC	1µF ± 20%	0201	6.3	X5R
DVDD	1µF ± 20%	0201	6.3	X5R
DVDDIO	1µF ± 20%	0201	6.3	X5R
AVDD	1µF ± 20%	0201	6.3	X5R

Table 12. Component List

20V Digital Input Class-DG Amplifier with I/V Sense and Brownout Prevention

Typical Application Circuits

Typical Application Circuit



Ordering Information

PART NUMBER	TEMP RANGE	PIN-PACKAGE
MAX98396EWB+	-40°C to +85°C	35 WLP
MAX98396EWB+T	-40°C to +85°C	35 WLP

+Denotes a lead(Pb)-free/RoHA-compliant package.

T = Tape and reel.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	3/21	Initial release	_
1	4/21	Added <i>Package Information</i> section, updated <i>Electrical Characteristics</i> table, updated supported TDM mode configurations in Table 5, added SPK_WIDEBAND_ONLY_EN bit to register map	10, 11-14, 16, 22, 24, 43, 44, 91, 138

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